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## **Reversion History**

Version	Contents	Prepared by	Checked by	Approved by	Date
0.00	Preliminary Version	Angus Tsai	Max Tang		2012/03/01
0.01	1. Add description of SDO (page 13) 2. Modify Register 4Fh to write only (page 179) 3. Modify EN4PWR table (page 15) 4. Add SPI description and modify SPI figures (page 20~22) 5. Modify reset timing (page 232) 6. Modify descripton of Register AEh (page 195) 7. Remove Registers 57h/59h/5Ah 8. Modify Power Pin content (page 11) 9. Modify Test Pin content (page 18) 10. Modify block diagram (page 10) 11. Update pin name from FTE2 to FTE1 (page 15/195)	Angus Tsai	Max Tang		2012/03/05
0.02	1. Modify typo (page 132) 2. Modify naming rule of register 0Bh/36h (page 160/174) 3. Add constraint in Register A8h (page 191) 4. Modify SPI figures and content (page 20~23) 5. Add new resolution (page 7/16) 6. Updated resolution typo (page 16) 7. Modify STB figure (page 195) 8. Modify default value of register 0Ah(page 159) 9. Modify restriction of Reg. 55h (page 184) 10. Add new resolution (page 7/16)	Angus Tsai	Max Tang		2012/03/30
0.03	1. Add Multi-IF control bit in Reg. F3h (page 207) 2. Modify I2C SPEC (page 24) 3. Modify MIPI Clock post spec (page 224) 4. Modify the SW Reset state of Reg. BAh/F3h (page 198/207) 5. Modify power on sequence chart (page 140-142)	Angus Tsai	Max Tang		2012/05/18
0.04	1. Modify clk_post spec of MIPI (page 224) 2. Modify VCOMDC3 range typo (page 218) 3. Modify typo (page 11) 4. Add VCI1T description (page 18)	Angus Tsai	Max Tang		2012/05/31
0.05	Modify typo (page 196)     Add delay time between sleep-in and DSB (page 146/180)	Angus Tsai	Max Tang		2012/06/22



## 1. General Description

#### 1.1 Purpose of this Document

This document has been created to provide complete reference specifications for the NT35596. IC designers, testing engineers and application engineers should refer to these specifications for circuits design, quality/performance control, and IC applications for customer.

#### 1.2 General Description

The NT35596 device is a single-chip RAM-less solution for LTPS TFT LCD that incorporates gate drivers, a timing controller with glass interface level-shifters, a VCOM driver and a glass power supply circuit.

The NT35596 can support MIPI, SPI and I2C interface. The source resolution can be adjusted from 720RGB to 1080RGB, and the gate resolution also can be set from 1024 lines to 1920 lines. About the detailed resolution setting, please refer to NT35596 Application Note.

The NT35596 is also able to make gamma correction settings separately for RGB dots to allow benign adjustments to panel characteristics, resulting in higher display qualities. The IC includes internal boosters that generate the LCD driving voltage, breeder resistance and voltage follower circuit for the LCD driver. A deep standby mode is also supported for lower power consumption.

The NT35596 also supports CABC function for the backlight control. It's able to reduce the total power consumption of display module significantly.

This LSI is suitable for small or medium-sized portable mobile solutions requiring long-term driving capabilities, including bi-directional pagers, digital audio players, cellular phones and handheld PDA.



## 2. Features

- Single-chip Full-HD LTPS Controller / Driver.
- Principal Display Resolution
  - 1080RGB x 1920 (1:3 Multiplexer for source driver, Source output from S1 to S1080)
  - 1080RGB x 1440 (1:3 Multiplexer for source driver, Source output from S1 to S1080)
  - 1050RGB x 1680 (1:3 Multiplexer for source driver, Source output from S1 to S525, and S556 to S1080)
  - 1050RGB x 1400 (1:3 Multiplexer for source driver, Source output from S1 to S525, and S556 to S1080)
  - 1024RGB x 1280 (1:3 Multiplexer for source driver, Source output from S1 to S512, and S569 to S1080)
  - 1024RGB x 1600 (1:3 Multiplexer for source driver, Source output from S1 to S512, and S569 to S1080)
  - 1000RGB x 1600 (1:3 Multiplexer for source driver, Source output from S1 to S500, and S581 to \$1080)
  - 960RGB x 1600 (1:3 Multiplexer for source driver, Source output from S1 to S480, and S601 to S1080)
  - 960RGB x 1440 (1:3 Multiplexer for source driver, Source output from S1 to S480, and S601 to S1080)
  - 960RGB x 1280 (1:3 Multiplexer for source driver, Source output from \$1 to \$480, and \$601 to \$1080)
  - 900RGB x 1600 (1:3 Multiplexer for source driver, Source output from S1 to S450, and S631 to S1080)
  - 900RGB x 1440 (1:3 Multiplexer for source driver, Source output from S1 to S450, and S631 to S1080).
  - 800RGB x 1280 (1:3 Multiplexer for source driver, Source output from S1 to S400, and S681 to S1080)
  - 800RGB x 1024 (1:3 Multiplexer for source driver, Source output from S1 to S400, and S681 to S1080)
  - 768RGB x 1366 (1:3 Multiplexer for source driver, Source output from S1 to S384, and S697 to S1080)
  - 768RGB x 1280 (1.3 Multiplexer for source driver, Source output from S1 to S384, and S697 to S1080)
  - 768RGB x 1024 (1:3 Multiplexer for source driver, Source output from S1 to S384, and S697 to S1080)
  - 720RGB x 1280 (1:3 Multiplexer for source driver, Source output from S1 to S360, and S721 to S1080)
  - 720RGB x 720 (1:3 Multiplexer for source driver, Source output from S1 to S360, and S721 to S1080)
  - 540RGB x 960 (1:3 Multiplexer for source driver, Source output from S1 to S270, and S811 to S1080)

#### Display Modes

■ Full Color Mode: 16.77M-colors

■ Reduced Color Mode: 262K-colors

■ Reduced Color Mode: 65K-colors

Only supported Normal Display Mode

#### Interface

■ MIPI DSI Interface (D-PHY: V1.1 , DSI:1.01.00, DCS:1.01.00)

MIPI I/F Supported 2, 3 or 4 data lanes (Lane number is selected by register BAh of CMD1 in MIPI LP mode, and this register can be programmed by MTP)

- I2C Interface
- SPI Interface
- Multi-interface (MIPI + SPI (8/9-bits) or MIPI + I2C by HW pin or register setting)

#### Display Features

- Individual gamma correction setting for RGB dots
- Deep standby function



#### On Chip Function

- DC/DC converter
- VCOM voltage generator
- Supports control signals (CGOUTR1~R16, CGOUTL1~L16) to gate driver in the LCD panel
- Provide OTP (1 time) to store related Power, LTPS setting, and gamma setting
- Provide MTP (3 times) to store VCOM, ID1, ID2, ID3 and DDB calibration
- Oscillator for display clock generation
- On module checksum checking
- 3D barrier control function
- Image enhancement technology

#### • Content Adaptive Backlight Control (CABC) Function

- Histogram analysis & data process
- Dimming control
- Only supported in full display mode

#### Supply Voltage Range

- Analog supply voltage range VCI to AVSS: 2.5V to 4.8V
- I/O supply voltage range for VDDI to VSS: 1.65V to 3.6V
- MIPLOSI supply voltage range for VDDAM to VSS: 1.7V to 3.6V

(VDDAM can connect to VDDI or VCI if its operation voltage is available)

- Analog supply voltage range for AVDD to AVSS: 4.5V to 6V
- Analog supply voltage range for AVEE to AVSS: -4.5V to -6V



#### • Output Voltage Level

- Source output voltage range: ( GVDDP ~ +0.2V ) and ( -0.2V ~GVDDN )
- Gamma voltage range: GVDDP = 3V ~ 5.25V (10mV/step)

 $GVDDN = -3V \sim -5.25V (10mV/step)$ 

■ Positive gate driver output voltage level: VGH to AVSS = AVDD - VCL, 2 x AVDD, 2 x AVDD - VCL, 2 x AVDD - AVEE

VGHO = 6V ~ 14V (100mV/step)

■ Negative gate driver output voltage level: VGL to AVSS = AVEE – VCI, 2 x AVEE, 2 x AVEE – VCI

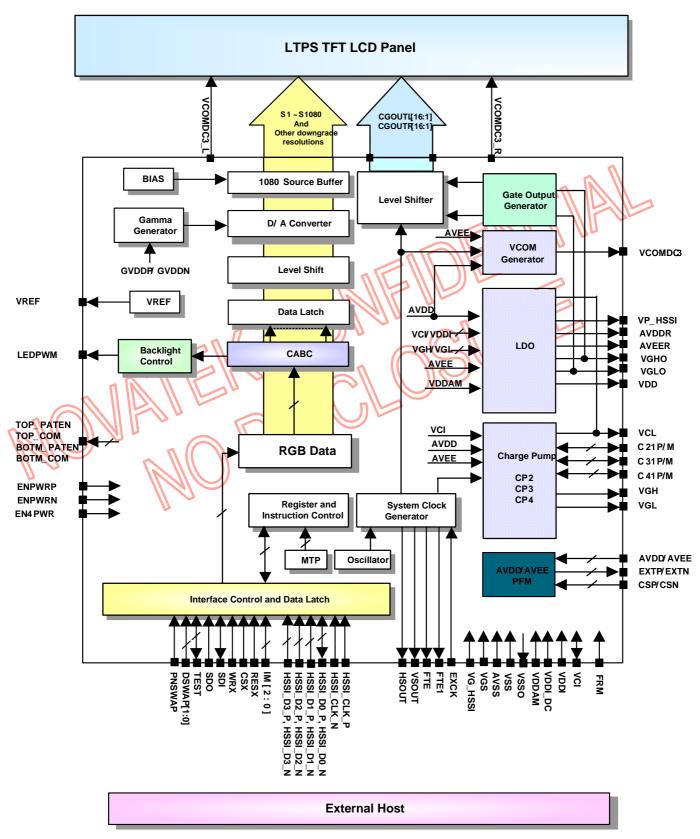
VGLO = -5V ~ -10V (100mV/step)

■ Common electrode output voltage level: VCOMDC3 = -2V to +2V (10mV/step)

■ 3D barrier output voltage level: VDCP = 3V ~ 5.5V (50mV/step)



## 3. Block Diagram



NT35596 block diagram



## 4. Pin Description

## 4.1 Pins for Power Input

Symbol	Pad Type	Description
VCI	Power Supply	<ul> <li>Power supply to the liquid crystal power supply analog circuit. Connect VCI to an external power supply with 2-1PWR and 4 PWR modes (VCI = 2.5V to 4.8V).</li> <li>In 2-2PWR and 3 PWR modes, VCI will be a LDO output, please connect a capacitor to stabilize voltage level.</li> </ul>
VDDI	Power Supply	- Power supply to the I/O VDDI = 1.65V to 3.6V
VDDI_DC	Power Supply	- Connect to VDDI for preventing noise.
VDDAM	Power Supply	- Power supply for MIPI interface VDDAM = 1.7V ~ 3.6V
vss	Power Ground	- Ground for digital logic, VSS = 0V
AVSS	Power Ground	- Ground for the analog unit (regulator, liquid crystal power supply circuit). AVSS = 0V In case of COG, connect AVSS to VSS on the FPC to prevent noise.
ves	Analog Ground	<ul> <li>Ground for gamma circuit. VGS = 0V.</li> <li>In case of COG, connect VGS to VSS on the FPC to prevent noise.</li> </ul>
VG_HSSI	Power Ground	- Ground for the High Speed Interface regulator. VG_HSSI= 0V In case of COG, connect VG_HSSI to VSS on the FPC to prevent noise.
AVDD	Power Input	- Positive input analog power for driver IC use It can be generated by "Internal PFM" or supported by "external PMIC".
AVEE	Power Input	- Negative input analog power for driver IC use It can be generated by "Internal PFM" or supported by "external PMIC".
ЕХТР	Output	- Control output for gate of NMOS in positive internal PFM converter when ENPWRP = AVSS If not used, please let this pin open.
EXTN	Output	- Control output for gate of PMOS in negative internal PFM converter when ENPWRN = AVSS If not used, please let this pin open.
CSP	Analog Input	<ul> <li>Voltage signal for sensing external inductor current in positive Internal PFM converter when ENPWRP = AVSS.</li> <li>If not used, please let this pin open.</li> </ul>
CSN	Analog Input	<ul> <li>Voltage signal for sensing external inductor current in negative Internal PFM converter when ENPWRN = AVSS.</li> <li>If not used, please let this pin open.</li> </ul>



## 4.2 Pins for MIPI Interface

Symbol	Pad Type	Description
		- DSI_CLK positive/ negative in MIPI interface.
		- HSSI_CLK_P/N are differential small amplitude signals. Ensure the trace length is shortest so
HEEL CLK DAN	MIDI Imput	that the - COG resistance is less than 10 ohm.
HSSI_CLK_P/N	MIPI Input	- For MIPI I/F, if deep standby mode is used, please pull HSSI_CLK_P/N to VSS after issuing
		deep standby command
		- If not used, please tie to VSS.
		- MIPI positive/negative data signal line.
		- HSSI_D0_P/N are differential small amplitude signals. Ensure the trace length is shortest so
HSSI_D0_P/N	MIPI I/O	that the COG resistance is less than 10 ohm.
11331_D0_17N	MII 1 VO	- For MIPI I/F, if deep standby mode is used, please pull HSSI_D0_P/N to VSS after issuing
		deep standby command
		- If not used, please tie to VSS.
		- MIPI positive/ negative data signal line.
	75	- HSSI_D1_P/N are differential small amplitude signals. Ensure the trace length is shortest so
HSSI_D1_P/N	MIPI Input	Vihat the COG resistance is less than 10 ohm.
		- For MIPI I/F, if deep standby mode is used, please pull HSSI_D1_P/N to VSS after issuing
		deep standby command
		- If not used, please tie to VSS.
		- MIPI positive/ negative data signal line.
II .		HSSI_D2_P/N are differential small amplitude signals. Ensure the trace length is shortest so
HSSI_D2_P/N	MIPI Input	that the COG resistance is less than 10 ohm.
		- For MIPI I/F, if deep standby mode is used, please pull HSSI_D2_P/N to VSS after issuing
		deep standby command
		- If not used, please tie to VSS.
		- MIPI positive/ negative data signal line.
		- HSSI_D3_P/N are differential small amplitude signals. Ensure the trace length is shortest so
HSSI_D3_P/N	MIPI Input	that the COG resistance is less than 10 ohm.
		- For MIPI I/F, if deep standby mode is used, please pull HSSI_D3_P/N to VSS after issuing
		deep standby command.
		- If not used, please tie to VSS.



## 4.3 Pins for SPI / I2C Interface

Symbol	Pad Type	Description
csx	Digital Input (VDDI – VSS)	- Chip select input pin of NT35596.  CSX = "0" (VSS): Selected (accessible)  CSX = "1" (VDDI): Unselected (not accessible)  - If not used, please pull it to VDDI.
DCX	Input	- This pin is used for SPI 8-bits I/F If not used, please tie this pin to VDDI.
WRX (SCL/ I2C_SCL)	Digital Input (VDDI – VSS)	<ul> <li>WRX: Novatek engineering mode.</li> <li>SCL: A synchronous clock signal in serial interface (SPI) operation.</li> <li>I2C_SCL: Serial input / output clock in I2C interface operation.</li> <li>If not used, please pull it to VDDI.</li> </ul>
SDI (I2C_SDA)	Digital I/O (VDDI – VSS)	- SDI: Serial data input pin (SDI) in serial interface (SPI) operation.  - I2C_SDA: Serial input/output data in I2C-Bus interface operation.  - If not used, please pull it to VSS.
SDO	Digital Output (VDDI – VSS)	<ul> <li>Serial data output pin (SDO) in serial interface operation. If the host places the SDI line into high-impedance state during the read intervals, then the SDI and SDO can be tied together.</li> <li>If not used, please let it floating.</li> <li>If user wants to save one trace of glass and system can support SDI/SDO share one wire, you can let SDO tie to SDA together on glass.</li> </ul>

## 4.4 Pins for CABC

Symbol	Pad Type	Description
	Digital Output LEDPWM (VDDI - VSS)	- This pin is used to connect to the external LED driver of panel backlight control.
		- PWM type control signal for determining brightness of the LED backlight.
LEDPWM		- The duty width of this LEDPWM signal is set by an 8-bits value to determine the duty from 0%
		(Low) and 100% (High).
		- If not used, please open this pin.



## 4.5 Pins for Interface Control

Symbol	Pad Type		Description							
		Se	elects	s the						
			IM2 IM1		IM2 IM1 IM0		IMO	Interface Selection	Data Pins	Available Colors
			0	0	0	MIPI + I2C	MIPI : HSSI_D0_P/N ~ HSSI_D3_P/N I2C : I2C_SDA	65k, 262k, 16.77M		
			0	0	1	Reserved	Reserved	Reserved		
			0	1	0	MIPI + SPI (9-bits) (SCL rising edge trigger)	MIPI : HSSI_D0_P/N ~ HSSI_D3_P/N SPI : SDI, SDO	65k, 262k, 16.77M		
IM2 - 0	Digital Input (VDDI – VSS)		0	1	1	MIPI + SPI (8-bits) (SCL rising edge trigger)	MIPI :HSSI_D0_P/N ~ HSSI_D3_P/N SPI : SDI, SDO	65k, 262k, 16.77M		
			1	0	0	Reserved	Reserved	Reserved		
			1	0	1	Reserved	Reserved	Reserved		
		7	1	1	0	MIPI Interface	HSSI_D0_P/N, HSSI_D1_P/N HSSI_D2_P/N, HSSI_D3_P/N	65k, 262k, 16.7M		
	1 M 1		1	1	1	Reserved	Reserved	Reserved		
	\ \( \)		a	nd Da	ata Lane to VP_HSSI.	/011b and do not use MIPI I/F, please				



## 4.6 Pins for Logic Function Control

Symbol	Pad Type	Description											
RESX	Digital Input (VDDI – VSS)	- This signa Low. - There is n						ed to pro	operly	initialize	the chip	o. Signa	l is active
EXCK	Digital Input (VDDI – VSS)	- External C				s from	9MHz to	o 40MHz	<u>′</u> .			U	
FTE	Digital Output (VDDI – VSS)	- Frame hear - The outputh - If not used	t voltage le	vel of F	TE pin is	s deteri	-		zing R	AM data	write op	erations	
FTE1	Digital Output (VDDI – VSS)	- This signa - The outpu - If not used	t voltage le	vel of F	TE1 pin	is dete	\	11 \\-		tput per s	scan line	e from N	T35596).
PNSWAP DSWAP[1:0]	Digital Input (VDDI – VSS)	- PNSWAP a - If not used PNSWAP	// П				_ ((( _ `	CLK+  CLK-  CLK-  CLK-  CLK-  CLK-  CLK+	11 //	D0+ D1- D1- D2-		D3+ D0- D2- D3- D0+ D2+ D3+	D3- D0+ D2+ D3+ D3- D0- D2- D3- D3- D3-
EN4PWR	Digital Input (VDDI – VSS)	- Enable or - If not used				ction.							
		EN4PWR	ENPWRP,		Mode	select f	four kind	•	mode :	or AVDD			/EE
ENPWRP/	Analog Input	N.A.	00	2-1F	PWR		VDDI, '	VCI		Internal P	FM	Intern	al PFM
ENPWRN	(AVDD- VSS)		10	2-2F	PWR		VDDI, A	VDD		External A	VDD	Intern	al PFM
		0	11	3P\	ΝR	VE	DI, AVDI	D, AVEE		External A	VDD	Externa	al AVEE
		1	11	4P\	WR	VDDI	I, VCI, AV	DD, AVE	E	External A	VDD	Externa	al AVEE
		Note: For mo	ore detail a	pplicatio	on circui	ts, plea	se refer	to NT35	596 A	pplication	Note.		



## 4.7 Analog Output for Display Driving

Symbol	Pad Type	Description																							
VCOMDC3_R/L	Analog Output	- VCOMDC3 signal output for panel usage.																							
Symbol	Pad Type	- Liquid crystal applic - If source output nur - SR1 and SL1 are d  H_RES [3:0]  0000b  0000b  0001b  0010b  0010b  0010b  0100b  0100b  0100b  0100b  0100b  0100b	cation voltage output prober less than 108 ummy sources.  V_RES[3:0]  0000b  0011b  0010b  0110b  0010b  0011b  0010b  0011b  0010b  0011b  0010b	age.  ut lines. 30, please let non-used so  Panel Type  1080 (RGB) x 1920  1080 (RGB) x 1440  1050 (RGB) x 1680  1050 (RGB) x 1680  1024 (RGB) x 1280  1024 (RGB) x 1600  960 (RGB) x 1600  960 (RGB) x 1440  960 (RGB) x 1440  960 (RGB) x 1600	Source Channel  \$1 ~ \$1080  \$1 ~ \$1080  \$1 ~ \$1080  \$1 ~ \$525 / \$556~\$1080  \$1 ~ \$525 / \$556~\$1080  \$1 ~ \$512 / \$569~\$1080  \$1 ~ \$512 / \$569~\$1080  \$1 ~ \$512 / \$569~\$1080  \$1 ~ \$500 / \$581~\$1080  \$1 ~ \$480 / \$601~\$1080  \$1 ~ \$480 / \$601~\$1080  \$1 ~ \$480 / \$631~\$1080																				
													0101b	0011b	900 (RGB) x 1440 800 (RGB) x 1280	\$1~\$450 / \$631~\$1080 \$1~\$400 / \$681~\$1080									
																							0110b	0111b	800 (RGB) x 1024
V												0111b	0101b	768 (RGB) x 1366	S1~S384 / S697~S1080										
			0111b	0110b	768 (RGB) x 1280	S1~S384 / S697~S1080																			
																	0111b	0111b	768 (RGB) x 1024	S1~S384 / S697~S1080					
												1000b	0110b	720 (RGB) x 1280	S1~S360 / S721~S1080										
												1000b	1001b	720 (RGB) x 720	S1~S360 / S721~S1080										
															1001b	1000b	540(RGB)x960	S1~S270 / S811~S1080							
																Note: For detailed \	/_RES[3:0] and H_	_RES [3:0] setting, please	refer to NT35596 Application Note.						

## 4.8 LTPS Panel Control Signals

Symbol	Pad Type	Description					
CGOUTL[16:1]	Digital Output	- These pins are used for LTPS control signal.					
CGOUTR[16:1]	(VGHO - VGLO)	- Please let non-used pins floating.					



## 4.9 Power Supply Pins

Symbol	Pad Type	Description
VDD	LDO output	- Power supply to the internal logic regulator circuit.
		- Connect a capacitor to stabilize output voltage.
AVDDR	LDO Output	- Positive LDO output for Driver IC usage.
		- Connect a capacitor to stabilize output voltage.
AVEER	LDO Output	- Negative LDO output for Driver IC usage.
AVEEN	250 Output	- Connect a capacitor to stabilize output voltage.
GVDDP	LDO Output	- Positive LDO output for gamma circuit.
GVDDN	LDO Output	- Negative LDO output for gamma circuit.
VREF	LDO Output	- Reference voltage output from the internal reference voltage generating circuit.
VP_HSSI	LDO Output	- Internal logic regulator output for MIPI high speed / low power mode use.
VI _IIOOI	250 Output	- Connect a capacitor for stabilization.
VOL	Channa Buran Outrast	- Output voltage from the step-up circuit, and generate from AVDD, AVEE and VCL.
VGH	Charge Pump Output	- Connect a capacitor to stabilize output voltage.
	SEL I	- Capacitor connection pins for the step-up circuit which generate VGH.
C21P/C21M	Analog Output	- If not used, please let these pins floating.
VGL		- Output voltage from the step-up circuit, and generated from AVEE and VCI.
VGLOUT	Charge Pump Output	- Please tie VGL with VGLOUT together.
		- Connect a capacitor to stabilize output voltage.
C31P/C31M	Analog Output	- Capacitor connection pins for the step-up circuit which generate VGL.
	11.0	- If not used, please let these pins open.
VGHO	LDO Output	- Positive LDO output for LTPS power generator.
22.0		- Connect a capacitor to stabilize output voltage.
VGLO	LDO Output	- Negative LDO output for LTPS power generator.
voco EDO Output		- Connect a capacitor to stabilize output voltage.
	Charge Pump Output	- Output voltage from the step-up circuit or LDO circuit, and generated from AVEE or VCI.
VCL	Or	- Connect a capacitor to stabilize output voltage.
	LDO Output	
C41P/C41M	Analog Output	- Capacitor connection pins for the step-up circuit which generate VCL.  - If not used, please let these pins floating.
		- II Hot used, please let these pins hoating.



## 4.10 Test and Dummy Pins

Symbol	Pad Type	Description		
DUMMY	DUMMY	- These pins are dummy (possess no function inside), and are not accessible to user Please open these test pins.		
COGTEST1 COGTEST2	Output	- Dummy pins to measure contact resistance. COGTEST1/2 pins are internal short.		
TEST	Input/Output	- Novatek internal test pins Please let these pins open.		
FRM	Input	- This pin is used for Novatek engineering mode If not use, please tie this pin to VSS.  FRM Free Running Mode  Low Disable  High Enable		
VCI1	Output	- This pin is used for Novatek engineering mode If not use, please let it open.		
vsso	Digital Ground	- This pin output a ground level for fixed level logic pin used If not used, please let it open.		
VSOUT	Output	- Test pin. If not use, please let this pin open.		
HSOUT	Output	- Test pin. If not use, please let this pin open.		
VCIIT	Analog Output	Novatek analog reserved pin.  - If not used, please let this pin open.		

## 4.11 3D-Barrier Control Pins (Option)

Symbol	Pad Type	Description	
TOP_PATEN	Output (VDCP – GND)	- 3D barrier control signal If not used, please let this pin open.	
TOP_COM	Output - 3D barrier control signal. (VDCP – GND) - If not used, please let this pin open.		
BOTM_PATEN	Output (VDCP – GND)	- 3D barrier control signal If not used, please let this pin open.	
BOTM_COM Output (VDCP – GND)		- 3D barrier control signal If not used, please let this pin open.	



## 5. Function Descriptions

#### 5.1 Interfaces (SPI/I2C/MIPI)

The NT35596 provides MIPI DSI, MIPI DSI + SPI (8/9-bits) and MIPI DSI + I2C interface. The interface can be determined by hardware pins (IM[2:0]). When MIPI DSI + SPI (8/9-bits) and MIPI DSI + I2C interface, SPI (8/9-bits) and I2C only support register access. Besides, user also can read and write registers via MIPI interface. But NT35596 doesn't support these two I/F to access register simultaneously. NT35596 also provides another multi-interface selection by register setting (CMD1 F3h), It is only available when IM[2:0] = 110b.

IM2	IM1	IMO	System Interface	Data Pins	Available Colors
0	0	0	MIPI DSI + I2C	MIPI : HSSI_D0_P/N ~ HSSI_D3_P/N I2C : I2C_SDA	65k, 262k, 16.77M
0	0	1	Reserved	Reserved	Reserved
0	1	0	MIPI DSI + SPI (9-bits Type) (SCL rising edge trigger)	MIPI : HSSI_D0_P/N ~ HSSI_D3_P/N SPI : SDI, SDO	65k, 262k, 16.77M
0	1	1	MIPI DSI + SPI (8-bits Type) (SCL rising edge trigger)	MIPI : HSSI_D0_P/N ~ HSSI_D3_P/N SPI : SDI, SDO	65k, 262k, 16.77M
1	0	0	Reserved	Reserved	Reserved
1	0	1	Reserved	Reserved	Reserved
1	1	0	MIPI DSI Interface	HSSI_D0_P/N, HSSI_D1_P/N HSSI_D2_P/N, HSSI_D3_P/N	65k, 262k, 16.7M
1	1	1	Reserved	Reserved	Reserved

Interface Selection of NT35596



#### 5.1.1 SPI Interface

#### 5.1.1.1 General Description for LoSSI

The Module uses a 9-bits serial interface (LoSSI). The chip-select CSX (active low) enables and disables the serial interface. RESX (active low) is an external reset signal. SCL is the serial data clock and SDA is serial data.

Serial data must be input to SDI in the sequence D/CX, D7 to D0. The Graphics Controller Chip reads the data at the rising edge of SCL signal. The first bit of serial data D/CX is data/command flag. When D/CX = "1", D7 to D0 bits are command parameters. When D/CX = "0" D7 to D0 bits are commands

SCL is not a continuous clock and it can be stopped by the host CPU when SCL is low or high after a rising edge of SCL for D0 in the writing mode.

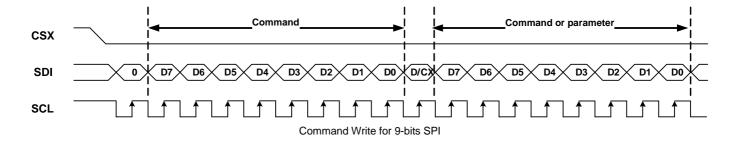
SCL and SDI can be high or low when there is a falling or rising edge of the CSX.

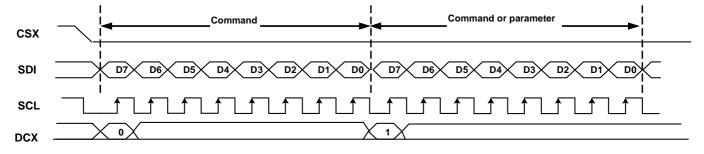
The 8bits serial mode consists of the Data/Command selection input (D/CX), chip enable input (CSX), the serial clock input (SCL), serial data Input (SDI) and serial output data (SDO) for data transmission. Serial clock (SCL) is used for interface with MCU only, so it can be stopped when no communication is necessary.

Note: If user wants to save trace of FPC and system can support SDI and SDO share same wire, you can tie SDO to SDI together on glass.

#### 5.1.1.2 Command Write for LoSSI

The host CPU drives the CSX pin low and starts by setting the D/CX-bit on SDI. The bit is read by the display on the first rising edge of SCL. On the next falling edge of SCL the MSB data bit (D7) is set on SDA by the CPU. On the next falling edge of SCL the next bit (D6) is set on SDI. This continues until all 8 Data bits have been transmitted as shown in below figures: Command Write.





Command Write for 8-bits SPI

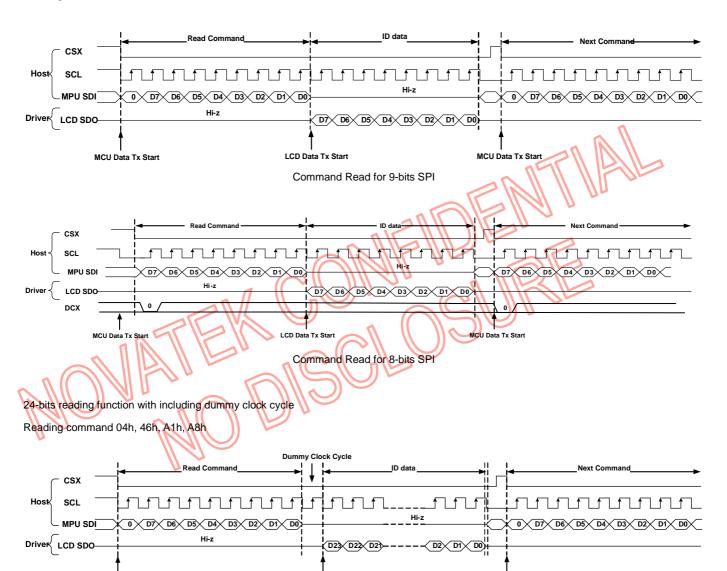


#### 5.1.1.3 Read Functions for LoSSI

MCU Data Tx Start

8-bits Reading Function without including dummy clock cycle

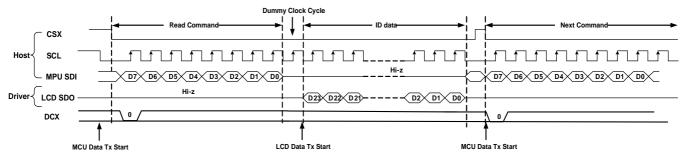
Reading commands 05h, 0Ah, 0Bh, 0Dh, 0Eh, 0Fh, DAh, DBh, DCh, FEh, 52h, 54h, 56h, 5Fh, AAh, AFh, F4h



Command Read for 9-bits SPI

MCU Data Tx Start

LCD Data Tx Start



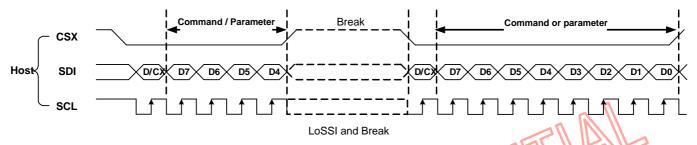
Command Read for 8-bits SPI

Note: In above figure is an ID Data length 24bits example (MSB first and parameter 1 first).

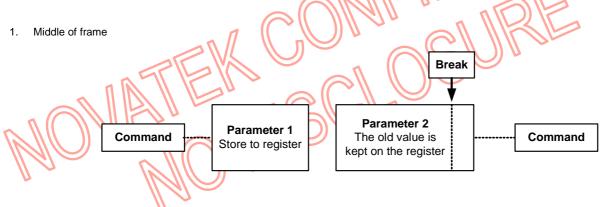


#### 5.1.1.4 Display Module Data Transfer Recovery (example for LoSSI)

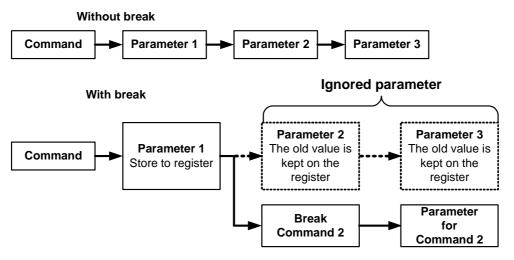
If there is a break in data transmission while transferring command or Multiple Parameter command Data, before a whole byte has been completed, then the Display Module will have reset the interface such that it will be ready to receive the same byte re-transmitted when the chip select line (CSX) is next activated. See the following example:



If a 1 or more parameter command is being sent and a break occurs while sending any parameter before the last one and if the host then sends a new command rather than retransmitting the parameter that was interrupted, then the parameters that were successfully sent are stored and the parameter where the break occurred is rejected. The interface is ready to receive next byte as shown:



#### 2. Between frames



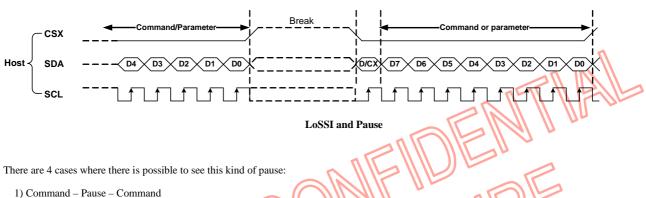
LoSSI and break during parameter

Note: Break can be e.g. another command or noise pulse.



#### 5.1.1.5 Display Module Data Transfer Pause (example for LoSSI)

It will be possible when transferring Command or Multiple Parameter Data to invoke a pause in the data transmission. If the Chip Select Line is released after a whole byte of Frame Memory Data, Command or Multiple Parameter Data has been completed, then the Display Module will wait and continue the Command or Parameter Data Transmission from the point where it was paused as shown below:



- 2) Command Pause Parameter
- 3) Parameter Pause Command
- 4) Parameter Pause Parameter

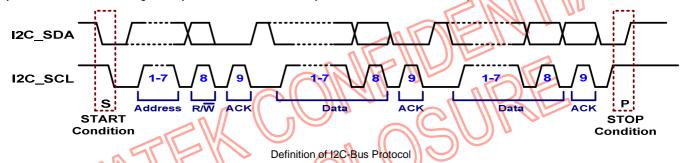


#### 5.1.2 I2C Interface

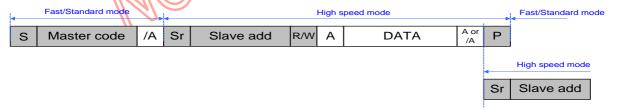
The I2C-bus is for bi-directional, two-line communication between different ICs or modules. The two lines are the Serial Data line (I2C\_SDA) and the Serial Clock Line (I2C\_SCL). Both lines must be connected to a positive supply via pull-up resistors. Data transfer can be initiated only when the bus is not busy. Each byte of eight bits is followed by an acknowledge bit. The acknowledge bit is a HIGH level signal put on the bus by the transmitter during which time the master generates an extra acknowledgement related clock pulse. A slave receiver which is addressed must generate an acknowledgement after the reception of each byte. Also a master receiver must generate an acknowledgement after the reception of each byte that has been clocked out of the slave transmitter.

#### (a) I2C-Bus Protocol:

Before any data is transmitted on the I2C-bus, the device, which should respond is addressed first. There are four slave address can be selected by MCU. The slave addressing is always carried out with the first byte transmitted after the START procedure.

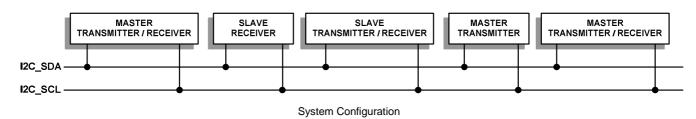


NT35596 I<sup>2</sup>C-bus supports high speed mode transfer (3.4MHz). I<sup>2</sup>C master must transfer 8 bits "Master codes", which are not used for slave addressing or other purposes. This master code is binary code "0000\_1xxx". Next diagram shows the sequence from fast/standard mode to high mode and high speed mode to fast/standard mode.



#### (b) Definitions:

- Transmitter: The device which sends the data to the bus.
- Receiver: The device which receives the data from the bus.
- Master: The device which initiates a transfer, generates clock signals and terminates a transfer.
- Slave: The device addressed by a master.
- Multi-master: More than one master can attempt to control the bus at the same time without corrupting the message.
- Arbitration: Procedure to ensure that, if more than one master simultaneously tries to control the bus, only one is allowed to do so and the message is not corrupted.
- Synchronization: Procedure to synchronize the clock signals of two or more devices.



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#### 5.1.2.1 Slave Address of I2C

NT35596 supports many slave addresses after the START procedure via I2C bus for MCU usage. A register (CMD1 register F8h) bit I2C\_SLAVE\_ADDR[6:0] to set the user's desired slave address. And 000\_0xxxb and 111\_1xxxb except 000\_0000h has been reversed. The slave address selection is described as the following table. The I2C interface address is decided by external MPU. 000\_0000h is a global address that always can access register of NT35596.

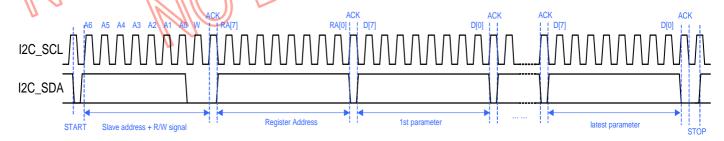
I2C_SLAVE_ADDR[6:0]	Slave Address	Notes
000_0000Ь	000_000b	
:	:	000_0xxxb and 111_1xxxb:
111_0110b	111_0110b	Reversed excepted 000_0000b
111_0111b	111_0111b	

Selection Table of Slave Address

#### 5.1.2.2 Register Write Sequence of I2C Interface

NT35596 supports register write sequence via I2C-bus transfer. The detail transference sequences are illustrated and described as below.

- (1) Data transfers for register writing follow the format is shown in below.
- (2) After the START condition (S), a slave address is sent. R/W bit is setting to "zero" for WRITE
- (3) The slave issues an ACK to master.
- (4) 8-bits register high byte address transfer first. Then transfer the register low byte address.
- (5) 8-bits register high byte data of parameter transfer first. Then transfer the register low byte data parameter.
- (6) A data transfer is always terminated by a STOP condition.

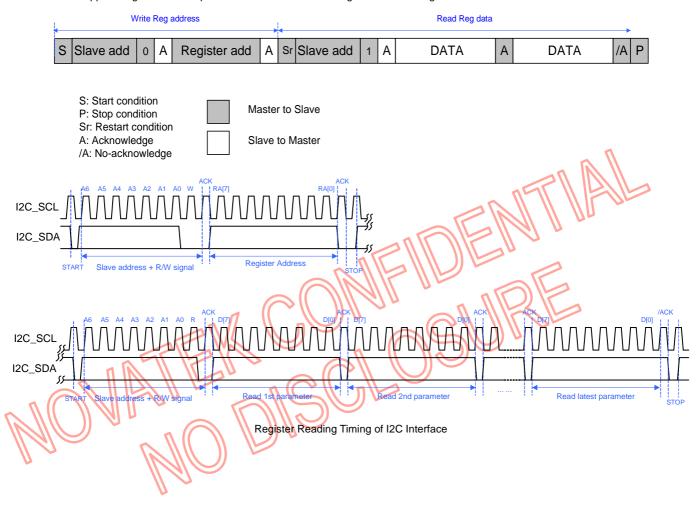


Register Writing Timing



#### 5.1.2.3 Register Read Sequence of I2C Interface

NT35596 supports register read sequence via I2C-bus transfer. Register data reading transfers follow the format and is shown in below.

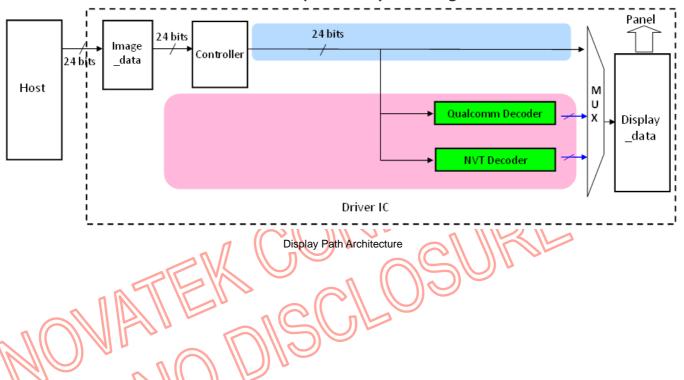




## 5.2 Display Data PATH

The NT35596 is a driver IC of RAM-less architecture. The NT35596 also provides user Qualcomm decoder or NVT decoder technology to save interface (MIPI) transmission bandwidth.

## **Data Compression System Diagram**





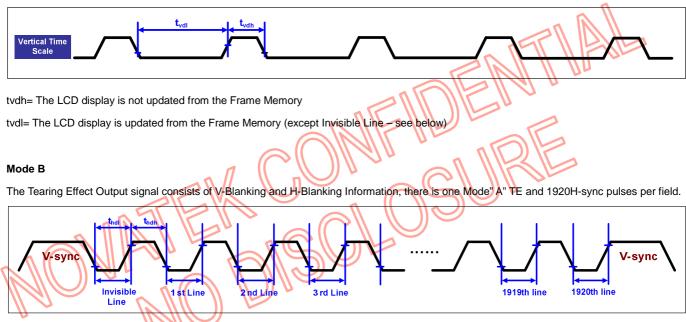
## **5.3 Frame Tearing Effect Interface**

The Tearing Effect output line supplies to the MPU a Panel synchronization signal. This signal can be enabled or disabled by the Tearing Effect Line off and on commands. The mode of the Tearing Effect signal is defined by the parameter of the Tearing Effect Line On command. The signal can be used by the MPU to synchronize Frame Memory Writing when displaying video images.

#### 5.3.1 Tearing Effect Line Modes

#### Mode A

The Tearing Effect Output signal consists of V-Blanking Information only:

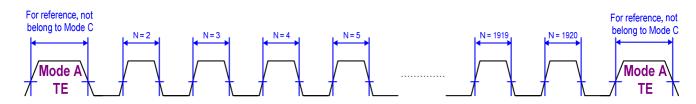


#### t<sub>hdh</sub> = The LCD display is not updated from the Frame Memory

t<sub>hdl</sub> = The LCD display is updated from the Frame Memory (except Invisible Line – see above)

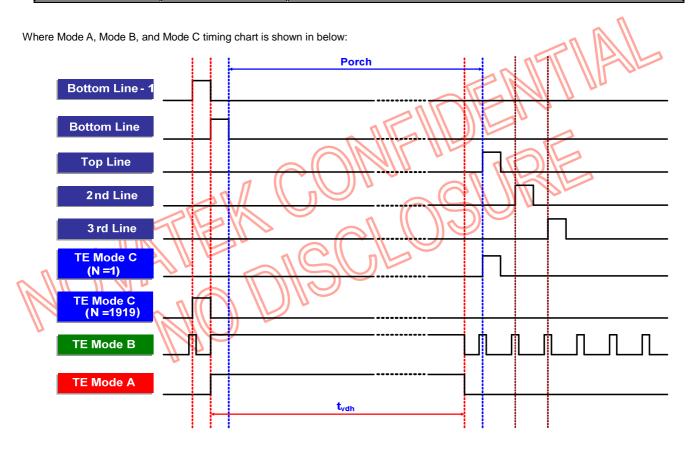
#### Mode C

This mode turns on the display module's Tearing Effect output signal on the TE signal line when the display module reaches line N. The Tearing Effect Line On has one parameter that describes the Tearing Effect Output Line mode. In below figure, it shows that TE only output one line period pulse that can be selected from 2<sup>nd</sup> line to 1920<sup>th</sup> line by register 4400h and 4401h.





Register 3500h	Register 4400h	TE Output	
М	N		
0	0	TE high in V-porch region (A)	
1	0	TE high in all V-porch and H-porch region (B)	
0	≠ 0	TE high at N-th line (C)	
1	≠ 0	TE high in all V-porch and H-porch region (B)	

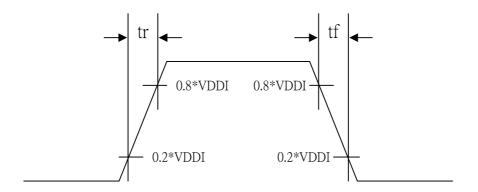


Notes 1: During sleep-in mode, the Tearing Output pin is active Low

Notes 2: N ≥ "Horizontal line number" will be ignore in TE mode C. "Horizontal line number" is decided by bit GM[1:0] of 00h (CMD2 Page0).

#### **AC characteristics of Tearing Effect Signal (FTE)**

FTE's rising-time and falling-time (tr, tf) are stipulated to equal to or less than 15ns when maximum loading is 30pF.





## 5.3.2 FTE Output Position Setting

The FTE pulse of "Mode C" is output to the line determined by N[10:0]. The FTE signal can be adopted as the trigger signal for writing image data in synchronization with display operation by detecting the RAM address where data is read out for display.

N[10:0]	FTE Output Line	
0000h	FTE high only in VBP Region	
0001h	2nd lines	
0002h	3rd lines	
0003h	4th lines	
:	:	
077Dh	1918th lines	
077Eh	1919th lines	
077Fh	1920th lines	

FTE Output Line

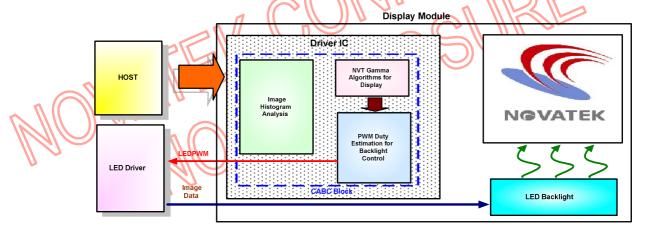


#### 5.4 Dynamic Backlight Control Function

The NT35596 supports Backlight-Control function to control brightness of backlight and to process image dynamically. This function enables to reduce backlight power consumption and minimize the effect of reduced power on the display image. The display image is dynamically controlled by CABC (Contents Adaptive Backlight Control) block. The availability of this function ranges from moving picture such as TV image to still picture such as menu. However, in order to gain a better display quality and reduce the power consumption of the backlight, the NT35596 internally uses NVT gamma algorithm to produce an optimal backlight control based on different image contents. Therefore, the power consumption of the backlight can be reduced without changing display image. The Backlight-Control function of the NT35596 supports two architectures as shown in below:

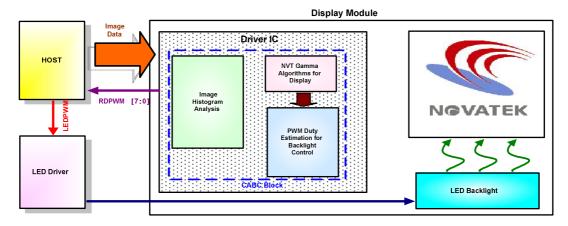
#### Architecture 1:

The brightness of backlight can directly be controlled by CABC block of the NT35596. The NT35596 will output the PWM duty via "LEDPWM" pin. The PWM duty is determined by CABC processed results based on different image contents. As for this application, user also can set/clear the bit "BL" of CMD1 register 53h to turn on/off the backlight. Besides, the user can control the brightness of the backlight by forcing a specified PWM duty. The CMD2 Page3 register 00h and 2Fh (include of FORCE\_CABC\_DUTY[7:0] and FORCE\_CABC\_PWM) is used to forcing the PWM duty.



#### Architecture 2:

The brightness of the backlight is controlled by the external host processor. In this application, the CABC block of the NT35596 also works and estimates a better gamma setting for improving the brightness of display image, the determined PWM duty information can be read from CMD2 Page3 Register 10h (RDPWM) of the NT35596. Because the backlight is controlled by host processor, user can clear the bit "BL" of the register 5300h for keeping the "LEDPWM" pins as ground level.





#### 5.4.1 Content Adaptive Backlight Control (CABC)

A Content Adaptive Brightness Control (CABC) function can be used to reduce the power consumption of the luminance source. Content adaptation means that content grey level scale can be increased while simultaneously decreasing brightness of the backlight to achieve same perceived brightness. The adjusted grey level scale and thus the power consumption reduction depend on the content of the image. The NVT CABC algorithm can adjust the brightness of each gray level without changing the original image contents.

The NVT CABC function provides three operation modes, and these modes can be selected by the CMD1 register 55h. See command "Write Content Adaptive Brightness Control (55h)" (CABC\_COND[1:0]) for more information. These three modes are described as:

#### - Off Mode:

Content Adaptive Brightness Control functionality is completely turn-off. In this mode, the NT35596 will use the original Gamma 2.2 registers setting for display. And if the function of "forced PWM duty" is turn-off (i.e. "FORCE\_CABC\_PWM" is set as '0'), the PWM duty of the "LEDPWM" pin is 100%.

#### - UI [User interface] Image Mode (UI Mode):

This mode is applied to optimize for Ul image. It is kept image quality as much as possible. Target power consumption reduction ratio: 10% or less. NT35596 provides flexible configuration for Ul-Mode via setting the register to choose prefer quality and brightness.

#### Still Picture Mode (Still Mode):

This mode is used to gain a better display quality for still picture. Some image quality degradation would be acceptable. Target power consumption reduction ratio: more than 30%. The NT35596 will automatically determine a better gamma setting and PWM duty based on different image contents, so the reduction ratio of the power consumption of backlight is not a constant ratio, this ratio will vary between 10% ~ 40% with different image contents.

#### - Moving Image Mode (Moving Mode):

User can select this mode to keep the moving image quality and reduce the power consumption of backlight. It is focused on the biggest power reduction with image quality degradation. Target power consumption reduction ratio: more than 30%. For this mode, user can flexibly configure a specified gamma algorithm to keep prefer image quality, and the brightness of backlight is dynamically varying with different image contents.

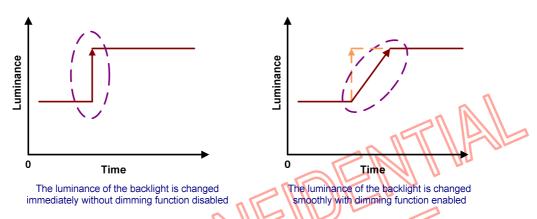
If the "force PWM duty" function is enabled (i.e. "FORCE\_CABC\_PWM" is set as '1') in any CABC mode, the output PWM duty of "LEDPWM" pin is followed the setting of "FORCE\_CABC\_DUTY[7:0]".

Note: The CABC can be operated only in the normal display mode.

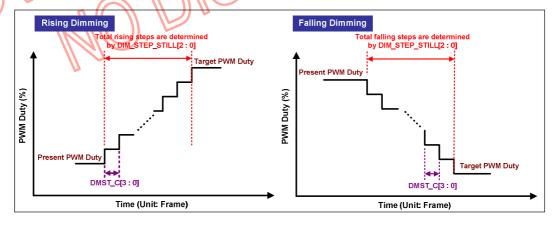


#### 5.4.2 Display Backlight Dimming Control

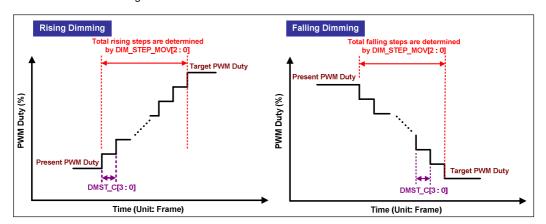
A dimming function (how fast to change the brightness from old to new level and what are brightness levels during the change) is used when changing from one brightness level to another. This dimming function curve is the same in increment and decrement directions. The basic concept is described below.



Dimming function can be enabled and disabled by setting the register 5300h (the setting bit name is "DD"). If "DD" is set as '0', the dimming function will be disabled, otherwise dimming function will be enabled while "DD" = '1'. From the original brightness value to the target brightness value, the transferring time steps between these two brightness values are equal making the linearly transition. The rising dimming (increase dimming) and the falling dimming (decrease dimming) use the same registers for setting ("DIM\_STEP\_STILL[2:0] and DMST\_C[3:0]", or "DIM\_STEP\_MOV[2:0] and DMST\_C[3:0]"). Below figure illustrate the "Fixed-Time" dimming curves for CABC each mode.



Dimming Mechanism in CABC Off-Mode / UI-Mode and Still-Mode

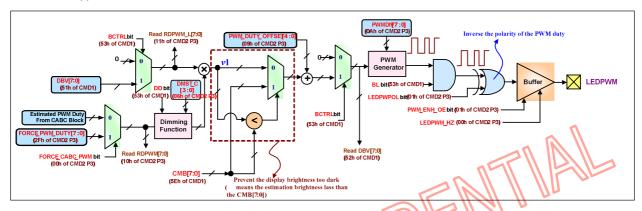


Dimming Mechanism in CABC Moving-Mode



#### 5.4.3 Brightness Control Lines for Backlight

The NT35596 have a "LEDPWM" pin which can output a PWM signal to the external LED driver IC. There are several control registers which are applied to control the "LEDPWM" status as illustrated in below.



Internal Display Backlight Control Combined With CABC and Manual brightness adjustment

The control bit "BL" is used to keep the LEDPWM in a fixed logic state, here are listed some application in below table:

BL	LEDPWPOL	Status of LEDPWM
0		0 (Default)
0	1	
1	<u> </u>	Original polarity of PWM signal
1		Inversed polarity of PWM signal

The setting bit "PWM\_ENH\_OE" is applied to improvement the driving ability of LEDPWM signal, here are listed two driving ability for selection:

PWM_ENH_OE	Status of LEDPWM
0	1X driving ability of LEDPWM
1	2X driving ability of LEDPWM

The setting bit "LEDPWM\_HZ" is applied to choose Hi-Z or output enables for "LEDPWM" pins, default 0 (output enable).

LEDPWM pin output	LEDPWPOL=0 &  LEDPWM_HZ=0	LEDPWPOL=1 &  LEDPWM_HZ=0	LEDPWM_HZ=1
(BL=1 and BCTRL=1 ) CABC off 0x5500=0	VDDI (LEDPWM_duty=100%)	GND (LEDPWM_duty=0%)	outputs Hi-Z
(BL=1 and BCTRL=1) CABC on 0x5500=1,UI mode 0x5500=2,still mode 0x5500=3,moving mode	PWM waveform (active high)	PWM waveform (active low)	outputs Hi-Z

#### CMB[7:0] (WRCABCMB[7:0]):

This register setting is used to limit the minimum PWM duty in order to prevent the backlight brightness too dark.



The registers PWMDIV[7:0] and PWM\_DUTY\_OFFSET[4:0] can change the frequency and duty compensation of the PWM signal. The PWM operation frequency "Fosc" is "not" the real PWM frequency, the "Fosc" is used to provide clock source for the internal PWM circuit. Two PWM operation frequencies can be chosen by setting register "PWMF", and the real PWM frequency can be quickly estimated by the bellow formula:

PWMF[1:0] (REG "09h" of CMD2 Page3)	PWM Operation Frequency (FOSC)	Real PWM Frequency of LEDPWM
00h	17.5MHZ	5000 . 1
01h (Default)	35MHZ	PWM Frequency = FOSC 256 * PWMDIV[7:0]
02h/03h	Reserved	

#### For Example:

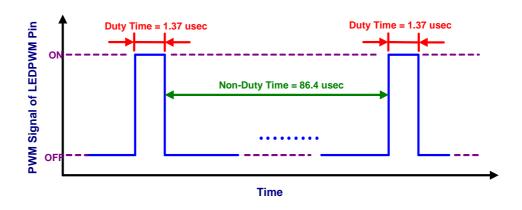
If the "PWMDIV[7:0]" = 0x0C and PWMF[1:0] = 01h, then:

PWMFrequency = 
$$\frac{35(MHz)}{256*PWMDIV[7:0]} = \frac{35(MHz)}{256*12} \approx 11.39(KHz)$$

In this condition, when PWM duty is estimated as "4" (Reading the register "RDDISBV[7:0]" = 03h), then the duty time of the PWM signal can be estimated as shown in below:

*PWMDutyTime* = 
$$\frac{4}{256} * \frac{1}{11.39(KHz)} = 1.37(u \text{ sec})$$

$$PWMNon - DutyTime = \frac{(256-4)}{256} * \frac{1}{11.39(KHz)} = 86.4(u \text{ sec})$$



The same, when PWM frequency is 11.39 KHz, and PWM duty of LEDPWM is 256 (Reading the register "RDDISBV[7:0]" = FFh), then the duty time can be estimated as shown in below:

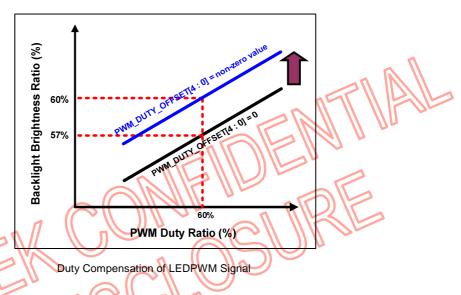
$$PWMDutyTime = \frac{256}{256} * \frac{1}{11.39(KHz)} = 87.8(u \text{ sec})$$



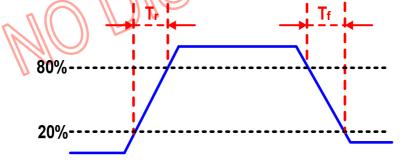
#### PWM\_DUTY\_OFFSET[4:0]:

Because the external LED driver needs some stable time to drive the LED backlight, this necessary stable time will reduce the effective PWM duty period, so the PWM\_DUTY\_OFFSET[4:0] is used to compensate effective PWM duty.

An example is shown in below. When PWM duty of LEDPWM signal is 60%, the backlight brightness should be 60% of original. But user may find that the backlight brightness is 57% of original. So user can set PWM\_DUTY\_OFFSET[4:0] and let the backlight brightness becomes 60% of original.



Notes: The rising time (Tr) and falling time (Tf) of the "LEDPWM" signal is stipulated to equal to or less than 15ns when maximum load is 30pF.





# 5.5 MIPI Interface (Mobile Industry Processor Interface)

The Display Serial Interface standard defines protocols between a host processor and peripheral devices that adhere to MIPI Alliance standards for mobile device interfaces. The DSI standard builds on existing standards by adopting pixel formats and command set defined in MIPI Alliance standards.

DSI-compliant peripherals support either of two basic modes of operation: Command Mode and Video Mode. Which mode is used depends on the architecture and capabilities of the peripheral. The mode definitions reflect the primary intended use of DSI for display interconnect, but are not intended to restrict DSI from operating in other applications.

Typically, a peripheral is capable of Command Mode operation or Video Mode operation. Some Video Mode display modules also include a simplified from of Command Mode operation in which the display module may refresh its screen from a reduced-size, or partial, frame buffer, and the interface (DSI) to the host processor may be shut down to reduce power consumption.

Command Mode refers to operation in which transactions primarily take the form of sending commands and data to a peripheral, such as a display module, that incorporates a display controller. The display controller may include local registers and a frame buffer. Systems using Command Mode write to, and read from, the registers and frame buffer memory. The host processor indirectly controls activity at the peripheral by sending commands, parameters and data to the display controller. The host processor can also read display module status information. Command Mode operation requires a bidirectional interface.

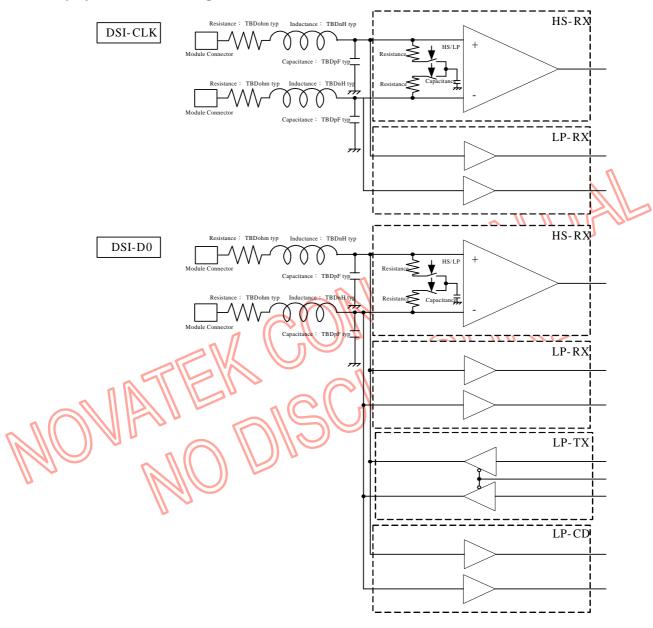
Video Mode refers to operation in which transfers from the host processor to the peripheral take the form of a real-time pixel stream. In normal operation, the display module relies on the host processor to provide image data at sufficient bandwidth to avoid flicker or other visible artifacts in the displayed image. Video information should only be transmitted using High Speed Mode. Some Video Mode architectures may include a simple timing controller and partial frame buffer, used to maintain a partial-screen or lower-resolution image in standby or Low Power Mode. This permits the interface to be shut down to reduce power consumption. To reduce complexity and cost, systems that only operate in Video Mode may use a unidirectional data path.

# Configuration:

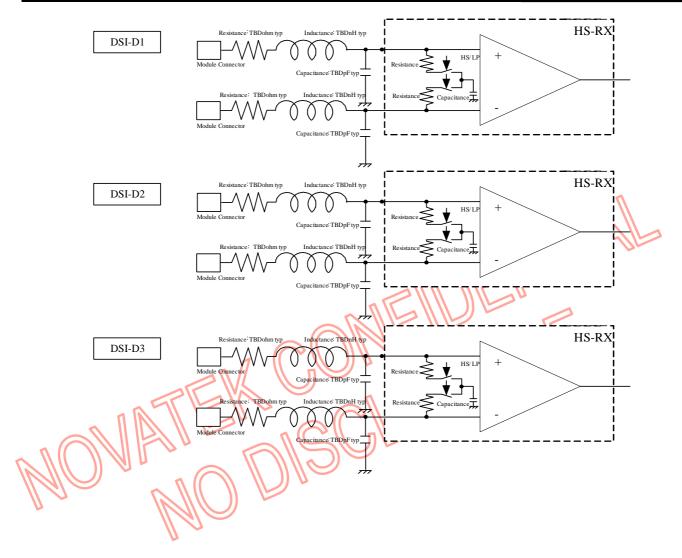
	MCU (Master) Display Module (Slave)
Clock Lane	Unidirectional Lane ■ Clock Only ■ Escape Mode(ULPS Only)
Data Lane 0	Bi-directional Lane ■ Forward High-Speed ■ Bi-directional Escape Mode ■ Bi-directional LPDT
Data Lane 1~3	Unidirectional ■ Forward High-Speed



# 5.5.1 Display Module Pin Configuration for DSI









# 5.5.2 Display Serial Interface (DSI)

# 5.5.2.1 General Description

Communication sequences between the MCU and the display module are described on chapter "5.5.2.3.3 Communication Sequences". The communication can be separated 2 different levels between the MCU and the display module:

- Low level communication what is done on the interface level
- High level communication what is done on the packet level

#### 5.5.2.2 Interface Level Communication

#### 5.5.2.2.1 General

The display module uses data and clock lane differential pairs for DSI (DSI-1M). Both differential lane pairs can be driven Low Power (LP) or High Speed (HS) mode.

Low Power mode means that each line of the differential pair is used in single end mode and a differential receiver is disable (A termination resistor of the receiver is disable) and it can be driven into a low power mode.

High Speed mode means that differential pairs (The termination resistor of the receiver is enable) are not used in the single end mode. There are used different modes and protocol in each mode when there is wanted to transfer information from the MCU to the display module and vice versa.

The State Codes of the High Speed (HS) and Low Power (LP) lane pair are defined below.

	<u> </u>	<del></del>					
Lane Pai	Line DC Vo	Itage Levels	High Speed(HS)	Low-Power(LP)			
State Cod	e Dx+ - line	Dx line	Burst Mode	Control Mode	Escape Mode		
HS-0	Low (HS)	High (HS)	Differential-0	Note 1	Note 1		
HS-1	High (HS)	Low (HS)	Differential-1	Note 1	Note 1		
LP-00	Low (LP)	Low (LP)	Not Defined	Bridge	Space		
LP-01	Low (LP)	High (LP)	Not Defined	HS-Request	Mark-0		
LP-10	High (LP)	Low (LP)	Not Defined	LP-Request	Mark-1		
LP-11	High (LP)	High (LP)	Not Defined	Stop	Note 2		

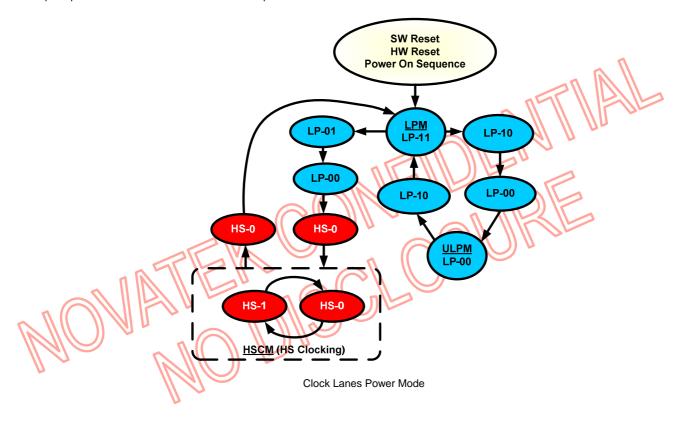
Notes 1: Low-Power Receivers (LP-Rx) of the lane pair are checking the LP-00 state code, when the Lane Pair is in the High Speed (HS) mode.

Notes 2: If Low-Power Receivers (LP-Rx) of the lane pair recognizes LP-11 state code, the lane pair returns to LP-11 of the Control mode.



#### 5.5.2.2.2 DSI-CLOCK Lanes

DSI-CLK+/- lanes can be driven into three different power modes: Low Power Mode (LPM), Ultra Low Power Mode (ULPM) or High Speed Clock Mode (HSCM). Clock lanes are in a single end mode (LP = Low Power) when there is entering or leaving Low Power Mode (LPM) or Ultra Low Power Mode (ULPM). Clock lanes are in the single end mode (LP = Low Power) when there is entering in or leaving out High Speed Clock Mode (HSCM). These entering and leaving protocols are using clock lanes in the single end mode to generate an entering or leaving sequences. The principle flow chart of the different clock lanes power modes is illustrated below

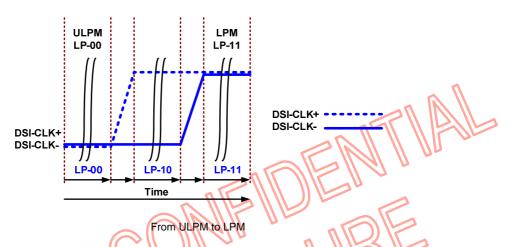




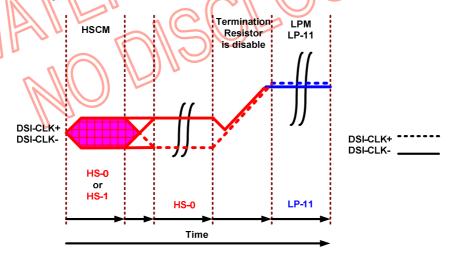
#### 5.5.2.2.2.1 Low Power Mode (LPM)

DSI-CLK+/- lanes can be driven to the Low Power Mode (LPM), when DSI-CLK lanes are entering LP-11 State Code, in three different ways:

- (1) After SW Reset, HW Reset or Power On Sequence =>LP-11
- (2) After DSI-CLK+/- lanes are leaving Ultra Low Power Mode (ULPM, LP-00 State Code) =>LP-10 =>LP-11 (LPM). This sequence is illustrated below.

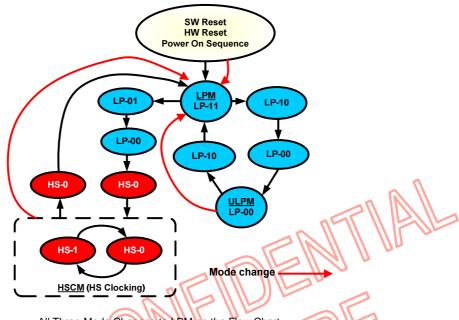


(3) After DSI-CLK+/- lanes are leaving High Speed Clock Mode (HSCM, HS-0 or HS-1 State Code) =>HS-0 =>LP-11 (LPM). This sequence and all three mode changes are illustrated below.



From High Speed Clock Mode (HSCM) to LPM

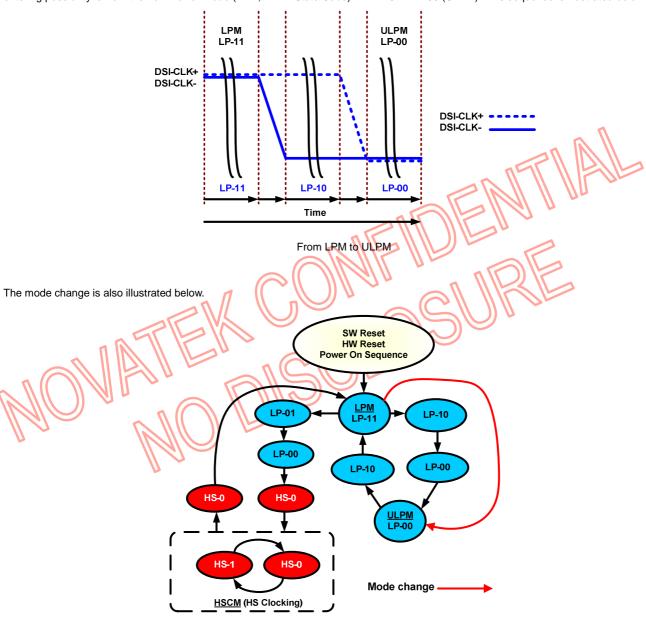






# 5.5.2.2.2 Ultra Low Power Mode (ULPM)

DSI-CLK+/- lanes can be driven to the Ultra Low power Mode (ULPM), when DSI-CLK lanes are entering LP-00 State Code. The only entering possibility is from the Low Power Mode (LPM, LP-11 State Code) =>LP-10 =>LP-00 (ULPM). This sequence is illustrated below.

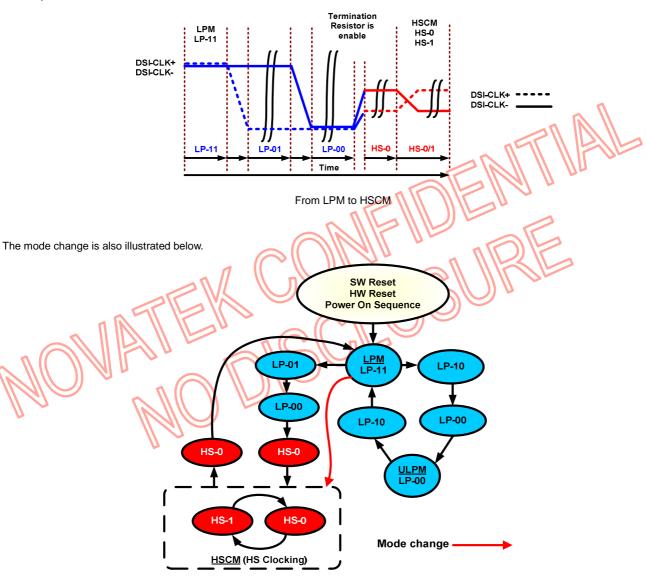


Mode Change from LPM to ULPM on the Flow Chart



#### 5.5.2.2.3 High Speed Clock Mode (HSCM)

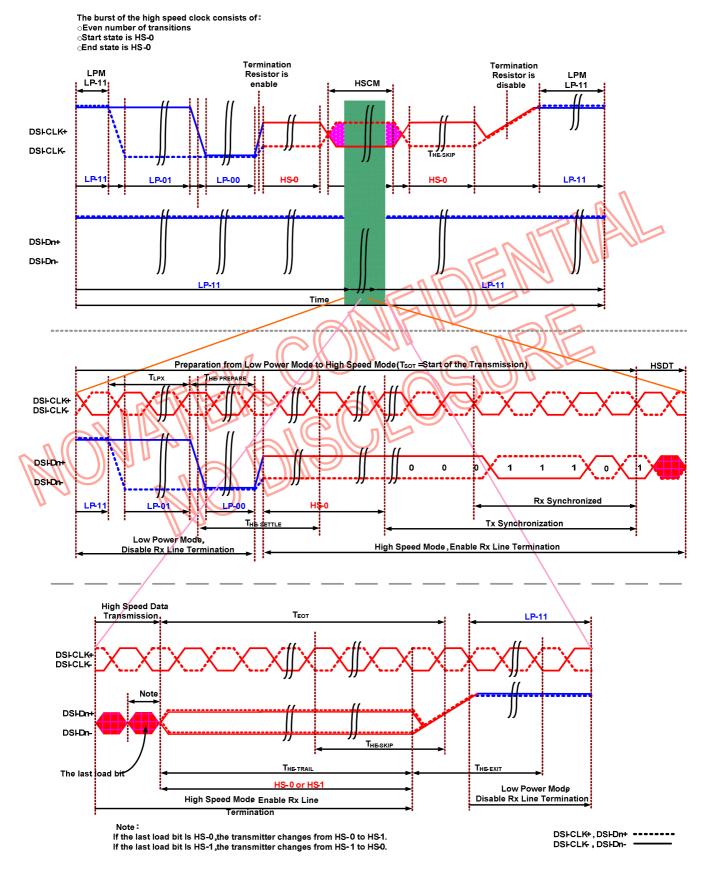
DSI-CLK+/- lanes can be driven to the High Speed Clock Mode (HSCM), when DSI-CLK lanes are starting to work between HS-0 and HS-1 State Codes. The only entering possibility is from the Low Power Mode (LPM, LP-11 State Code) =>LP-01 =>LP-00 =>HS-0 =>HS-0/1 (HSCM). This sequence is illustrated below.



Mode Change from LPM to HSCM on the Flow Chart

The high speed clock (DSI-CLK+/-) is started before high speed data is sent via DSI-D0+/- lanes. The high speed clock continues clocking after the high speed data sending has been stopped.





High Speed Clock Burst

Version 0.05



#### 5.5.2.2.3 DSI-DATA Lanes

#### 5.5.2.2.3.1 General

2012/06/22

DSI-Dn+/- Data Lanes can be driven in different modes which are:

- Escape Mode (Only DSI\_D0+/- data lanes is used)
- High-Speed Data Transmission (all data lanes are used)
- Bus Turnaround Request (Only DSI\_D0+/- data lanes is used)

These modes and their entering codes are defined on the following table.

# **Entering and Leaving Sequences:**

Mode	Entering Mode Sequence	Leaving Mode Sequence
Escape Mode	LP-11=>LP-10=>LP-00=>LP-01=>LP-00	LP-00=>LP-10=>LP-11(Mark-1)
High-Speed Data Transmission	LP-11=>LP-01=>LP-00=>HS-0	(HS-0 or HS-1) =>LP-11
Bus Turnaround Request	LP-11=>LP-10=>LP-00=>LP-10=>LP-00	High-Z





# 5.5.2.2.3.2 Escape Mode

Data lane0 (DSI-D0+/-) can be used in different Escape Modes when data lanes are in Low Power (LP) mode.

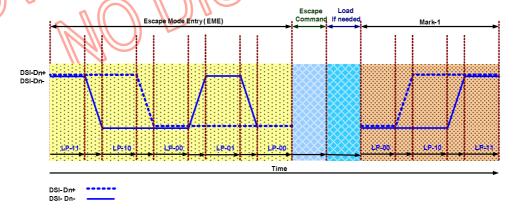
These Escape Modes are used to:

- Send "Low-Power Data Transmission" (LPDT) e.g. from the MCU to the display module
- Drive data lanes to "Ultra-Low Power State" (ULPS)
- Indicate "Remote Application Reset" (RAR), which is reset the display module
- Indicate "Tearing Effect" (TEE), which is used for a TE line event from the display module to the MCU
- Indicate "Acknowledge" (ACK), which is used for a non-error event from the display module to the MCU

The basic sequence of the Escape Mode is as follow

- Start: LP-11
- Escape Mode Entry (EME): LP-11 =>LP-10 =>LP-00 =>LP-01 =>LP-00
- Escape Command (EC), which is coded, when one of the data lanes is changing from low-to-high-to-low then this changed data lane is presenting a value of the current data bit (DSI-D0+ = 1, DSI-D0- = 0) e.g. when DSI-D0- is changing from low-to-high-to-low, the receiver is latching a data bit, which value is logical 0. The receiver is using this low-to-high-to-low transition for its internal clock.
- · A load if it is needed
- Exit Escape (Mark-1) LP-00 =>LP-10 =>LP-11
- End: LP-11

This basic construction is illustrated below:



# General Escape Mode Sequence

The number of the different Escape Commands (EC) is eight. These eight different escape commands (EC) can be divided 2 different groups: Mode or Trigger. The MCU is informing to the display module that it is controlling data lanes (DSI-D0+/-) with the mode e.g. The MCU can inform to the display module that it can put data lanes in the low power mode. The MCU is waiting from the display module event information, which has been set by the MCU, with the trigger e.g. when the display module reaches a new V-synch, the display module sent to the MCU a TE trigger (TEE), if the MCU has been requested it.



# **Escape Commands**

Escape Command	Command Type Mode/Trigger	Entry Command Pattern (First Bit => Last Bit Transmitted)	Dn	D0
Low-Power Data Transmission	Mode	1110 0001 bin	-	*
Ultra-Low Power Mode	Mode	0001 1110 bin	*	*
Underfined-1, Note	Mode	1001 1111 bin	-	-
Underfined-2, Note	Mode	1101 1110 bin	-	-
Remote Application Reset	Trigger	0110 0010 bin	-	*
Tearing Effect	Trigger	0101 1101 bin	-	*
Acknowledge	Trigger	0010 0001 bin	-	۸ <b>*</b>
Unknow-5, Note	Trigger	1010 0000 bin		\\-

Escape commands are defined

Notes: This Escape command support has not been implemented on the display module.

n=1: "★"= Supported; "-" = Not Supported



#### **Low-Power Data Transmission (LPDT)**

The MCU can send data to the display module in Low-Power Data Transmission (LPDT) mode when data lanes are entering in Escape Mode and Low-Power Data Transmission (LPDT) command has been sent to the display module. The display module is also using the same sequence when it is sending data to the MCU.

The Low Power Data Transmission (LPDT) is using a following sequence:

- Start: LP-11
- Escape Mode Entry (EME): LP-11 =>LP-10 =>LP-00 =>LP-01 =>LP-00
- Low-Power Data Transmission (LPDT) command in Escape Mode: 1110 0001 (First to Last bit)
- Load (Data):

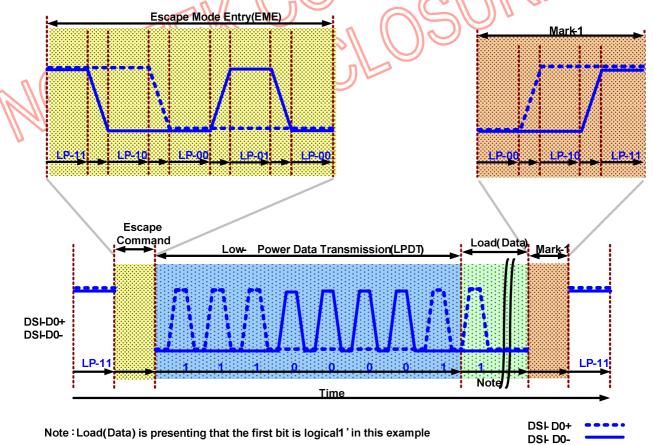
One or more bytes (8 bit)

Data lanes are in pause mode when data lanes are stopped (Both lanes are low) between bytes

• Mark-1: LP-00 =>LP-10 =>LP-11

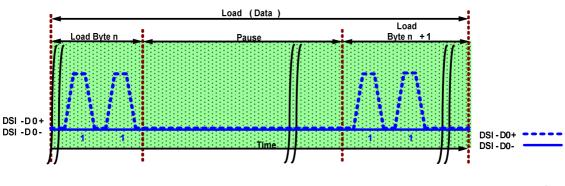
• End: LP-11

This sequence is illustrated for reference purposes below:



Low-Power Data Transmission (LPDT)





#### Pause (Example)

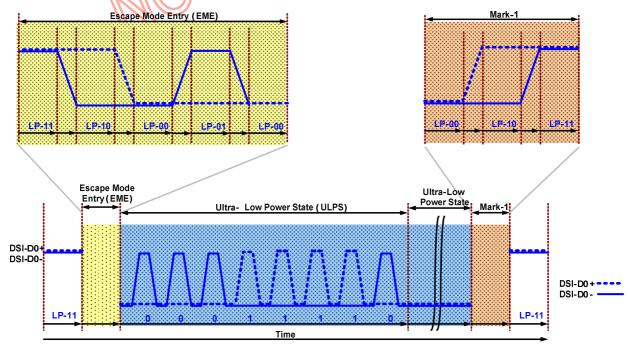
# Ultra-Low Power State (ULPS)

The MCU can force data lanes in Ultra-Low Power State (ULPS) mode when data lanes are entering in Escape Mode

The Ultra-Low Power State (ULPS) is using a following sequence:

- Start: LP-11
- Escape Mode Entry (EME): LP-11 =>LP-00 =>LP-01 =>LP-01
- Ultra-Low Power State (ULPS) command in Escape Mode: 0001 1110 (First to Last bit)
- Ultra-Low Power State (ULPS) when the MCU is keeping data lanes low
- Mark-1: LP-00 =>LP-10 =>LP-11
- End: LP-11

This sequence is illustrated for reference purposes below:



Ultra-Low Power State (ULPS)

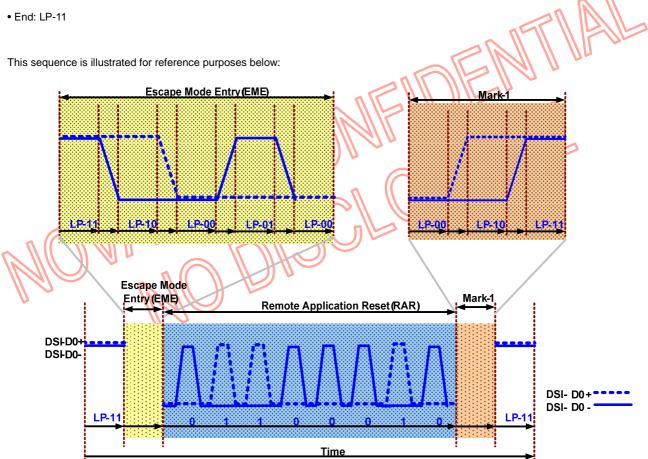


#### Remote Application Reset (RAR)

The MCU can inform to the display module that it should be reset in Remote Application Reset (RAR) trigger when data lanes are entering in Escape Mode.

The Remote Application Reset (RAR) is using a following sequence:

- Start: LP-11
- Escape Mode Entry (EME): LP-11 =>LP-10 =>LP-00 =>LP-01 =>LP-00
- Remote Application Reset (RAR) command in Escape Mode: 0110 0010 (First to Last bit)
- Mark-1: LP-00 =>LP-10 =>LP-11



Remote Application Reset (RAR)

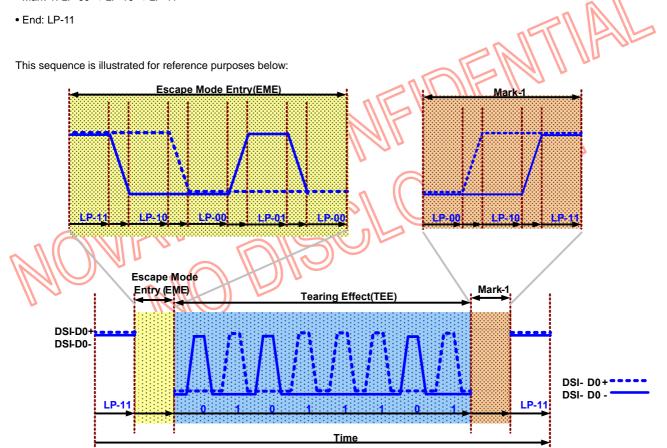


# Tearing Effect (TEE)

The display module can inform to the MCU when a tearing effect event (New V-synch) has been happen on the display module by Tearing Effect (TEE).

The Tearing Effect (TEE) is using a following sequence:

- Start: LP-11
- Escape Mode Entry (EME): LP-11 =>LP-10 =>LP-00 =>LP-01 =>LP-00
- Tearing Effect (TEE) trigger in Escape Mode: 0101 1101 (First to Last bit)
- Mark-1: LP-00 =>LP-10 =>LP-11



Tearing Effect (TEE)

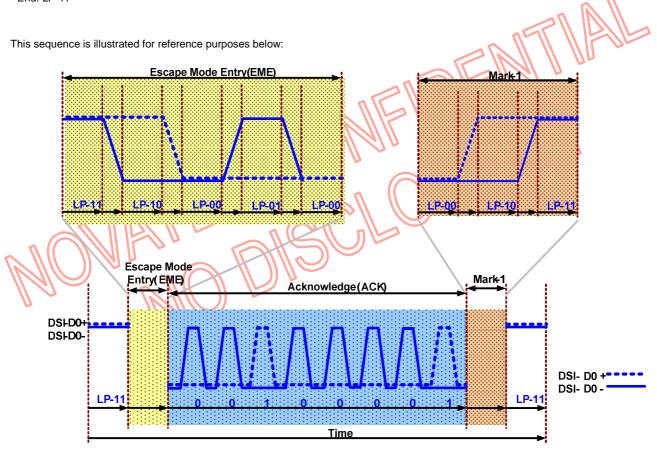


# Acknowledge (ACK)

The display module can inform to the MCU when an error has not recognized on it by Acknowledge (ACK).

The Acknowledge (ACK) is using a following sequence:

- Start: LP-11
- Escape Mode Entry (EME): LP-11 =>LP-10 =>LP-00 =>LP-01 =>LP-00
- Acknowledge (ACK) command in Escape Mode: 0010 0001 (First to Last bit)
- Mark-1: LP-00 =>LP-10 =>LP-11
- End: LP-11



Acknowledge (ACK)



#### 5.5.2.2.3.3 High Speed Data Transmission

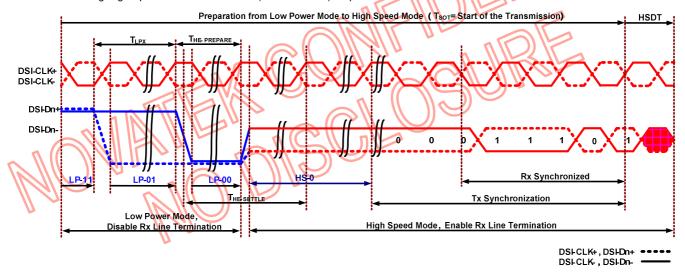
#### Entering High-Speed Data Transmission (Tsot of HSDT)

The display module is entering High-Speed Data Transmission (HSDT) when Clock lanes DSI-CLK+/- have already been entered in the High-Speed Clock Mode (HSCM) by the MCU. See more information on chapter "High-Speed Clock Mode (HSCM)".

Data lanes of the display module are entering (TsoT) in the High-Speed Data Transmission (HSDT) as follows

- Start: LP-11
- HS-Request: LP-01
- HS-Settle: LP-00 => HS-0 (Rx: Lane Termination Enable)
- Rx Synchronization: 011101 (Tx (= MCU) Synchronization: 0001 1101)
- End: High-Speed Data Transmission (HSDT) Ready to receive High-Speed Data Load

This same entering High-Speed Data Transmission (Tsot of HSDT) sequence is illustrated below.



Entering High-Speed Data Transmission (Tsot of HSDT)



#### Leaving High-Speed Data Transmission (TEOT of HSDT)

The display module is leaving the High-Speed Data Transmission (TEOT of HSDT) when Clock lanes DSI-CLK+/- are in the High-Speed Clock Mode (HSCM) by the MCU and this HSCM is kept until data lanes are in LP-11 mode. See more information on chapter "High-Speed Clock Mode (HSCM)".

Data lanes of the display module are leaving from the High-Speed Data Transmission (TEOT of HSDT) as follows

- Start: High-Speed Data Transmission (HSDT)
- Stops High-Speed Data Transmission

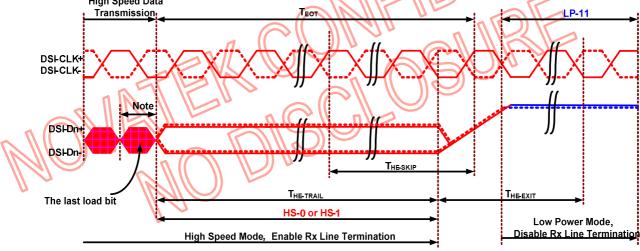
MCU changes to HS-1, if the last load bit is HS-0

MCU changes to HS-0, if the last load bit is HS-1

• End: LP-11 (Rx: Lane Termination Disable)

This same leaving High-Speed Data Transmission (TEOT of HSDT) sequence is illustrated below.

High Speed Data



Note:

If the last load bit Is HS0, the transmitter changes from HS-0 to HS-1. If the last load bit Is HS1, the transmitter changes from HS-1 to HS-0.

DSI-CLK+, DSI-Dn+---DSI-CLK-, DSI-Dn-

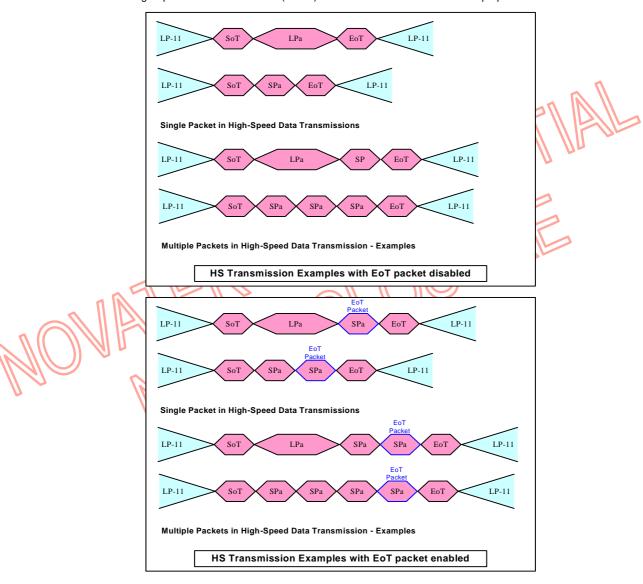
Leaving High-Speed Data Transmission (TEOT of HSDT)



# Burst of the High-Speed Data Transmission (HSDT)

The burst of the high-speed data transmission (HSDT) can consist of one data packet or several data packets. These data packets can be Long (LPa) or Short (SPa) packets. These packets are defined on chapter "Short Packet (SPa) and Long Packet (LPa) Structures".

These different burst of the High-Speed Data Transmission (HSDT) cases are illustrated for reference purposes below.



### Abbreviations:

Abbreviation	Explanation					
EoT	End of the Transmission					
LPa	Long Packet					
LP-11	Low Power Mode, Data lanes are'1's (Stop Mode)					
SPa	Short Packet					
SoT	Start of the Transmission					



### 5.5.2.3 Packet Level Communication

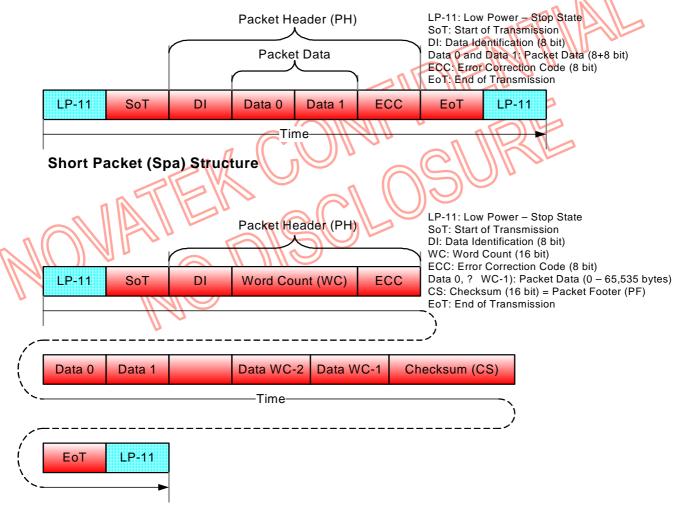
#### 5.5.2.3.1 Short Packet (SPa) and Long Packet (LPa) Structures

Short Packet (SPa) and Long Packet (LPa) are always used when data transmission is done in Low Power Data Transmission (LPDT) or High-Speed Data Transmission (HSDT) modes.

The lengths of the packets are

- Short Packet (SPa): 4 bytes
- Long Packet (LPa): From 6 to 65,541 bytes

The type (SPa or LPa) of the packet can be recognized from their package headers (PH).



# Long Packet (Lpa) Structure

#### Note

Short Packet (SPa) Structure and Long Packet (LPa) Structure are presenting a single packet sending (= Includes LP-11, SoT and EoT for each packet sendings).

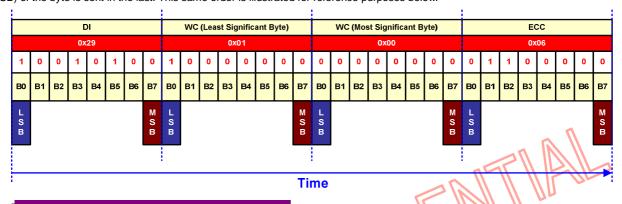
The other possibility is that there is not needed SoT, EoT and LP-11 between packets if packets have sent in multiple packet format e.g.

- \* LP-11 =>SoT =>SPa =>LPa =>SPa =>EoT =>LP-11
- \* LP-11 =>SoT =>SPa =>SPa =>EoT =>LP-11
- \* LP-11 =>SoT =>LPa =>LPa =>EoT =>LP-11



#### 5.5.2.3.1.1 Bit Order of Byte on Packets

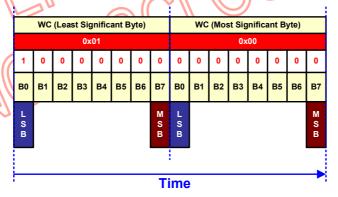
The bit order of the byte, what is used on packets, is that the Least Significant Bit (LSB) of the byte is sent in the first and the Most Significant Bit (MSB) of the byte is sent in the last. This same order is illustrated for reference purposes below.



Bit Order of the Byte on Packet

# 5.5.2.3.1.2 Byte Order of the Multiple Byte Information on Packets

Byte order of the multiple bytes information, what is used on packets, is that the Least Significant (LS) Byte of the information is sent in the first and the Most Significant (MS) Byte of the information is sent in the last e.g. Word Count (WC) consists of 2 bytes (16 bits) when the LS byte is sent in the first and the MS byte is sent in the last. This same order is illustrated for reference purposes below.



Byte Order of the Multiple Byte on Packet

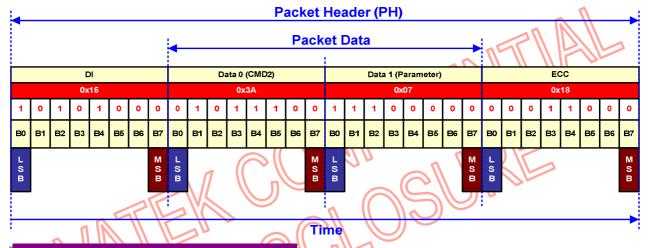


#### 5.5.2.3.1.3 Packet Header (PH)

The packet header is always consisting of 4 bytes. The content of these 4 bytes are different if it is used to Short Packet (SPa) or Long Packet (LPa).

#### Short Packet (SPa):

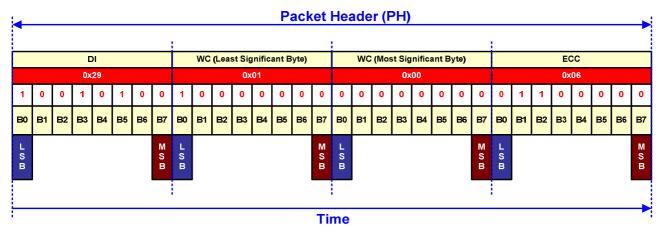
- 1st byte: Data Identification (DI) => Identification that this is Short Packet (SPa)
- 2nd and 3rd bytes: Packet Data (PD), Data 0 and 1
- 4th byte: Error Correction Code (ECC)



Packet Header (PH) on Short Packet (Spa)

#### Long Packet (LPa):

- 1st byte: Data Identification (DI) => Identification that this is Long Packet (LPa)
- 2nd and 3rd bytes: Word Count (WC)
- 4th byte: Error Correction Code (ECC)



Packet Header (PH) on Long Packet (Lpa)



# Data Identification (DI)

Data Identification (DI) is a part of Packet Header (PH) and it consists of 2 parts:

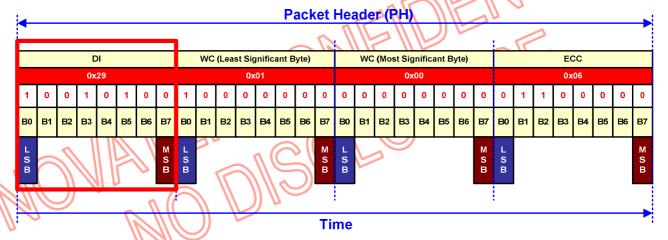
- Virtual Channel (VC), 2 bits, DI[7...6]
- Data Type (DT), 6 bits, DI[5...0]

The Data Identification (DI) structure is illustrated on a table below.

# **Data Identification (DI) Structure**

	Data Identification (DI)										
Virtual Cha	annel (VC)	Data Type (DT)									
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0				

Data Identification (DI) is illustrated on Packet Header (PH) for reference purposes below.

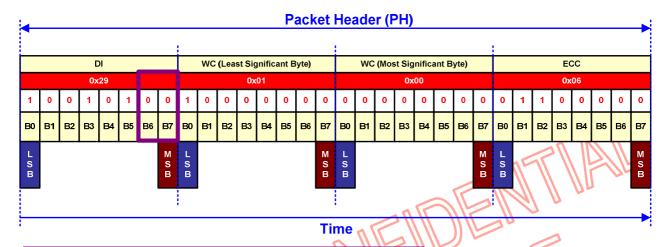


Data Identification (DI) on the Packet Header (PH)



#### Virtual Channel (VC)

Virtual Channel (VC) is a part of Data Identification (DI[7...6]) structure and it is used to address where a packet is wanted to send from the MCU. Bits of the Virtual Channel (VC) are illustrated for reference purposes below.

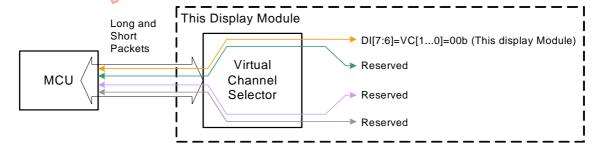


# Virtual Channel (VC) on the Packet Header (PH)

Virtual Channel (VC) can address 4 different channels for e.g. 4 different display modules. Devices are using the same virtual channel what the MCU is using to send packets to them e.g.

- The MCU is using the virtual channel 0 when it sends packets to this display module
- This display module is also using the virtual channel 0 when it sends packets to the MCU

This functionality is illustrated below.



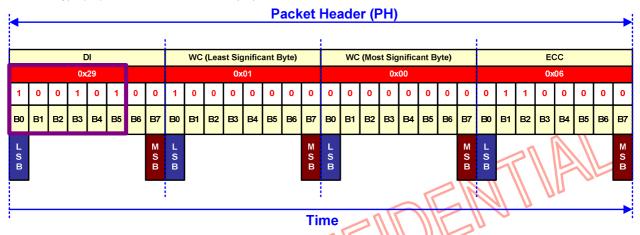
Virtual Channel (VC) Configuration



# Data Type (DT)

Data Type (DT) is a part of Data Identification (DI[5...0]) structure and it is used to define a type of the used data on a packet.

Bits of the Data Type (DT) are illustrated for reference purposes below.



Data Type (DT) on the Packet Header (PH)



This Data Type (DT) also defines what the used packet is: Short Packet (SPa) or Long Packet (LPa). Data Types (DT) are different from the MCU to the display module (or other devices) and vice versa. This Data Type (DT) are defined on tables below.

Data Type (DT) from MCU to the Display Module (or Other Devices)

Data Type, hex	Data Type, binary	Description	Packet Size	Note
01h	00 0001	Sync Event, V Sync Start	Short	
11h	01 0001	Sync Event, V Sync End	Short	
21h	10 0001	Sync Event, H Sync Start	Short	
31h	11 0001	Sync Event, H Sync End	Short	
08h	00 1000	End of Transmission (EoT) packet	Short 1	
02h	00 0010	Color mode (CM) Off Command	Short	
12h	01 0010	Color mode (CM) On Command	Short	
03h	00 0011	Generic Short Write, no parameter	Short	
13h	01 0011	Generic Short Write, 1 parameter	Short	1,2
23h	10 0011	Generic Short Write, 2 parameter	Short	1,3
29h	10 1001	Generic Long Write	Long	1
04h	00 0100	Generic Read, no parameter	Short	
14h	01 0100	Generic Read, 1 parameter	Short	1,2
24h	10 0100	Generic Read, 2 parameter	Short	1,3
05h	00 0101	DCS WRITE, no parameters	Short	
15h	01 0101	DCS WRITE, 1 parameter	Short	
06h 📶	00 0110	DCS READ, no parameters	Short	
37h	11 0111	Set Maximum Return Packet Size	Short	
09h	00 1001	Null Packet, no data	Long	
19h	01 1001	Blanking Packet, no data	Long	
39h	11 1001	DCS Long Write/Write LUT Command Packet	Long	
0Eh	00 1110	Packed Pixel Stream,16-bits RGB, 5-6-5 Format	Long	
1Eh	01 1110	Packed Pixel Stream,18-bits RGB, 6-6-6 Format	Long	
2Eh	10 1110	Loosely Packed Pixel Stream,18-bits RGB, 6-6-6 Format	Long	
3Eh	11 1110	Packed Pixel Stream,24-bits RGB, 8-8-8 Format	Long	
x0h and xFh unspecified	xx 0000 xx 1111	DON'T USE (All unspecified codes are reserved)		

Note: 1. The receiver process packets with data type (Generic Write/Read) the same way as data type (DCS Write / Read).

- 2. Generic Write/Read with 1 parameter: Payload Bytes = Command + 00h.
- 3. Generic Write/Read with 2 parameter: Payload Bytes = Command + Parameter.
- 4. The receiver will ignore packets with data type that neither listed in table above nor in MIPI DSI spec.

Data Type (DT) from the Display Module (or Other Devices) to the MCU

					Fro	m the I	Display Module (or Other Devices) to the MCU		
Hex	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Description	Short / Long Packet	Abbreviation
02h	0	0	0	0	1	0	Acknowledge with Error Report	Short	AwER
08h	0	0	1	0	0	0	End of Transmission (EoT) packet	EoT	
1Ch	0	1	1	1	0	0	DCS Read Long Response	Long	DCSRR-L
21h	1	0	0	0	0	1	DCS Read Short Response, 1 byte returned	Short	DCSRR1-S
22h	1	0	0	0	1	0	DCS Read Short Response, 2 byte returned	Short	DCSRR2-S
1Ah	0	1	1	0	1	0	Generic Read Long Response	Long	GENRR-L
11h	0	1	0	0	0	1	Generic Read Short Response, 1 byte returned	Short	GENRR1-S
12h	0	1	0	0	1	0	Generic Read Short Response, 2 byte returned	Short	GENRR2-S

The receiver will ignore other Data Type (DT) if they are not defined on tables: "Data Type (DT) from the MCU to the Display Module (or Other

Devices)" or "Data Type (DT) from the Display Module (or Other Devices) to the MCU".

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# Availability of MIPI Data Type for Instruction Code (User Command Set)

MIPI Data Type	03h	13h	23h	29h (GENW-L)	04h	14h	24h (GENR2-S)	05h (DCSWN-S)	15h (DCSW1-S)	39h	06h (DCSRN-S)
Instruction Code	(GLIWIN-3)	(GENW1-S)	(GLNW2-3)	(GLNW-L)	(GENRN-S)  Availab	ility of MIPI Da		(DCSWN-3)	(DC3W1-3)	(DCSW-L)	(DC3KN-3)
00h (NOP)								Yes	Yes	Yes	
01h (SOFT_RESET)								Yes	Yes	Yes	
05h (RDNUMED)											Yes
0Ah (GET_POWER_MODE)										2	Yes
0Bh (GET_ADDRESS_MODE)									an A	1 //	Yes
0Dh (GET_DISPLAY_MODE)								2 115			Yes
0Eh (GET_SIGNAL_MODE)								D	11 111		Yes
0Fh (RDDSDR)						7111	111/-				Yes
10h (ENTER_SLEEP_MODE)					1111			Yes	Yes	Yes	
11h (EXIT_SLEEP_MODE)					M			Yes	Yes	Yes	
20h (EXIT_INVERT_MODE)			7 ((				$   \epsilon  $	Yes	Yes	Yes	
21h (ENTER_INVERT_MODE)	75				2			Yes	Yes	Yes	
26h (GMASET)					$\mathcal{I}$				Yes	Yes	
28h (SET_DISPLAY_OFF)					八几			Yes	Yes	Yes	
29h (SET_DISPLAY_ON)								Yes	Yes	Yes	
34h (SET_TEAR_OFF)	2			U				Yes	Yes	Yes	
35h (SET_TEAR_ON)			_						Yes	Yes	Yes
36h (SET_ADDRESS_MODE)	17								Yes	Yes	Yes
3Bh (MIPICTRL)										Yes	Yes
44h/45h										Vos	Vos
(SET_TEAR_SCANLINE)										Yes	Yes
46h (RDSCL)											Yes
4Fh (ENTER_DSTB_MODE)									Yes	Yes	



# NT35596

MIDI Data Typo	03h	13h	23h	29h	04h	14h	24h	05h	15h	39h	06h
MIPI Data Type	(GENWN-S)	(GENW1-S)	(GENW2-S)	(GENW-L)	(GENRN-S)	(GENR1-S)	(GENR2-S)	(DCSWN-S)	(DCSW1-S)	(DCSW-L)	(DCSRN-S)
Instruction Code					Availab	lity of MIPI Da	ata Type				
51h (WRIDSBV)									Yes	Yes	Yes
52h (RDDISBV)											Yes
53h (WRCTRLD)									Yes	Yes	
54h (RDCTRLD)										0	Yes
55h (WRCABC)									Yes	Yes	
56h (RDCABC)										-//IF	Yes
5Eh (WRCABCMB)								D	Yes	Yes	
5Fh (RDCABCMB)						MIC			_		Yes
A1h (RDDDBS)							シー				Yes
A8h (RDDDBC)			(6								Yes
AAh (RDFCS)		. 5 /	7				116				Yes
AFh (RDCCS)	1				•			クロ			Yes
BAh(SET_MIPI_LANE)							)		Yes	Yes	Yes
BCh (3D-Barrier Ctrl)	7///				_ Л\L	7			Yes	Yes	Yes
D2h~D6h (RGB/MIPI Ctrl)					)				Yes	Yes	Yes
DAh (RDID1)	110			U							Yes
DBh (RDID2)											Yes
DCh (RDID3)	11 .										Yes
F3h(Multi-IF Function)									Yes	Yes	Yes
F4h (NOVATEK ID)											Yes
F5h (IF-TEST)									Yes	Yes	Yes
F6h~F7h (EXT CLK)									Yes	Yes	Yes
F8h (I2C SLAVE ADDR.)									Yes	Yes	Yes
F9h (PIXEL EXTEN.)									Yes	Yes	Yes
FEh (RDCMDSTATUS)											Yes



# Packet Data (PD) on the Short Packet (SPa)

Packet Data (PD) of the Short Packet (SPa) is defined after Data Type (DT) of the Data Identification (DI) has indicated that Short Packet (SPa) is wanted to send.

Packet Data (PD) of the Short Packet (SPa) consists of 2 data bytes: Data 0 and Data 1.

Packet Data (PD) sending order is that Data 0 is sent in the first and the Data 1 is sent in the last.

Bits of Data 1 are set to '0' if the information length is 1 byte.

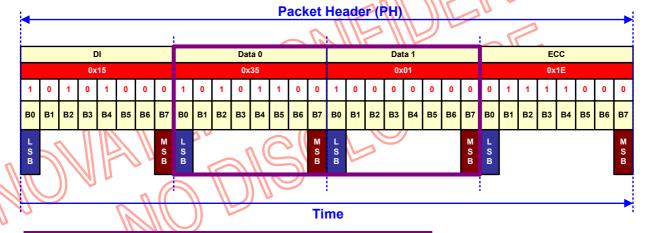
Packet Data (PD) of the Short Packet (SPa), when the length of the information is 1 or 2 bytes are illustrated for reference purposes below, when

Virtual Channel (VC) is 0.

Packet Data (PD) information:

• Data 0: 35hex (Display Command Set (DCS) with 1 Parameter => DI(Data Type (DT)) = 15hex)

• Data 1: 01hex (DCS's parameter)

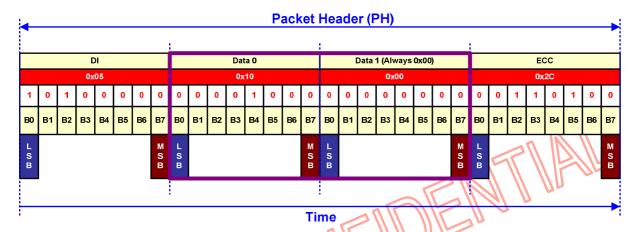


Packet Data (PD) for Short Packet (SPa), 2 Bytes Information



# Packet Data (PD) Information:

- Data 0: 10hex (DCS without parameter => DI(Data Type (DT)) = 05hex)
- Data 1: 00hex (Null)



Packet Data (PD) for Short Packet (SPa), 1 Byte Information



#### Word Count (WC) on the Long Packet (LPa)

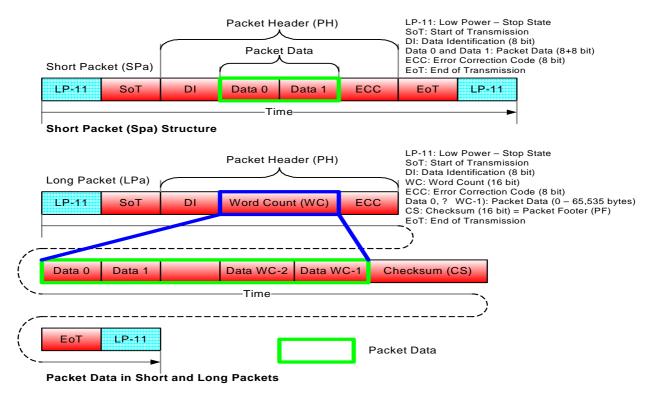
Word Count (WC) of the Long Packet (LPa) is defined after Data Type (DT) of the Data Identification (DI) has indicated that Long Packet (LPa) is wanted to send.

Word Count (WC) indicates a number of the data bytes of the Packet Data (PD) what is wanted to send after Packet Header (PH) versus Packet Data (PD) of the Short Packet (SPa) is placed in the Packet Header (PH).

Word Count (WC) of the Long Packet (LPa) consists of 2 bytes.

These 2 bytes of the Word Count (WC) sending order is that the Least Significant (LS) Byte is sent in the first and the Most Significant (MS) Byte is sent in the last.

Word Count (WC) on the Long Packet (LPa)



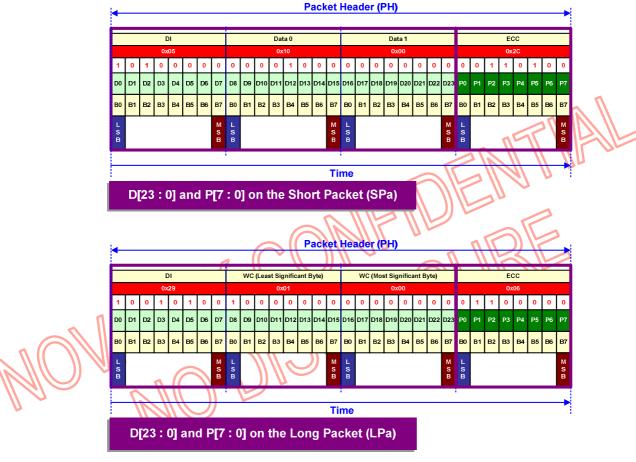
Error Correction Code (ECC)



Error Correction Code (ECC) is a part of Packet Header (PH) and its purpose is to identify an error or errors:

- Short Packet (SPa): Data Identification (DI) and Packet Data (PD) bytes (24 bits: D[23...0])
- Long Packet (LPa): Data Identification (DI) and Word Count (WC) bytes (24 bits: D[23...0])

D[23...0] is illustrated for reference purposes below.

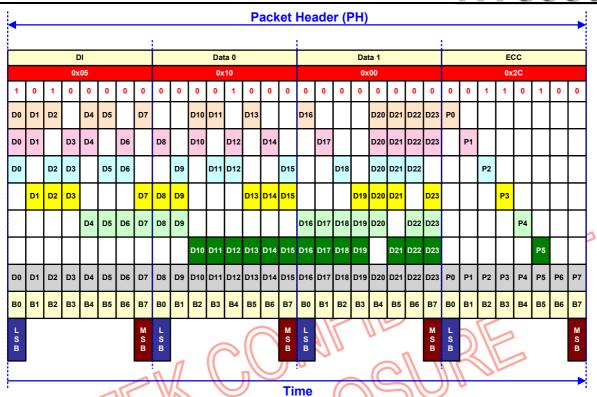


Error Correction Code (ECC) can recognize one error or several errors and makes correction in one bit error case.

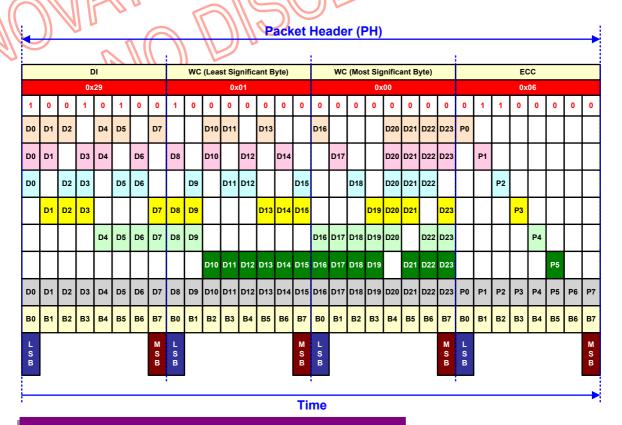
Bits (P[7...0]) of the Error Correction Code (ECC) are defined, where the symbol 'A' is presenting XOR function (Pn is '1' if there is odd number of '1's and Pn is '0' if there is even number of '1's), as follows.

- P7 = 0
- P6 = 0
- P5 = D10^D11^D12^D13^D14^D15^D16^D17^D18^D19^D21^D22^D23
- P4 = D4^D5^D6^D7^D8^D9^D16^D17^D18^D19^D20^D22^D23
- P3 = D1^D2^D3^D7^D8^D9^D13^D14^D15^D19^D20^D21^D23
- P2 = D0^D2^D3^D5^D6^D9^D11^D12^D15^D18^D20^D21^D22
- P1 = D0^D1^D3^D4^D6^D8^D10^D12^D14^D17^D20^D21^D22^D23
- P0 = D0^D1^D2^D4^D5^D7^D10^D11^D13^D16^D20^D21^D22^D23

P7 and P6 are set to '0' because Error Correction Code (ECC) is based on 64 bits value ([D63...0]), but this implementation is based on 24 bits value (D[23...0]). Therefore, there is only needed 6 bits (P[5...0]) for Error Correction Code (ECC).



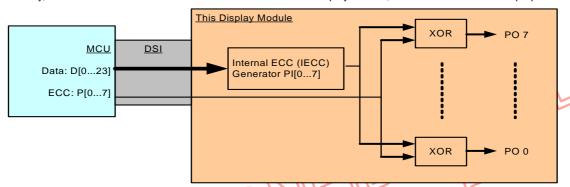
**XOR Functionality on the Short Packet (SPa)** 



**XOR Functionality on the Long Packet (LPa)** 

The transmitter (The MCU or the Display Module) is sending data bits D[23...0] and Error Correction Code (ECC) P[7...0]. The receiver (The Display module or the MCU) is calculate an Internal Error Correction Code (IECC) and compares the received Error Correction Code (ECC) and the Internal Error Correction Code (IECC). This comparison is done when each power bit of ECC and IECC have been done XOR function. The result of this function is PO[7...0].

This functionality, where the transmitter is the MCU and the receiver is the display module, is illustrated for reference purposes below.



Internal Error Correction Code (IECC) on the Display Module (The Receiver)

The sent data bits (D[23...0]) and ECC (P[7...0]) are received correctly, if a value of the PO[7...0]) is 00h. The sent data bits (D[23...0]) and ECC (P[7...0]) are not received correctly, if a value of the PO[7...0]) is not 00h.

ECC P[70]	1	1	0	0	0	0	0	0	03h
ECC P[[70]	1	1	0	0	0	0	0	0	03h
XOR(ECC,IECC) =>PO[7,0]	0	0	0	0	0	0	0	0	=00h => No Error
	-)	IJ						М	
	S							s	
U	В							В	

Internal XOR Calculation between ECC and IECC Values - No Error

ECC P[70]	1	1	0	0	0	0	0	0	03h
IECC PI[70]	1	1	1	1	0	0	0	0	0Fh
XOR(ECC,IECC) =>PO[70]	0	0	1	1	0	0	0	0	=0Ch => Error
	L							М	
	S							S	
	В							В	

Internal XOR Calculation between ECC and IECC Values - Error

The received Error Correction Code (ECC) can be 00h when the Error Correction Code (ECC) functionality is not used for data values D[23...0] on the transmitter side.



The number of the errors (one or more) can be defined when the value of the PO[7...0] is compared to values on the following table.

One Bit Error Value of the Error Correction Code (ECC)

Data Bit	P07	PO6	PO5	PO4	PO3	PO2	PO1	PO0	Hex
D[0]	0	0	0	0	0	1	1	1	07h
D[1]	0	0	0	0	1	0	1	1	0Bh
D[2]	0	0	0	0	1	1	0	1	0Dh
D[3]	0	0	0	0	1	1	1	0	0Eh
D[4]	0	0	0	1	0	0	1	1	13h
D[5]	0	0	0	1	0	1	0	1	15h
D[6]	0	0	0	1	0	1	1	0	16h
D[7]	0	0	0	1	1	0	0	1	19h
D[8]	0	0	0	1	1	0	1	0	1Ah
D[9]	0	0	0	1	1	1	0	0	1Ch
D[10]	0	0	1	0	0	0	1	1	23h
D[11]	0	0	1	0	0	1	0	1	25h
D[12]	0	0	1	0	0	1	1	0	26h
D[13]	0	0	1	0	1	0	0	1	<b>2</b> 9h
D[14]	0	0	1	0	1	0	1	0	2Ah
D[15]	0	0	1	0	1	1	0	0	2Ch
D[16]	0	0	1	1	0	0	0	1	31h
D[17]	0	0	1	1	0	0	1	0	32h
D[18]	0	0	1	1	0	1	0	0	34h
D[19]	0	0	1	1	1	0	0	0	38h
D[20]	0	0	0	1	1	1	1	1	1Fh
D[21]	0	0	1	0	1	1	1	1	2Fh
D[22]	0	0	1	1	0	1	1	1	37h
D[23]	0	0	1	1	1	0	1	1	3Bh

One error is detected if the value of the PO[7...0] is on: One Bit Error Value of the Error Correction Code (ECC) and the receiver can correct this one bit error because this found value also defines what is a location of the corrupt bit e.g.

- PO[7...0] = 0Eh
- The bit of the data (D[23...0]), what is not correct, is D[3]

More than one error is detected if the value of the PO[7...0] is not on: One Bit Error Value of the Error Correction Code (ECC) e.g. PO[7...0] = 0Ch.



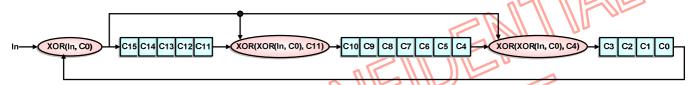
## 5.5.2.3.1.4 Packet Data (PD) on the Long Packet (LPa)

Packet Data (PD) of the Long Packet (LPa) is defined after Packet Header (PH) of the Long Packet (LPa). The number of the data bytes is defined on chapter "Word Count (WC) on the Long Packet (LPa)".

#### 5.5.2.3.1.5 Packet Footer (PF) on the Long Packet (LPa)

Packet Footer (PF) of the Long Packet (LPa) is defined after the Packet Data (PD) of the Long Packet (LPa). The Packet Footer (PF) is a checksum value what is calculated from the Packet Data of the Long Packet (LPa).

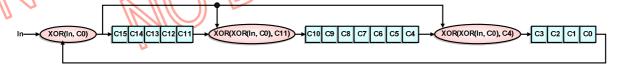
The checksum is using a 16-bits Cyclic Redundancy Check (CRC) value which is generated with a polynomial X16+X12+X5+X0 as it is illustrated below.



#### 16-bits Cyclic Redundancy Check (CRC) Calculation

The 16-bits Cyclic Redundancy Check (CRC) generator is initialized to FFFFh before calculations. The Least Significant Bit (LSB) of the data byte of the Packet Data (PD) is the first bit what is inputted into the 16-bits Cyclic Redundancy Check (CRC).

An example of the 16-bits Cyclic Redundancy Check (CRC), where the Packet Data (PD) of the Long Packet (LPa) is 01h, is illustrated (step-by-step) below.



Step	In	XOR(In, C0)	C15	C14	C13	C12	C11	XOR(XOR(In, C0), C11(Step - 1))	C10	С9	С8	C7	C6	C5	C4	XOR(XOR(In, C0), C4(Step - 1))	СЗ	C2	C1	C0	C0
0	х	х	1	1	1	1	1	х	1	1	1	1	1	1	1	х	1	1	1	1	х
1	1 (LSB)	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
2	0	1	1	0	1	1	1	0	0	1	1	1	1	1	1	0	0	1	1	1	1
3	0	1	1	1	0	1	1	0	0	0	1	1	1	1	1	0	0	0	1	1	1
4	0	1	1	1	1	0	1	0	0	0	0	1	1	1	1	0	0	0	0	1	1
5	0	1	1	1	1	1	0	0	0	0	0	0	1	1	1	0	0	0	0	0	0
6	0	0	0	1	1	1	1	0	0	0	0	0	0	1	1	1	1	0	0	0	0
7	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0	1	1	1	0	0	0
8	0 (MSB)	0	0	0	0	1	1	1	1	1	0	0	0	0	0	1	1	1	1	0	0
	1 Byte	CRC Result	0	0	0	1	1		1	1	0	0	0	0	0		1	1	1	0	
		'	мѕв					•								•				LSB	



A value of the Packet Footer (PF) is 1E0Eh in this example. This example (Command 01h has been sent) is illustrated below.

<b>—</b>																						_															
					D	)I								WC	C (L	eas	t Si	gnif	icant	Byt	te)	٧	/C (I	Vlost	Sig	nific	ant	Byte	∍)				E	CC			
				(	0x3	39	)										0)	01							0x	00							0x	15			
1	0	)	0	1	1	1	1		1	0		0	1	I	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	1	0	1	0	1	0	0	0
30	В1	1 1	B2	В	33	B4	4	E	35	В	6	В7	В	0	В1	B2	ВЗ	В4	В5	В6	В7	В0	В1	B2	В3	В4	В5	В6	В7	В0	В1	B2	ВЗ	В4	B5	В6	В7
L S B		•					•					M S B	L S E		•						M S B	L S B							M S B	L S B							M S B
																				• Ti	me											NE	1	1/1	$\backslash $		1
																									- 1	n 5		1		2/2	M	1	7 //		17	U	
											-		•		Pa	ack			ta (	PD								- 1	1	: 11	ert	_<				U	<b>—</b>
/										•	-				Pa	ack	Da	ta 0		PD		CF	RC (I	Leas		gnifi		- 1	1	: 11	er (	_<	t Sig		ican	t Byt	te)
/												25	1	Ī	P:	ack 0	Da			0	0	CF 0	1 1	Leas	et Sig	gnifi		- 1	1	: 11	10	_<	t Sig	gnifi 1E	icani 0	t Byt	te)
						1'							1 B	+	0	0	Da 02	ta 0		0	0	0	1	1	0x	gnifi 0E 0	can 0	t Byt	te)	0	RC (I	Mos 1	t Sig 0x 1	1E 1	0	0	0
													1 B L S E	0	0	0	Da 02	ta 0	0	0	0	0 B0 L	1	1	0x	gnifi 0E 0	can 0	t Byt	te)	0	RC (I	Mos 1	t Sig 0x 1	1E 1	0	0	0
													L	0	0	0	Da 02	ta 0	0	0	0 B7 M S	0 B0 L	1	1	0x	gnifi 0E 0	0 B5	t Byt	0 B7	0 B0 L	RC (I	Mos 1	t Sig 0x 1	1E 1	0	0	0 B7 M S

The receiver is calculated own checksum value from received Packet Data (PD). The receiver compares own checksum and the Packet Footer (PF) what the transmitter has sent.

The received Packet Data (PD) and Packet Footer (PF) are correct if the own checksum of the receiver and Packet Footer (PF) are equal and vice versa the received Packet Data (PD) and Packet Footer (PF) are not correct if the own checksum of the receiver and Packet Footer (PF) are not equal.

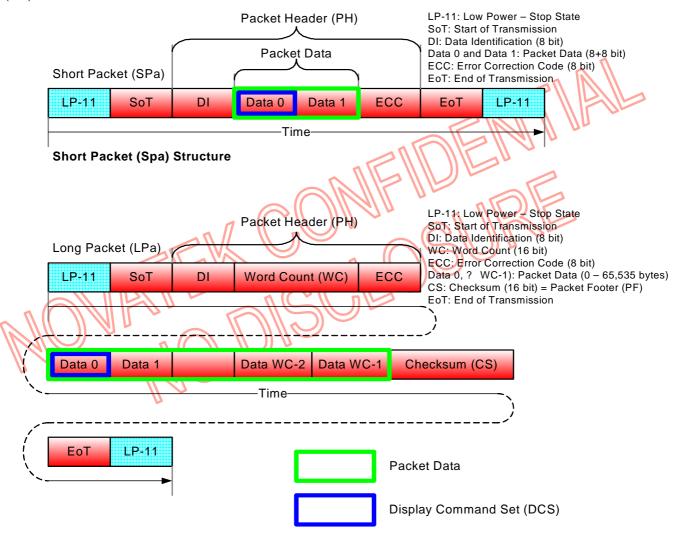


#### 5.5.2.3.2 Packet Transmission

## 5.5.2.3.2.1 Packet from the MCU to the Display Module

## **Display Command Set (DCS)**

Display Command Set (DCS), which is defined on chapter "Instruction Description", is used from the MCU to the display module. This Display Command Set (DCS) is always defined on the Data 0 of the Packet Data (PD), which is included in Short Packet (SPa) and Long packet (LPa) as these are illustrated below.



Display Command Set (DCS) on Short Packet (SPa) and Long Packet (LPa)



## Generic Write, no Parameter (GENW0-S), Data Type = 00 0011 (03h)

This data type is useless in normal application.

# Generic Write, 1 Parameter (GENW1-S), Data Type = 01 0011 (13h)

"Generic Write, 1 Parameter" (GENW1-S) is always using a Short Packet (SPa), what is defined on Data Type (DT, 01 0011b), from the MCU to the display module. The content of 2 payload bytes is "command" and 00h. "Generic Write, 1 Parameter" (GENW1-S) is used for Manufacture Command Set (CMD2, means panel function registers) writing only. Since all CMD2 registers are 1 "address" byte with 1 "parameter" byte. Therefore, this data type is useless in normal application.

Short Packet (SPa) is defined e.g.

## • Data Identification (DI)

Virtual Channel (VC, DI[7...6]): 00b Data Type (DT, DI[5...0]): 01 0011b

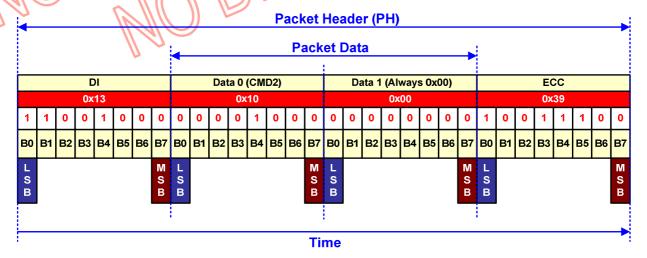
## • Packet Data (PD)

Data 0: "POWER\_CTRL15 (10h)", the Power Control 15 in the page 0 of CMD2"

Data 1: Always 00hex

# Error Correction Code (ECC)

This is defined on the Short Packet (SPa) as follows



Generic Write, 1 Parameter (GENW1-S) - Example



# Generic Write, 2 Parameter (GENW2-S), Data Type = 10 0011 (23h)

"Generic Write, 2 Parameter" (GENW2-S) is always using a Short Packet (SPa), what is defined on Data Type (DT, 10 0011b), from the MCU to the display module. The content of 2 payload bytes are "command" and "parameter". "Generic Write, 2 Parameter" (GENW2-S) is used for Manufacture Command Set (CMD2, means panel function registers) writing only.

Notes: One Sub pixel has been written.

Short Packet (SPa) is defined e.g.

#### • Data Identification (DI)

Virtual Channel (VC, DI[7...6]): 00b Data Type (DT, DI[5...0]): 10 0011b

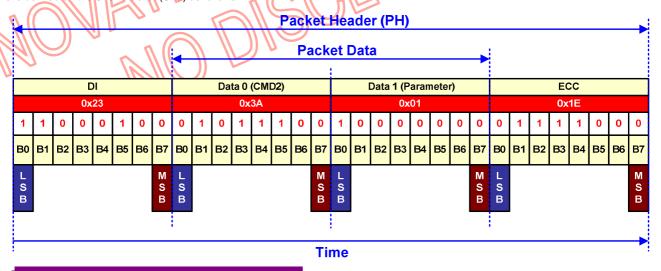
## • Packet Data (PD)

Data 0: "3-GAMMA-R CTRL15 (3Ah)", the Red Gamma Control in page 0 of CMD2

Data 1: 01hex, the parameter of the CMD2

#### • Error Correction Code (ECC)

This is defined on the Short Packet (SPa) as follows.



Generic Write, 2 Parameter (GENW2-S) - Example



## Generic Write Long (GENW-L), Data Type = 10 1001 (29h)

"Generic Write Long" (GENW-L) is always using a Long Packet (LPa), what is defined on Data Type (DT, 10 1001b), from the MCU to the display module. The content of payload bytes are "command" with multiple "parameter". "Generic Write Long" (GENW-L) is used for Manufacture Command Set (CMD2, means panel function registers) writing only.

Long Packet (LPa), when a command (No Parameter) was sent, is defined e.g.

#### • Data Identification (DI)

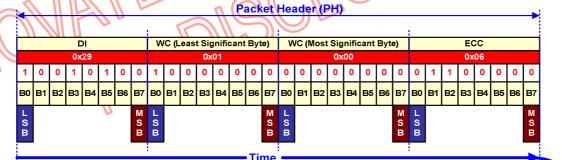
Virtual Channel (VC, DI[7...6]): 00b
Data Type (DT, DI[5...0]): 10 1001b

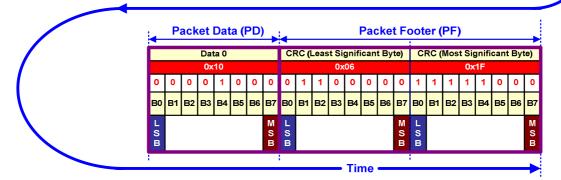
# • Word Count (WC)

Word Count (WC): 0001h

- Error Correction Code (ECC)
- Packet Data (PD): Data 0: "Sleep In (10h)", Display Command Set (DCS)
- Packet Footer (PF)

This is defined on the Long Packet (LPa) as follows.





Generic Write Long (GENW-L) with CMD2 Only - Example



Long Packet (LPa), when a Write (1 parameter) was sent, is defined e.g.

## • Data Identification (DI)

Virtual Channel (VC, DI[7...6]): 00b Data Type (DT, DI[5...0]): 10 1001b

## • Word Count (WC)

Word Count (WC): 0002h

## • Error Correction Code (ECC)

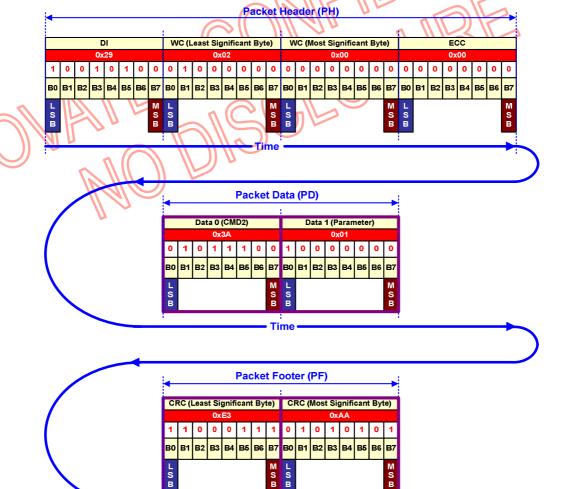
## • Packet Data (PD):

Data 0: "3-GAMMA-R CTRL15 (3Ah)", the Red Gamma Control in page 0 of CMD2

Data 1: 01hex, Parameter of the CMD2

## • Packet Footer (PF)

This is defined on the Long Packet (LPa) as follows.



Generic Write Long with CMD2 and 1 Parameter - Example



Generic Read, No Parameter (GENR0-S), Data Type = 00 0100 (04h);

This data type is useless in normal application.

Generic Read, 1 Parameter (GENR1-S), Data Type = 01 0100 (14h); Generic Read, 2 Parameter (GENR2-S), Data Type = 10 0100 (24h)

"Generic Read, 1 Parameter / Generic Read, 2 Parameter" (GENR1-S / GENR2-S) is always using a Short Packet (SPa), what is defined on Data Type (DT, 01 0100b) and Data Type (DT, 10 0100b), from the MCU to the display module. Generic read data type is used for Manufacture Command Set (CMD2, means panel function registers) reading only.

The MCU has to define to the display module, what is the maximum size of the return packet. A command, what is used for this purpose, is "Set Maximum Return Packet Size" (SMRPS-S), which Data Type (DT) is 11 0111b and which is using Short Packet (SPa) before the MCU can send ""Generic Read, 1 Parameter" to the display module. This same sequence is illustrated for reference purposes below.

#### Step 1:

- The MCU sends "Set Maximum Return Packet Size" (Short Packet (SPa)) (SMRPS-S) to the display module when it wants to return one byte from the display module
- Data Identification (DI)

Virtual Channel (VC, DI[7...6]): 00b

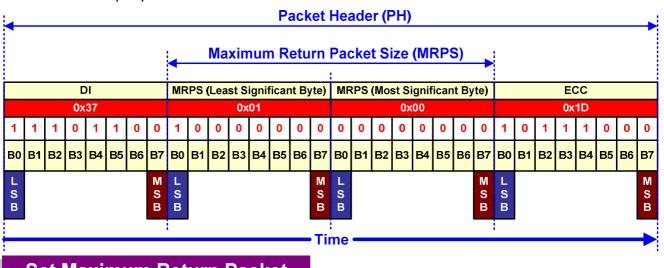
Data Type (DT, DI[5...0]): 11 0111b

Maximum Return Packet Size (MRPS)

Data 0: 01hex

Data 1: 00hex

• Error Correction Code (ECC)



**Set Maximum Return Packet Size (SMRPS-S) - Example** 



## Step 2:

• The MCU wants to receive a value of the "Read ID1 (DAh)" from the display module when the MCU sends "Generic Read, 1 Parameter" to the display module

#### • Data Identification (DI)

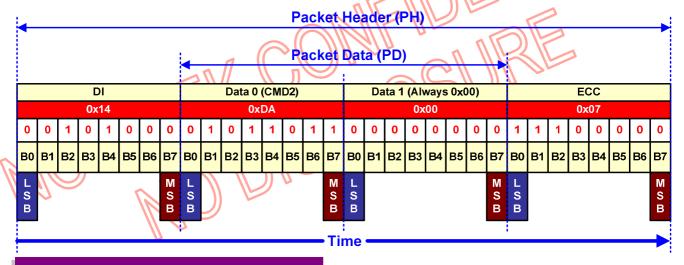
Virtual Channel (VC, DI[7...6]): 00b Data Type (DT, DI[5...0]): 01 0100b

## • Packet Data (PD)

Data 0: "Read ID1 (DAh)", Display Command Set (DCS)

Data 1: Always 00hex

## • Error Correction Code (ECC)



Generic Read, 1 Parameter (GENR1-S) - Example

#### Step 3:

The display module can send 2 different information to the MCU after Bus Turnaround (BTA)

- 1. An acknowledge with Error Report (AwER), which is using a Short Packet (SPa), if there is an error to receive a command, See chapter "Acknowledge with Error Report (AwER)"
- 2. Information of the received command. Short Packet (SPa) or Long Packet (LPa)



# Display Command Set (DCS) Write, No Parameter (DCSWN-S), Data Type = 00 0101 (05h)

"Display Command Set (DCS) Write, No Parameter" is always using a Short Packet (SPa), what is defined on Data Type (DT, 00 0101b), from the MCU to the display module. The content of payload bytes is "command" with "00h". "Display Command Set (DCS) Write, No Parameter" is used for User Command Set (CMD1) writing only.

Short Packet (SPa) is defined e.g.

#### • Data Identification (DI)

Virtual Channel (VC, DI[7...6]): 00b Data Type (DT, DI[5...0]): 00 0101b

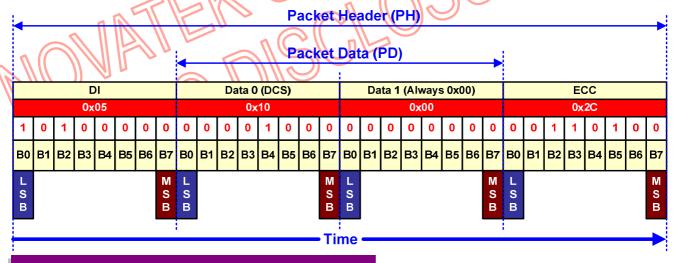
# • Packet Data (PD)

Data 0: "ENTER\_SLEEP\_MODE (10h)", Display Command Set (DCS)

Data 1: Always 00hex

#### • Error Correction Code (ECC)

This is defined on the Short Packet (SPa) as follows.



Display Command Set (DCS) Write, No Parameter (DCSWN-S) - Example



# Display Command Set (DCS) Write, 1 Parameter (DCSW1-S), Data Type = 01 0101 (15h)

"Display Command Set (DCS) Write, 1 Parameter" (DCSW1-S) is always using a Short Packet (SPa), what is defined on Data Type (DT, 01 0101b), from the MCU to the display module. The content of payload bytes are "command" with one "parameter". "Display Command Set (DCS) Write, 1 Parameter (DCSW1-S)" is used for User Command Set (CMD1) writing only.

Short Packet (SPa) is defined e.g.

#### • Data Identification (DI)

Virtual Channel (VC, DI[7...6]): 00b Data Type (DT, DI[5...0]): 01 0101b

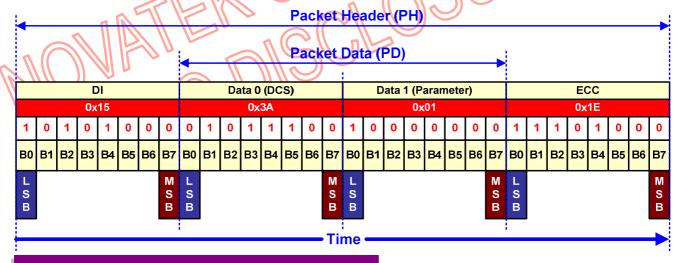
# • Packet Data (PD)

Data 0: "SET\_PIXEL\_FORMAT (3Ah)", Display Command Set (DCS)

Data 1: 01hex, Parameter of the DCS

## • Error Correction Code (ECC)

This is defined on the Short Packet (SPa) as follows.



Display Command Set (DCS) Write, 1
Parameter (DCSW1-S) - Example



## Display Command Set (DCS) Write Long (DCSW-L), Data Type = 11 1001 (39h)

"Display Command Set (DCS) Write Long" (DCSW-L) is always using a Long Packet (LPa), what is defined on Data Type (DT, 11 1001b), from the MCU to the display module. The content of payload bytes are "command" with multiple "parameter". "Display command Set (DCS) Write Long" (DCSW-L) is used for User Command Set (CMD1) writing only.

Long Packet (LPa), when a command (No Parameter) was sent, is defined e.g.

#### • Data Identification (DI)

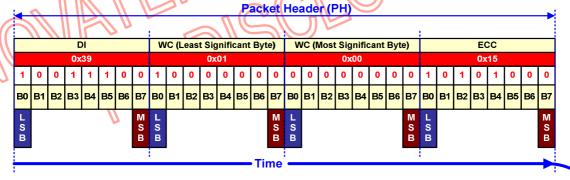
Virtual Channel (VC, DI[7...6]): 00b Data Type (DT, DI[5...0]): 11 1001b

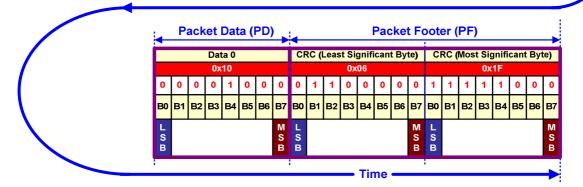
# • Word Count (WC)

Word Count (WC): 0001h

- Error Correction Code (ECC)
- Packet Data (PD): Data 0: "EXTER\_SLEEP\_MODE (10h)", Display Command Set (DCS)
- Packet Footer (PF)

This is defined on the Long Packet (LPa) as follows.





Display Command Set (DCS) Write Long (DCSW-L) with DCS Only - Example



Long Packet (LPa), when a Write (1 parameter) was sent, is defined e.g.

## • Data Identification (DI)

Virtual Channel (VC, DI[7...6]): 00b Data Type (DT, DI[5...0]): 11 1001b

#### • Word Count (WC)

Word Count (WC): 0002h

## • Error Correction Code (ECC)

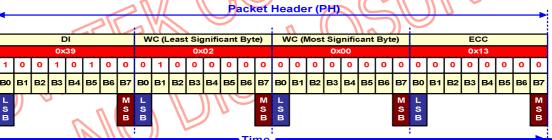
# • Packet Data (PD):

Data 0: "SET\_PIXEL\_FORMAT (3Ah)", Display Command Set (DCS)

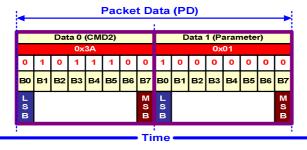
Data 1: 01hex, Parameter of the DCS

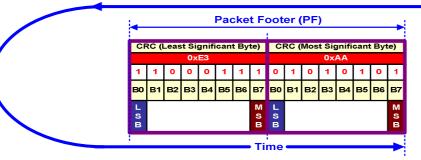
## • Packet Footer (PF)

This is defined on the Long Packet (LPa) as follows.



Time





Display Command Set (DCS) Write Long with DCS and 1 Parameter - Example



Long Packet (LPa), when a Write (4 parameters) was sent, is defined e.g.

## • Data Identification (DI)

Virtual Channel (VC, DI[7...6]): 00b

Data Type (DT, DI[5...0]): 11 1001b

#### • Word Count (WC)

Word Count (WC): 0005h

## • Error Correction Code (ECC)

## • Packet Data (PD):

Data 0: "PARLINES (30h)", Display Command Set (DCS)

Data 1: 00hex, 1st Parameter of the DCS, Start Column SC[15...8]

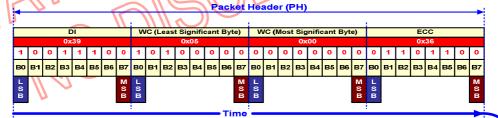
Data 2: 00hex, 2nd Parameter of the DCS, Start Column SC[7...0]

Data 3: 01hex, 3rd Parameter of the DCS, End Column EC[15...8]

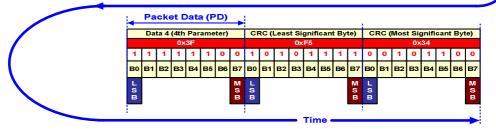
Data 4: 3Fhex, 4th Parameter of the DCS, End Column EC[7...0]

#### • Packet Footer (PF)

This is defined on the Long Packet (LPa) as follows.



														Pac	ke	t Da	ata	(PI	<b>)</b>													
È		Da	ta 0	(CIV	ID2)				Dat	ta 1	(1st	Par	ame	ter)			Dat	a 2 (	2nd	Par	ame	ter)		Data 3 (3rd Parameter)								
			0x	30							Ox	00							Ox	:00							0x	01				
0	0	0	0	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	
во	В1	B2	вз	В4	В5	В6	В7	В0	В1	B2	вз	В4	В5	В6	В7	В0	В1	B2	вз	В4	В5	В6	В7	В0	В1	B2	вз	В4	В5	В6	В7	
L					•		M S			•			•		M	L							Ms	Ls							M S	
В							В	В							OΩ	В							ηш	В							В	
																	•															



Display Command Set (DCS) Write Long with DCS and 4 Parameters - Example



## Display Command Set (DCS) Read, No Parameter (DCSRN-S), Data Type = 00 0110 (06h)

"Display Command Set (DCS) Read, No Parameter" (DCSRN-S) is always using a Short Packet (SPa), what is defined on Data Type (DT, 00 0110b), from the MCU to the display module. The content of payload bytes are "command" with "00h". Display Command Set (DCS) Read, No Parameter (DCSRN-S) is used for User Command Set (CMD1) reading only.

The MCU has to define to the display module, what is the maximum size of the return packet. A command, what is used for this purpose, is "Set Maximum Return Packet Size" (SMRPS-S), which Data Type (DT) is 11 0111b and which is using Short Packet (SPa) before the MCU can send "Display Command Set (DCS) Read, No Parameter" to the display module. This same sequence is illustrated for reference purposes below.

#### Step 1:

• The MCU sends "Set Maximum Return Packet Size" (Short Packet (SPa)) (SMRPS-S) to the display module when it wants to return one byte from the display module

• Data Identification (DI)

Virtual Channel (VC, DI[7...6]): 00b

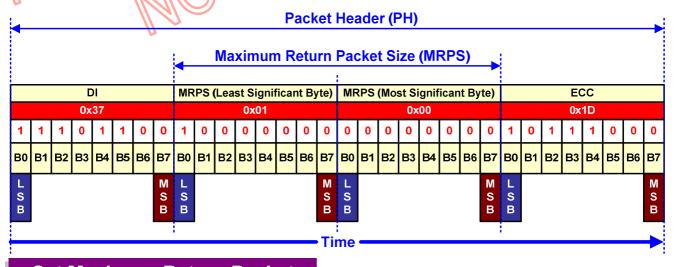
Data Type (DT, DI[5...0]): 11 0111b

Maximum Return Packet Size (MRPS)

Data 0: 01hex

Data 1: 00hex

• Error Correction Code (ECC)



Set Maximum Return Packet Size (SMRPS-S) - Example



#### Step 2:

• The MCU wants to receive a value of the "Read ID1 (DAh)" from the display module when the MCU sends "Display Command Set (DCS) Read, No Parameter" to the display module

#### • Data Identification (DI)

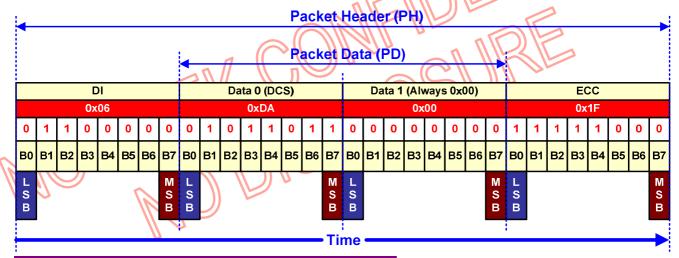
Virtual Channel (VC, DI[7...6]): 00b Data Type (DT, DI[5...0]): 00 0110b

#### • Packet Data (PD)

Data 0: "Read ID1 (DAh)", Display Command Set (DCS)

Data 1: Always 00hex

## • Error Correction Code (ECC)



Display Command Set (DCS) Read, No Parameter (DCSRN-S) - Example

# Step 3:

The display module can send 2 different information to the MCU after Bus Turnaround (BTA)

- 1. An acknowledge with Error Report (AwER), which is using a Short Packet (SPa), if there is an error to receive a command, See chapter "Acknowledge with Error Report (AwER)"
- 2. Information of the received command. Short Packet (SPa) or Long Packet (LPa)

# Null Packet, No Data (NP-L), Data Type = 00 1001 (09h)

"Null Packet, No Data" (NP-L) is always using a Long Packet (LPa), what is defined on Data Type (DT, 001001b), from the MCU to the display module. The purpose of this command is keeping data lanes in the high speed mode (HSDT), if it is needed. The display module is ignored Packet Data (PD) what the MCU is sending. Long Packet (LPa), when 5 random data bytes of the Packet Data (PD) were sent, is defined e.g.



## • Data Identification (DI)

Virtual Channel (VC, DI[7...6]): 00b

Data Type (DT, DI[5...0]): 00 1001b

# • Word Count (WC)

Word Count (WC): 0005hex

#### • Error Correction Code (ECC)

## • Packet Data (PD):

Data 0: 89hex (Random data)

Data 1: 23hex (Random data)

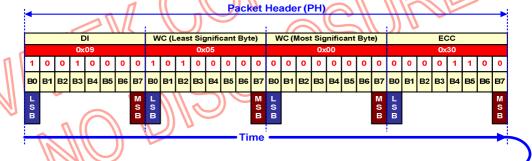
Data 2: 12hex (Random data)

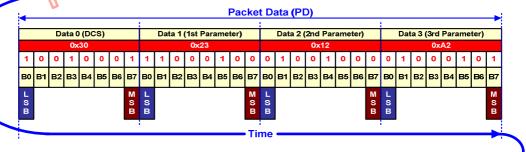
Data 3: A2hex (Random data)

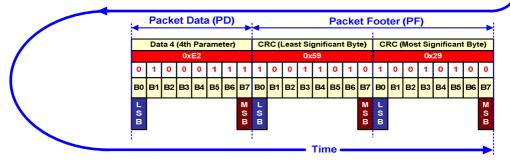
Data 4: E2hex (Random data)

## • Packet Footer (PF)

This is defined on the Long Packet (LPa) as follows.







Null Packet, No Data (NP-L) - Example



## Sync Event (H Start, H End, V Start, V End), Data Type = xx 0001 (x1h)

Sync Events are Short packets and, therefore, can time-accurately represent events like the start and end of sync pulses. As "start" and "end" are separate and distinct events, the length of sync pulses, as well as position relative to active pixel data, e.g. front and back porch display timing, may be accurately conveyed to the peripheral. The Sync Events are defined as follows:

- Data Type = 00 0001 (01h) V Sync Start
- Data Type = 01 0001 (11h) V Sync End
- Data Type = 10 0001 (21h) H Sync Start
- Data Type = 11 0001 (31h) H Sync End

In order to represent timing information as accurately as possible a V Sync Start event represents the start of the VSA and also implies an H Sync Start event for the first line of the VSA. Similarly, a V Sync End event implies an H Sync Start event for the last line of the VSA.

Sync events should occur in pairs, Sync Start and Sync End, if accurate 1054 pulse-length information needs to be conveyed. Alternatively, if only a single point (event) in time is required, a single sync event (normally, Sync Start) may be transmitted to the peripheral. Sync events may be concatenated with blanking packets to convey inter-line timing accurately and avoid the overhead of switching between LPS and HS for every event. Note there is a power penalty for keeping the data line in HS mode, however. Display modules that do not need traditional sync/blanking/pixel timing should transmit pixel data in a high-speed burst then put the bus in Low Power Mode, for reduced power consumption. The recommended burst size is a scan line of pixels, which may be temporarily stored in a line buffer on the display module.



## EoT Packet, Data Type = 00 1000 (08h)

This new short packet is used for indicating the end of a HS transmission to the data link layer. As a result, detection of the end of HS transmission may be decoupled from physical layer characteristics. D-PHY defines an EoT sequence composed of a series of all 1's or 0's depending on the last bit of the last packet within a HS transmission. Due to potential errors, the EoT sequence could wrongly be interpreted as valid data types. Although EoT errors are not expected to happen frequently, the addition of this new packet will enhance overall system reliability.

Older devices compliant to earlier revisions of DSI specification do not support EoT packet generation or detection. All Hosts and Peripheral devices compliant to this revision of DSI specification, and going forward, shall incorporate capability of supporting EoT packet. They shall also provide means for enabling and disabling this capability – implementation specific – to ensure interoperability with older DSI devices not supporting EoT packet.

As mentioned earlier, the main objective of an EoT packet is to enhance overall robustness of the system during HS transmission mode. Therefore, DSI transmitters should not generate an EoT packet when transmitting in LP mode. The data link layer of DSI receivers shall detect and interpret arriving EoT packets regardless of transmission mode (HS or LP modes) in order to decouple itself from the PHY layer. Table below describes how DSI mandates EoT packet support for different transmission and reception modes.

## **EoT Support for Host and Peripheral**

	DSI	Host		DSI Peripheral						
	(EoT capab	oility enable)			(EoT capab	ility enable)				
HS N	lode	LPI	Mode	HS I	Mode	LP N	/lode			
Receive	Transmit	Receive	Transmit	Receive	Transmit	Receive	Transmit			
Not Applicable	"Shall"	"Shall"	"Should not"	"Shall"	Not Applicable	"Shall"	"Should not"			

Unlike other DSI packets, an EoT packet has a fixed format as follows:

- Data Type = DI [5:0] = 0b001000
- Virtual Channel = DI [7:6] = 0b00
- Payload Data [15:0] = 0x0F0F
- ECC [7:0] = 0x01

The virtual channel identifier associated with an EoT packet is fixed to 0, regardless of the number of different virtual channels present within the same transmission. For multi-Lane systems, the EoT packet bytes are distributed across multiple Lanes.



## Color Mode On Command, and, Data Type = 01 0010 (12h)

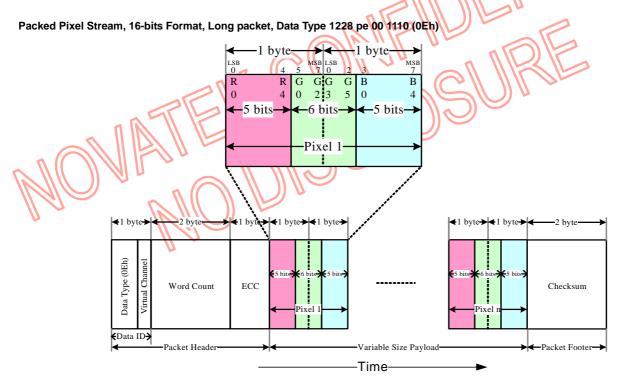
Color Mode On is a Short packet command that switches a Video Mode display module to 8-colors mode for power saving.

# Color Mode Off Command, Data Type = 00 0010 (02h)

Color Mode Off is a Short packet command that returns a Video Mode display module from 8-colors mode to normal display operation.

## Blanking Packet (Long), Data Type = 01 1001 (19h)

A Blanking packet is used to convey blanking timing information in a Long packet. Normally, the packet represents a period between active scan lines of a Video Mode display, where traditional display timing is provided from the host processor to the display module. The blanking period may have Sync Event packets interspersed between blanking segments. Like all packets, the Blanking packet contents shall be an integer number of bytes. Blanking packets may contain arbitrary data as payload. The Blanking packet consists of the DI byte, a two-byte WC, an ECC byte, a payload of length WC bytes, and a two-byte checksum.



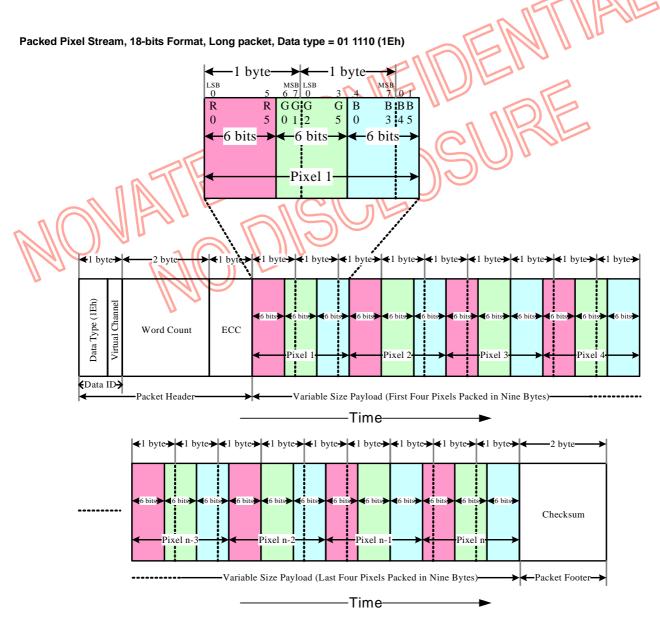
16-bit per Pixel - RGB Color Format, Long packet



Packed Pixel Stream 16-bits Format is a Long packet used to transmit image data formatted as 16-bit pixels to a Video Mode display module. The packet consists of the DI byte, a two-byte WC, an ECC byte, a payload of length WC bytes and a two-byte checksum. Pixel format is five bits red, six bits green, five bits blue, in that order. Note that the "Green" component is split across two bytes. Within a color component, the LSB is sent first, the MSB last.

With this format, pixel boundaries align with byte boundaries every two bytes. The total line width (displayed plus non-displayed pixels) should be a multiple of two bytes.

Normally, the display module has no frame buffer of its own, so all image data shall be supplied by the host processor at a sufficiently high rate to avoid flicker or other visible artifacts.



18-bit per Pixel (Packed) - RGB Color Format, Long packet

# NT35596

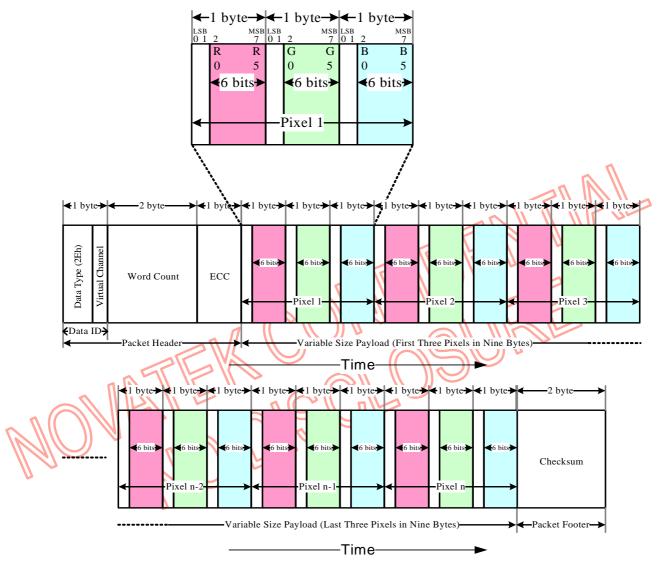
Packed Pixel Stream 18-bits Format (Packed) is a Long packet. It is used to transmit RGB image data formatted as pixels to a Video Mode display module that displays 18-bits pixels The packet consists of the DI byte, a two-byte WC, an ECC byte, a payload of length WC bytes and a two-byte Checksum. Pixel format is red (6 bits), green (6 bits) and blue (6 bits), in that order. Within a color component, the LSB is sent first, the MSB last.

Note that pixel boundaries only align with byte boundaries every four pixels (nine bytes). Preferably, display modules employing this format have a horizontal extent (width in pixels) evenly divisible by four, so no partial bytes remain at the end of the display line data. If the active (displayed) horizontal width is not a multiple of four pixels, the transmitter shall send additional fill pixels at the end of the display line to make the transmitted width a multiple of four pixels. The receiving peripheral shall not display the fill pixels when refreshing the display device. For example, if a display device has an active display width of 399 pixels, the transmitter should send 400 pixels in one or more packets. The receiver should display the first 399 pixels and discard the last pixel of the transmission.

With this format, the total line width (displayed plus non-displayed pixels) should be a multiple of four pixels (nine bytes).



Pixel Stream, 18-bits Format in Three Bytes, Long packet, Data Type = 101110 (2Eh)



18-bit per Pixel (Loosely Packed) - RGB Color Format, Long packet

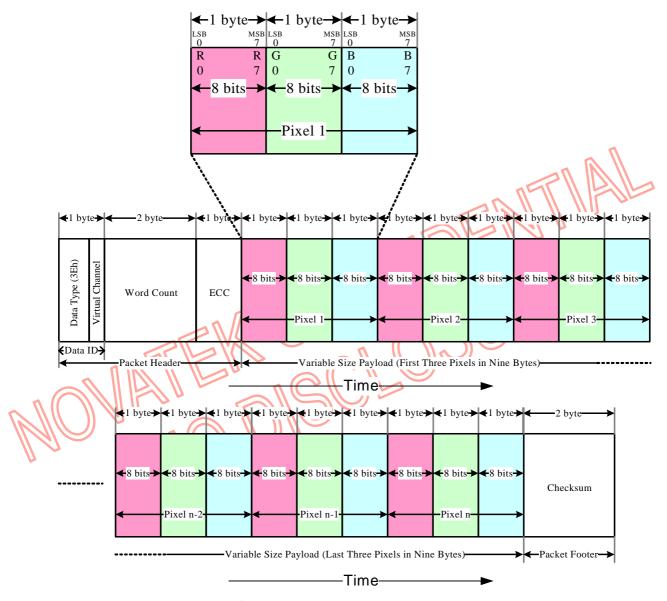
In the 18-bits Pixel Loosely Packed format, each R, G, or B color component is six bits but is shifted to the upper bits of the byte, such that the valid pixel bits occupy bits [7:2] of each byte. Bits [1:0] of each payload byte representing active pixels are ignored. As a result, each pixel requires three bytes as it is transmitted across the Link. This requires more bandwidth than the "packed" format, but requires less shifting and multiplexing logic in the packing and unpacking functions on each end of the Link.

This format is used to transmit RGB image data formatted as pixels to a Video Mode display module that displays 18-bits pixels. The packet consists of the DI byte, a two-byte WC, an ECC byte, a payload of length WC bytes and a two-byte Checksum. The pixel format is red (6 bits), green (6 bits) and blue (6 bits) in that order. Within a color component, the LSB is sent first, the MSB last.

With this format, pixel boundaries align with byte boundaries every three bytes. The total line width (displayed plus non-displayed pixels) should be a multiple of three bytes.



Packed Pixel Stream, 24-bits Format, Long packet, Data Type = 11 1110 (3Eh)



24-bit per Pixel – RGB Color Format, Long packet

Packed Pixel Stream 24-bits Format is a Long packet. It is used to transmit image data formatted as 24-bits pixels to a Video Mode display module. The packet consists of the DI byte, a two-byte WC, an ECC byte, a payload of length WC bytes and a two-byte Checksum. The pixel format is red (8 bits), green (8 bits) and blue (8 bits), in that order. Each color component occupies one byte in the pixel stream; no components are split across byte boundaries. Within a color component, the LSB is sent first, the MSB last.

With this format, pixel boundaries align with byte boundaries every three bytes. The total line width (displayed plus non-displayed pixels) should be a multiple of three bytes.



## 5.6.2.3.2.2 Packet from the Display Module to the MCU

## **Used Packet Types**

The display module is always using Short Packet (Spa) or Long Packet (Lpa), when it is returning information to the MCU after the MCU has requested information from the Display Module. This information can be a response of the Display Command Set (DCS) (See chapter "Display Command Set (DCS) Read, No Parameter" (DCSRN-S)) or an Acknowledge with Error Report (See chapter: "Acknowledge with Error Report (AwER)" (AwER)).

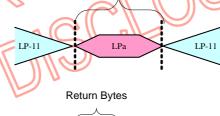
The used packet type is defined on Data Type (DT). See chapter "Data Type (DT)".

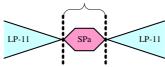
A number of the return bytes are more than the maximum size of the Packet Data (PD) on Long Packet (Lpa) or Short Packet (Spa) when the display module is sending return bytes in several packets until all return bytes have been sent from the display module to the MCU.

It is also possible that the display module is sending return bytes in several packets even if the maximum size of the Packet Data (PD) could be sent on a packet.

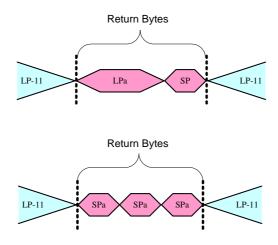
Return Bytes

Both cases are illustrated for reference purposes below.





**Return Bytes on Single Packet** 



Return Bytes on Several Packets - Only for Reference Purposes



Data Types for Display Module-Sourced Packets

Data Type, (HEX)	Data Type, (BINARY)	Symbol	Description	Packet Size
02h	00 0010	AwER	Acknowledge & Error Report	Short
08h	00 1000	EoT	End of Transmission (EoT) Packet	Short
1Ch	01 1100	DCSRR-L	DCS Long Read Response	Long
21h	10 0001	DCSRR1-S	DCS Short Read Response, 1 Byte returned	Short
22h	10 0010	DCSRR2-S	DCS Short Read Response, 2 Byte returned	Short
1Ah	01 1010	GENRR-L	Generic Long Read Response	Long
11h	01 0001	GENRR1-S	Generic Short Read Response, 1 Byte returned	Short
12h	01 0010	GENRR2-S	Generic Short Read Response, 2 Byte returned	Short

Acknowledge with Error Report (AwER), Data Type = 00 0010(02h)

"Acknowledge with Error Report" (AwER) is always using a Short Packet (SPa), what is defined on Data Type (DT, 00 0010b), from the display module to the MCU.

The Packet Data (PD) can include bits, which are defining the current error, when a corresponding bit is set to '1', as they are defined on the following table.

Acknowledge with Error Report (AwER) for Long Packet (LPa) Response

Bit	Description
0	SoT Error
1	SoT Sync Error
2	EoT Sync Error
3	Escape Mode Entry Command Error
4	Low-Power Transmit Sync Error
5	Any Protocol Timer Time-Out
6	False Control Error
7	Contention is Detected on the Display Module
8	ECC Error, single-bit (detected and corrected)
9	ECC Error, multi-bit (detected, not corrected)
10	Checksum Error (Long packet only)
11	DSI Data Type (DT) Not Recognized
12	DSI Virtual Channel (VC) ID Invalid
13	Reserved
14	Reserved, Set to '0' internally
15	DSI Protocol Violation

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These errors are only included on the last packet, which has been received from the MCU to the display module before Bus Turnaround (BTA).

The display module ignores the received packet which includes error or errors.

Acknowledge with Error Report (AwER) of the Short Packet (SPa) is defined e.g.

#### • Data Identification (DI)

Virtual Channel (VC, DI[7...6]): 00b
Data Type (DT, DI[5...0]): 00 0010b

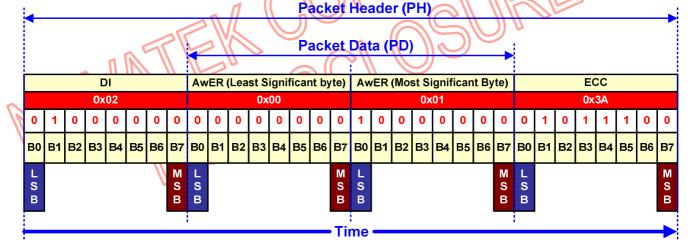
# • Packet Data (PD)

Bit 8: ECC Error, single-bit (detected and corrected)

AwER: 0100h

## • Error Correction Code (ECC)

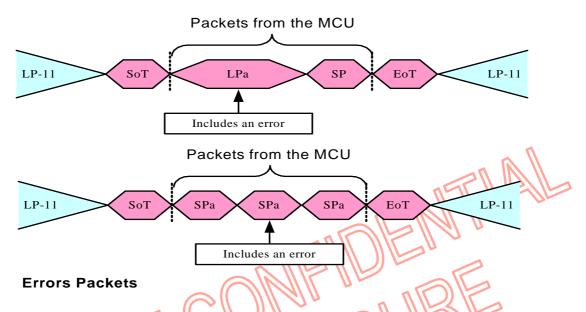
This is defined on the Short Packet (SPa) as follows.



Acknowledge with Error Report (AwER) - Example



It is possible that the display module has received several packets, which have included errors, from the MCU before the MCU is doing Bus Turnaround (BTA). Some examples are illustrated for reference purposes below.

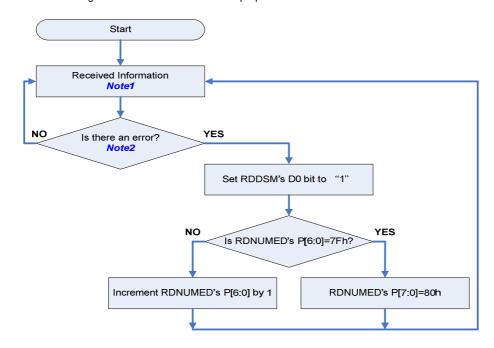


Therefore, there is needed a method to check if there has been errors on the previous packets. These errors of the previous packets can check "Read Display Signal Mode (0Eh)" and "Read Number of the Errors on DSI (05h)" commands.

The bit D0 of the "Read Display Signal Mode (0Eh)" command has been set to '1' if a received packet includes an error.

The numbers of the packets, which are including an ECC (multi and single) or CRC error, are calculated on the RDNUMED register, which can read "Read Number of the Errors on DSI (05h)" command. This command also sets the RDNUMED register to 00h as well as set the bit D0 of the "Read Display Signal Mode (0Eh)" command to '0' after the MCU has read the RDNUMED register from the display module.

The functionality of the RDNUMED register is illustrated for reference purposes below.



Note1: This information can be interface or packet level communication but it is always from the MCU to the display module in this case.

Note2: CRC or ECC (multi and single) error



## DCS Read Long Response (DCSRR-L), Data Type = 01 1100(1Ch)

"DCS Read Long Response" (DCSRR-L) is always using a Long Packet (LPa), what is defined on Data Type (DT, 01 1100b), from the display module to the MCU. "DCS Read Long Response" (DCSRR-L) is used when the display module wants to response a DCS Read command, which the MCU has sent to the display module.

Long Packet (LPa), which includes 5 data bytes of the Packet Data (PD), is defined e.g.

#### • Data Identification (DI)

Virtual Channel (VC, DI[7...6]): 00b Data Type (DT, DI[5...0]): 01 1100b

## • Word Count (WC)

Word Count (WC): 0005hex

# • Error Correction Code (ECC)

## • Packet Data (PD):

Data 0: 89hex

Data 1: 23hex

Data 2: 12hex

Data 3: A2hex Data 4: E2hex

• Packet Footer (PF)

This is defined on the Long Packet (LP) as follows.



DCS Read Long Response (DCSRR-L) - Example



## DCS Read Short Response, 1 Byte Returned (DCSRR1-S), Data Type = 10 0001(21h)

"DCS Read Short Response, 1 Byte Returned" (DCSRR1-S) is always using a Short Packet (SPa), what is defined on Data Type (DT, 10 0001b), from the display module to the MCU. "DCS Read Short Response, 1 Byte Returned" (DCSRR1-S) is used when the display module wants to response a DCS Read command, which the MCU has sent to the display module.

Short Packet (SPa) is defined e.g.

#### • Data Identification (DI)

Virtual Channel (VC, DI[7...6]): 00b Data Type (DT, DI[5...0]): 10 0001b

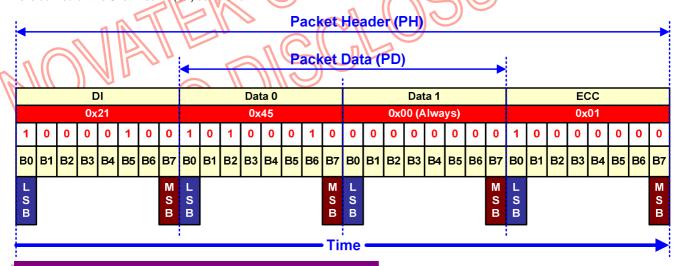
# • Packet Data (PD)

Data 0: 45hex

Data 1: 00hex (Always)

## • Error Correction Code (ECC)

This is defined on the Short Packet (SP) as follows.



DCS Read Short Response, 1 Byte Returned (DCSRR1-S) - Example



# DCS Read Short Response, 2 Bytes Returned (DCSRR2-S), Data Type = 10 0010(22h)

"DCS Read Short Response, 2 Bytes Returned" (DCSRR2-S) is always using a Short Packet (SPa), what is defined on Data Type (DT, 10 0010b), from the display module to the MCU. "DCS Read Short Response, 2 Bytes Returned" (DCSRR2-S) is used when the display module wants to response a DCS Read command, which the MCU has sent to the display module.

Short Packet (SPa) is defined e.g.

#### • Data Identification (DI)

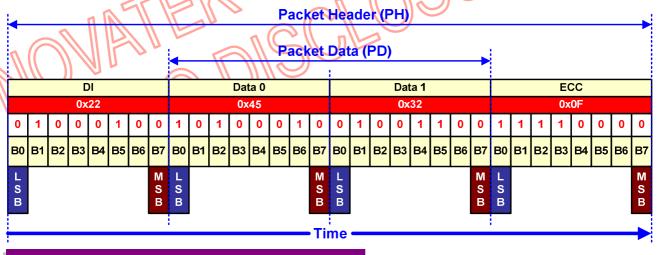
Virtual Channel (VC, DI[7...6]): 00b Data Type (DT, DI[5...0]): 10 0010b

# • Packet Data (PD)

Data 0: 45hex
Data 1: 32hex

• Error Correction Code (ECC)

This is defined on the Short Packet (SPa) as follows.



DCS Read Short Response, 2 Bytes Returned (DCSRR2-S) - Example



## Generic Read Long Response (GENRR-L), Data Type = 01 1010(1Ah)

"Generic Read Long Response" (GENRR-L) is always using a Long Packet (LPa), what is defined on Data Type (DT, 01 1010b), from the display module to the MCU. "Generic Read Long Response" (GENRR-L) is used when the display module wants to response a Generic Read command, which the MCU has sent to the display module. Long Packet (LPa), which includes 5 data bytes of the Packet Data (PD), is defined e.g.

#### • Data Identification (DI)

Virtual Channel (VC, DI[7...6]): 00b Data Type (DT, DI[5...0]): 01 1010b

## • Word Count (WC)

Word Count (WC): 0005hex

# • Error Correction Code (ECC)

# • Packet Data (PD):

Data 0: 89hex

Data 1: 23hex

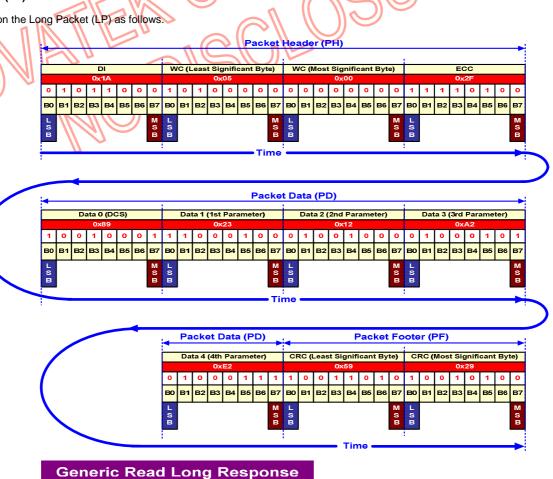
Data 2: 12hex

Data 3: A2hex

Data 4: E2hex

## • Packet Footer (PF)

This is defined on the Long Packet (LP) as follows.



(GENRR-L) - Example



## Generic Read Short Response, 1 Byte Returned (GENRR1-S), Data Type = 01 0001(11h)

"Generic Read Short Response, 1 Byte Returned" (GENRR1-S) is always using a Short Packet (SPa), what is defined on Data Type (DT, 01 0001b), from the display module to the MCU. "Generic Read Short Response, 1 Byte Returned" (GENRR1-S) is used when the display module wants to response a Generic Read command, which the MCU has sent to the display module.

Short Packet (SPa) is defined e.g.

#### • Data Identification (DI)

Virtual Channel (VC, DI[7...6]): 00b Data Type (DT, DI[5...0]): 01 0001b

## • Packet Data (PD)

Data 0: 45hex

Data 1: 00hex (Always)

# • Error Correction Code (ECC)

This is defined on the Short Packet (SP) as follows. Packet Header (PH Packet Data (PD) DI ECC Data 0 Data 1 0 0 0 0 0 0 1 0 0 0 В1 В6 B0 В1 B2 **B**3 B2 В3 B6 B0 B2 **B**3 В6 B0 B1 В7 B4 **B5** B6 **B7** B0 **B1 B7 B5 B7 B**3 М S B s s s s s s s В В В В В В

Generic Read Short Response, 1 Byte Returned (GENRR1-S) - Example



# Generic Read Short Response, 2 Bytes Returned (GENRR2-S), Data Type = 01 0010(12h)

"Generic Read Short Response, 2 Bytes Returned" (GENRR2-S) is always using a Short Packet (SPa), what is defined on Data Type (DT, 01 0010b), from the display module to the MCU. "Generic Read Short Response, 2 Bytes Returned" (GENRR2-S) is used when the display module wants to response a Generic Read command, which the MCU has sent to the display module.

Short Packet (SPa) is defined e.g.

• Data Identification (DI)

Virtual Channel (VC, DI[7...6]): 00b Data Type (DT, DI[5...0]): 01 0010b

• Packet Data (PD)

Data 0: 45hex Data 1: 32hex

• Error Correction Code (ECC)

This is defined on the Short Packet (SPa) as follows. Packet Header (PH) Packet Data (PD) DI Data 0 Data 1 ECC 0x12 0x32 0x09 0 **B3 B5** B2 B4 B0 B1 В3 B4 B5 B6 B0 B1 В3 B4 В6 B0 B1 B4 B6 B0 **B**5 B6 **B7** B2 B7 B2 **B7 B3** В5 **B7** M S L S M S M S L S s s s В В В В В В В

Generic Read Short Response, 2 Byte Returned (GENRR2-S) - Example



## 5.5.2.3.3 Communication Sequence

## 5.5.2.3.3.1 General

The communication sequences can be done on interface or packet levels between the MCU and the display module. See chapters "Interface Level Communication" and "Packet Level Communication". This communication sequence description is for DSI data lanes and it has been assumed that the needed low level communication is done on DSI clock lanes (DSI-CLK+/-) automatically.

Functions of the interface level communication is described on the following table.

## **Interface Level Communication**

Interface Mode	Abbreviation	Interface Action Description
	LP-11	Stop state
	LPDT	Low power data transmission
	ULPS	Ultra-Low power state
Low Power	RAR	Remote application reset
	TEE	Tearing effect event
	ACK	Acknowledge (No error)
SP IN	ВТА	Bus turnaround
High Speed	HSDT	High speed data transmission

Functions of the packet level communication are described on the following table.

## **Packet Level Communication**

Packet Sender	Abbreviation	Packet Size	Packet Description
	DCSW1-S	SPa	DCS Write, 1 Parameter
	DCSWN-S	SPa	DCS Write, No Parameter
MCU	DCSW-L	LPa	DCS Write, Long
MCO	DCSRN-S	SPa	DCS Read, No Parameter
	SMRPS-S	SPa	Set maximum return packet size
	NP-L	LPa	Null packet, No data
	AwER	SPa	Acknowledge with error report
Display Module	DCSRR-L	LPa	DCS Read, Long Response
Display Module	DCSRR1-S	SPa	DCS Read, Short Response
	DCSRR2-S	SPa	DCS Read, Short Response



### 5.5.2.3.3.2 Sequences

## DCS Write, 1 Parameter Sequence

A Short Packet (SPa) of "Display Command Set (DCS) Write, 1 Parameter (DCSW1-S)" is defined on chapter "Display Command Set (DCS) Write, 1 Parameter (DCSW1-S)" and example sequences, how this packet is used, is described on following tables.

#### DCS Write, 1 Parameter Sequence - Example 1

	Mo	CU		Display	Module	
Line	Packet Sender	Interface Mode Control	Information Direction	Interface Mode Control	Packet Sender	Comment
1	-	LP-11	=>	-		Start
2	DCSW1-S	LPDT	=>	((		
3	-	LP-11	=>			End

# DCS Write, 1 Parameter Sequence - Example 2

	MC	CU		Display	Module	
Line	Packet Sender	Interface Mode Control	Information Direction	Interface Mode Control	Packet Sender	Comment
1	-	LP-11	<b>\$</b>	<i>J</i> -	-	Start
	DCSW1-S	HSDT	))   =>	-	-	
3	-	LP-11	=>	-	-	End



# DCS Write, 1 Parameter Sequence - Example 3

	M	ICU		Display	Module	
Line	Packet Sender	Interface Mode Control	Information Direction	Interface Mode Control	Packet Sender	Comment
1	-	LP-11	=>	-	-	Start
2	DCSW1-S	HSDT	=>	-	-	
3	-	LP-11	=>	-	-	
4	-	ВТА	<=>	ВТА	-	Interface control change from the MCU to the display module
5	-	-	<b>&lt;=</b>	LP-11		If no error => goto line 7  If error => goto line 12
6						
7	-	-	<= ^	ACK		No error
8	-	-	< ₹	LP-11	n m	
9	-	ВТА	( <del>-</del>	ВТА		Interface control change from the display module to the MCU
10	-	LP-11	*	M		End
11						
12				LPDT	AwER	Error report
13	- 6		<=	LP-11	-	
14	-	ВТА	<=>	BTA	-	
15	-	LP-11	=>	-	-	End



# DCS Write, No Parameter Sequence

A Short Packet (SPa) of "Display Command Set (DCS) Write, No Parameter (DCSWN-S)" is defined on chapter "Display Command Set (DCS) Write, No Parameter (DCSWN-S)" and example sequences, how this packet is used, is described on following tables.

### DCS Write, No Parameter Sequence - Example 1

	М	CU		Display	Module	
Line	Packet Sender	Interface Mode Control	Information Direction	Interface Mode Control	Packet Sender	Comment
1	-	LP-11	=>	-		Start
2	DCSWN-S	LPDT	=>	-		
3	-	LP-11	=>			End

	Mo	MCU		Display	Module	
Line	Packet Sender	Interface Mode Control	Information Direction	Interface Mode Control	Packet Sender	Comment
1	-	LP-11			-	Start
2	DCSWN-S	HSDT		-	-	
	-	LP-11	)) \\ =>	-	-	End



	М	CU		Display	Module	
Line	Packet Sender	Interface Mode Control	Information Direction	Interface Mode Control	Packet Sender	Comment
1	-	LP-11	=>	-	-	Start
2	DCSWN-S	HSDT	=>	-	-	
3	-	LP-11	=>	-	-	
4	-	ВТА	<=>	ВТА	-	Interface control change from the MCU to the display module
5	-	-	<b>&lt;=</b>	LP-11		If no error => goto line 7  If error => goto line 12
6						
7	-	-	<= \	ACK		No error
8	-	-	Ŏ <sup>†</sup>	LP-11	n m	
9	-	ВТА	( <del>+</del>	ВТА		Interface control change from the display module to the MCU
10	-	LP-11	<b>^</b>	M - [[c		End
11						
12	MID			LPDT	AwER	Error report
13	- 0	<b>//((-))/</b>	<=	LP-11	-	
14	-	ВТА	<=>	ВТА	-	
15	-	LP-11	=>	-	-	End



# **DCS Write Long Sequence**

A Long Packet (LPa) of "Display Command Set (DCS) Write Long (DCSW-L)" is defined on chapter "Display Command Set (DCS) Write Long (DCSW-L)" and example sequences, how this packet is used, is described on following tables.

## DCS Write, Long Sequence - Example 1

	М	CU		Display	Module	
Line	Packet Sender	Interface Mode Control	Information Direction	Interface Mode Control	Packet Sender	Comment
1	-	LP-11	=>	-	-	Start
2	DCSW-L	LPDT	=>	-		
3	-	LP-11	=>	. ((		End

## DCS Write, Long Sequence - Example 2

	MC	MCU		Display	Module	
Line	Packet Sender	Interface Mode Control	Information Direction	Interface Mode Control	Packet Sender	Comment
1	-	LP-11			-	Start
2	DCSW-L	HSDT			-	
3	-	LP-11	=>	-	-	End





# DCS Write, Long Sequence - Example 3

	M	CU		Display I	Module	
Line	Packet	Interface	Information	Interface	Packet	Comment
	Sender	Mode Control	Direction	Mode Control	Sender	
1	-	LP-11	=>	-	-	Start
2	DCSW-L	HSDT	=>	-	-	
3	-	LP-11	=>	-	-	
4	-	вта	<=>	вта	-	Interface control change from the MCU to the display module
5	-	-	<=	LP-11		If no error => goto line 7  If error => goto line 12
6						
7	-	-	<b>&lt;=</b>	ACK		No error
8	-	-	<b>₹</b>	LR-11	in	
9	-	вта	(=)	BTA		Interface control change from the display module to the MCU
10	-	LP-11	) (C	Me    6		End
11						
12	Ain			LPDT	AwER	Error report
13	- 0		<b>*</b>	LP-11	-	
14	-	ВТА	<=>	ВТА	-	
15	-	LP-11	=>	-	-	End



# DCS Write, Long Sequence - Example 4

	M	ICU		Display I	Module	
Line	Packet Sender	Interface Mode Control	Information Direction	Interface Mode Control	Packet Sender	Comment
1	-	LP-11	=>	-	-	Start
2	DCSW-L	HSDT	=>	-	-	Memory Write (2Ch)
3	DCSW-L	HSDT	=>	-	-	Memory Write Continue(3Ch)
4	DCSW-L	HSDT	=>	-	-	Memory Write Continue(3Ch)
5	DCSW1-S	HSDT	=>	-		Memory Write Continue(3Ch) with 1 parameter
6	-	LP-11	=>			End



# DCS Read, No Parameter Sequence

A Short Packet (SPa) of "Display Command Set (DCS) Read, No Parameter (DCSRN-S)" is defined on chapter "Display Command Set (DCS) Read, No Parameter (DCSRN-S)" and example sequences, how this packet is used, is described on following tables.

	М	CU	lu fa mantia a	Display	Module	
Line	Packet	Interface	Information  Direction	Interface	Packet	Comment
	Sender	Mode Control	Direction	Mode Control	Sender	
1	-	LP-11	=>	-	-	Start
2	SMRPS-S	HSDT	=>	-		Define how many data byte is wanted to read: 1 byte
3	DCSRN-S	HSDT	=>	305		wanted to get a response ID1 (DAh)
4	-	LP-11	=>			
5	-	ВТА	S=>	вта		Interface control change from the MCU to the display module
6	. 5			LP-11		If no error => goto line 8  If error => goto line 13
7						
8			(=)	LPDT	DCSRR1-S	Response 1 byte return
	<i>γ</i> -		\\\ \&=	LP-11	-	
10	-	вта	<=>	ВТА	-	Interface control change from the display module to the MCU
11	-	LP-11	=>	-	-	End
12						
13	-	-	<=	LPDT	AwER	Error report
14	-	-	<=	LP-11	-	
15	-	ВТА	<=>	ВТА	-	
16	-	LP-11	=>	-	-	End





	M	ICU		Display	Module	
Line	Packet Sender	Interface Mode Control	Information Direction	Interface Mode Control	Packet Sender	Comment
1	-	LP-11	=>	-	-	Start
2	SMRPS-S	HSDT	=>	-	-	Define how many data byte is wanted to read : 200 byte
3	DCSRN-S	HSDT	=>	-	-	wanted to get a response "Memory Read" (2Eh)
4	-	LP-11	=>	-	: ~ 1	
5	-	ВТА	<=>	ВТА		Interface control change from the MCU to the display module
6	-	-	Ü,	LPF-11		If no error => goto line 8  If error => goto line 13
7						
8				LPDT	DCSRR-L	Response 200 bytes return
9	n MS		<= (	LP-11	9	
10	-	ВТА		ВТА	-	Interface control change from the display module to the MCU
MA	-	LP-11	=>	-	-	End
12						
13	-	-	<=	LPDT	AwER	Error report
14	-	-	<=	LP-11	-	
15	-	ВТА	<=>	ВТА	-	
16	-	LP-11	=>	-	-	End





	М	ICU		Display l	Module	
Line	Packet Sender	Interface Mode Control	Information Direction	Interface Mode Control	Packet Sender	Comment
1	-	LP-11	=>	-	-	Start
2	SMRPS-S	HSDT	=>	-	-	Define how many data byte is wanted to read : 200 byte
3	DCSRN-S	HSDT	=>	-	-	wanted to get a response "Memory Read" (2Eh)
4	-	LP-11	=>	-	- 1	
5	-	вта	<=>	BTA		Interface control change from the MCU to the display module
6	-	-	÷ C	LP-11		If no error => goto line 8  If error => goto line 14
7						
8	-			LPDT	DCSRR-L	Responsed 100 bytes return
9	n M		•	LPDT	DCSRR-L	Responsed 100 bytes return
10				LP-11	-	
Mic	-	вта	<=>	вта	-	Interface control change from the display module to the MCU
12	-	LP-11	=>	-	-	End
13						
14	-	-	<=	LPDT	AwER	Error report
15	-	-	<=	LP-11	-	
16	-	ВТА	<=>	BTA	-	
17	-	LP-11	=>	-	-	End





	MCU			Display	Module	
Line	Packet	Interface	Information Direction	Interface	Packet	Comment
	Sender	Mode Control		Mode Control	Sender	
1	-	LP-11	=>	-	-	Start
2	SMRPS-S	HSDT	=>	-	-	Define how many data byte is wanted to read : 200 byte
3	DCSRN-S	HSDT	=>	-	-	wanted to get a response "Memory  Read" (2Eh)
4	-	LP-11	=>	-	: ~ 1	
5	-	ВТА	<=>	BTA		Interface control change from the MCU to the display module
6	-	-	ů.	LP-11		If no error => goto line 8
7						
8				LPDT	DCSRR-L	Response 199 bytes return
9			\$ « C	LPDT	DCSRR1-L	Response 1 byte return
10				LP-11	-	
	-	ВТА		ВТА	-	Interface control change from the display module to the MCU
12	-	LP-11	=>	-	-	End
13						
14	-	-	<=	LPDT	AwER	Error report
15	-	-	<=	LP-11	-	
16	-	вта	<=>	BTA	-	
17	-	LP-11	=>	-	-	End





	М	CU		Display	Module	
Line	Packet	Interface	Information Direction	Interface	Packet	Comment
	Sender	Mode Control		Mode Control	Sender	
1	-	LP-11	=>	-	-	Start
2	SMRPS-S	HSDT	=>	-	-	Define how many data byte is wanted to read : 200 byte
3	DCSRN-S	HSDT	=>	-	-	wanted to get a response "Memory Read" (2Eh)
4	-	LP-11	=>	-	-	,
5	-	вта	<=>	ВТА		Interface control change from the MCU to the display module
6	-	-	<b>&lt;=</b>	LP-11		If no error => goto line 8  If error => goto line 14
7						
8	-		/ F	LPDT	DCSRR-L	Response 198 bytes return
9	-			LPDT	DCSRR2-L	Response 2 bytes return
10	n M		<=	LP-11		,
	-	вта		ВТА		Interface control change from the display module to the MCU
1/2	-	LP-11		-	-	End
13						
14	-	110	<=	LPDT	AwER	Error report
15	-	-	<=	LP-11	-	
16	-	ВТА	<=>	ВТА	-	
17	-	LP-11	=>	-	-	End



# **Null Packet, No Data Sequence**

A Long Packet (LPa) of "Null Packet, No Data (NP-L)" is defined on chapter "Null Packet, No Data (NP-L)" and example sequences, how this packet is used, is described on following tables.

## Null Packet, No Parameter Sequence - Example

	М	CU		Display N	lodule	
Line	Packet Sender	Interface Mode Control	Information Direction	Interface Mode Control	Packet Sender	Comment
1	-	LP-11	=>	-	-	Start
2	NP-L	HSDT	=>	-	-	Only high speed data transmission is used.
3	-	LP-11	=>	-	-	End





# 5.5.2.3.3.3 Tearing Effect Bus Trigger Sequences

# Tearing Effect Bus Trigger Enable Sequence – DCSW-L and HSDT

	МС	CU		Display	Module	
Line	Packet	Interface	Information  Direction	Interface	Packet	Comment
	Sender	Mode Control	Direction	Mode Control	Sender	
1	-	LP-11	=>	-	-	Start
2	DCSWL	HSDT	=>	-	-	Tearing Effect Bus Trigger Enable
3	EoTP	HSDT	=>	-	-	End of Transmission Packet
4	-	LP-11	=>	-	-	
5	-	ВТА	<=>	ВТА		Interface control change from the MCU to the display module
6	-	-	<=	LP-11		If No Error => Goto Line 8  If Error is Corrected by ECC => Goto Line 19  If Error => Goto Line 30
7						
8	-			ACK		No Error
9	n M		<=	LP-11		,
10	-	вта		BTA		Interface Control Change from the display module to the MCU
	-	LP-11				
12		ВТА	<=>	ВТА	-	Interface Control Change from the MCU to the display module
13			<b>\</b> =	LP-11	-	
14			<b>\</b> =	TEE	•	TE (Escape Trigger) on the next V-Synch.
15			<=	LP-11	-	
16	-	ВТА	<b>&lt;=&gt;</b>	ВТА	-	Interface Control Change from the display module to the MCU
17		LP-11	=>	-	-	End
18						
19	-	-	<=	LPDT	AwER	Error Report (Error is Corrected by ECC)
20	-	-	<=	LP-11	-	
21	-	вта	<=>	ВТА	-	Interface Control Change from the display module to the MCU
22	-	LP-11	=>	-	-	
23		ВТА	<=>	ВТА	-	Interface Control Change from the MCU to the display module

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24	-		<=	LP-11	-	
25	-		<=	TEE	-	
26	-		<=	LP-11	-	
27	-	ВТА	<=>	ВТА	-	
28	-	LP-11	=>		-	End
29						
30	-	-	<=	LPDT	AwER	Error Report
31	-	-	<=	LP-11	-	
32	-	ВТА	<=>	ВТА	-	Interface Control Change from the display module to the MCU
33	1	LP-11	=^			If the MCU is not forcing BTA => Goto Line 34  If the MCU is forcing BTA => Goto Line 36
34	-	LP-11	=>	~ C. III		End
35						
36	-	вта		ВТА		Interface Control Change from the MCU to the display module
37	n M		<=	LP-11		Dead-Lock (No TE information) See Note 2
38	-	LP-11				The MCU is forced to start to control the interface.  The display module detects Bus Connection Error  (BCE)
39	-	ВТА	\- \-	ВТА	-	Interface Control Change from the MCU to the display module
40	-	-	<=	LP-11	-	
41	-	-	<b>&lt;=</b>	LPDT	AwER	Error Report (Bus Connection Error (BCE) is reported) See Note 2
42	-	-	<=	LP-11	-	
43	-	ВТА	< <del>-</del> >	ВТА	-	Interface Control Change from the display module to the MCU
44	-	LP-11	=>		-	End

Notes: 1. Lines 1 – 17 are needed for every frame.

2. Bits 5 and 7 of the AwER are applied.

# Tearing Effect Bus Trigger Enable Sequence – DCSW-L and LPDT

	M	CU	lufa ma atla m	Display Module		
Line	Packet Sender	Interface Mode Control	Information Direction	Interface Mode Control	Packet Sender	Comment
1	-	LP-11	=>	-	-	Start
2	DCSWL	HSDT	=>	-	-	Tearing Effect Bus Trigger Enable
3	EoTP	HSDT	=>	-	-	End of Transmission Packet

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						1110000
4	-	LP-11	=>	-	-	
5	-	вта	<=>	ВТА	-	Interface control change from the MCU to the display module
6	-	-	<=	LP-11	-	If No Error => Goto Line 8  If Error is Corrected by ECC => Goto Line 19  If Error => Goto Line 30
7						
8	-	-	<=	ACK	-	No Error
9	-	-	<=	LP-11	-	
10	-	вта	<=>	ВТА	-	Interface Control Change from the display module to the MCU
11	-	LP-11	=>	~ 115		
12		ВТА		вта		Interface Control Change from the MCU to the display module
13				LP-11		
14				TEE		TE (Escape Trigger) on the next V-Synch.
15				LP-11	-	
16	-	ВТА	<=>	ВТА		Interface Control Change from the display module to the MCU
17		LP-11	=>	-	-	End
18						
19	-	-	<=	LPDT	AwER	Error Report (Error is Corrected by ECC)
20	-	-	<=	LP-11	-	
21	-	ВТА	<=>	ВТА	-	Interface Control Change from the display module to the MCU
22	-	LP-11	=>	-	-	
23		ВТА	<=>	ВТА	-	Interface Control Change from the MCU to the display module
24	-		<=	LP-11	-	
25	-		<=	TEE	-	
26	-		<=	LP-11	-	
27	-	ВТА	<=>	ВТА	-	
28	-	LP-11	=>		-	End
29						
30	-	-	<=	LPDT	AwER	Error Report
31	-	-	<=	LP-11	-	
U-	-			-	U-	-

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32	-	вта	<=>	вта	-	Interface Control Change from the display module to the MCU
33	-	LP-11	=>	-	-	If the MCU is not forcing BTA => Goto Line 34  If the MCU is forcing BTA => Goto Line 36
34	-	LP-11	=>	-	-	End
35						
36	-	ВТА	<= <i>&gt;</i>	ВТА	-	Interface Control Change from the MCU to the display module
37	-		<=	LP-11	-	Dead-Lock (No TE information) See Note 2
38	-	LP-11	=>			The MCU is forced to start to control the interface.  The display module detects Bus Connection Error  (BCE)
39	-	ВТА	<=>	ВТА		Interface Control Change from the MCU to the display module
40	-	-		LP-11	-	
41				LPDT	AWER	Error Report (Bus Connection Error (BCE) is reported) See Note 2
42			ůc (C	LP-11		
43	-	ВТА		BTA	-	Interface Control Change from the display module to the MCU
44	-	LP-11	=>		-	End

Notes: 1. Lines 1 – 17 are needed for every frame.

2. Bits 5 and 7 of the AwER are applied.

# Tearing Effect Bus Trigger Enable Sequence –DCSW1-S and HSDT

	M	CU		Display	Module	
Line	Packet Sender	Interface Mode Control	Information Direction	Interface Mode Control	Packet Sender	Comment
1	-	LP-11	=>	-	-	Start
2	DCSW1-S	LPDT	=>	-	-	Tearing Effect Bus Trigger Enable
3	-	LP-11	=>	-	-	
4	-	вта	<=>	вта	-	Interface control change from the MCU to the display module
5	-	-	<=	LP-11	-	If No Error => Goto Line 8  If Error is Corrected by ECC => Goto Line 19  If Error => Goto Line 30
6						
7	-	-	<=	ACK	-	No Error
8	-	-	<=	LP-11	-	



						1110000
9	-	ВТА	<=>	ВТА	-	Interface Control Change from the display module to the MCU
10	-	LP-11	=>	-		
11		ВТА	<=>	ВТА	-	Interface Control Change from the MCU to the display module
12			<=	LP-11	-	
13			<=	TEE	-	TE (Escape Trigger) on the next V-Synch.
14			<b>&lt;=</b>	LP-11		
15	-	вта	<=>	вта		Interface Control Change from the display module to the MCU
16		LP-11	<i>₽</i>	1111/21		End
17						
18		1 Col	<=	LPDT	AWER	Error Report (Error is Corrected by ECC)
19	11-11		<= 6	LP-11		
20	-	вта		BTA	-	Interface Control Change from the display module to the MCU
21	-	LP-11	=>	-	-	
22		ВТА	<=>	ВТА	-	Interface Control Change from the MCU to the display module
23	-		<=	LP-11	-	
24	-		<=	TEE	-	
25	-		<=	LP-11	-	
26	-	ВТА	<=>	ВТА	-	
27	-	LP-11	=>		-	End
28						
29	-	-	<=	LPDT	AwER	Error Report
30	-	-	<=	LP-11	-	
31	-	вта	<=>	ВТА	-	Interface Control Change from the display module to the MCU
32	-	LP-11	=>	-	-	If the MCU is not forcing BTA => Goto Line 34  If the MCU is forcing BTA => Goto Line 36
33	-	LP-11	=>	-	-	End
34						
35	-	вта	<=>	вта	-	Interface Control Change from the MCU to the display module
36	-		<=	LP-11	-	Dead-Lock (No TE information) See Note 2
D.						

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37	-	LP-11	=>		-	The MCU is forced to start to control the interface.  The display module detects Bus Connection Error (BCE)			
38	-	вта	<=>	вта	-	Interface Control Change from the MCU to the display module			
39	-	-	<=	LP-11	-				
40	-	-	<=	LPDT	AwER	Error Report (Bus Connection Error (BCE) is reported) See Note 2			
41	-	-	<=	LP-11	-				
42	-	вта	<=>	вта	-	Interface Control Change from the display module to the MCU			
43	-	LP-11	=>			End			
Notes: 1. Lines	s 1 – 17 are nee	ded for every fra	ame.	7 11					
	2. Bits 5 and 7 of the AwER are applied.  Tearing Effect Bus Trigger Disable Sequence – DCSWN-S and LPDT								
		ACH.		Diam					

# Tearing Effect Bus Trigger Disable Sequence – DCSWN-S and LPDT

	MCU		lu Carres di arr	Display Module				
Line	Packet Sender	Interface Mode Control	Information Direction	Interface Mode Control	Packet Sender	Comment		
	-	LP-11	=>\	-	-	Start		
2	DCSWN-S	LPDT	=>	-	-	Tearing Effect Bus Trigger Disable		
3	-	LP-11	=>	-	-	End		

# Tearing Effect Bus Trigger Disable Sequence – DCSWN-S and HSDT

	MCU		Information	Display Module			
Line	Packet Sender	Interface Mode Control	Information Direction	Interface Mode Control	Packet Sender	Comment	
1	-	LP-11	=>	-	-	Start	
2	DCSWN-S	HSDT	=>	-	-	Tearing Effect Bus Trigger Disable	
	ЕоТр	HSDT				End of Transmission Packet	
3	-	LP-11	=>	-	-	End	



#### 5.5.2.4 Video Mode Communication

Video Mode peripherals require pixel data delivered in real time. This section specifies the format and timing of DSI traffic for this type of display module.

#### 5.5.2.4.1 Transmission Packet Sequences

DSI supports several formats, or packet sequences, for Video Mode data transmission. The peripheral's timing requirements dictate which format is appropriate. In the following sections, Burst Mode refers to time-compression of the RGB pixel (active video) portion of the transmission. In addition, these terms are used throughout the following sections:

- Non-Burst Mode with Sync Pulses enables the peripheral to accurately reconstruct original video timing, including sync pulse widths.
- Non-Burst Mode with Sync Events similar to above, but accurate reconstruction of sync pulse widths is not required, so a single Sync Event is substituted.
- Burst mode RGB pixel packets are time-compressed, leaving more time during a scan line for LP mode (saving power) or for multiplexing other transmissions onto the DSI link.

In the following figures the Blanking or Low-Power Interval (BLLP) is defined as a period during which video packets such as pixel-stream and sync event packets are not actively transmitted to the peripheral. To enable PHY synchronization the host processor should periodically end HS transmission and drive the Data Lanes to the LP state. This transition should take place at least once per frame; shown as LPM in the figures in this section. It is recommended to return to LP state once per scan-line during the horizontal blanking time. Regardless of the frequency of BLLP periods, the host processor is responsible for meeting all documented peripheral timing requirements. Note, at lower frequencies BLLP periods will approach, or become, zero, and burst mode will be indistinguishable from non-burst mode.

During the BLLP the DSI Link may do any of the following:

- Remain in Idle Mode with the host processor in LP-11 state and the peripheral in LP-RX
- Transmit one or more non-video packets from the host processor to the peripheral using Escape Mode
- Transmit one or more non-video packets from the host processor to the peripheral using HS Mode
- If the previous processor-to-peripheral transmission ended with BTA, transmit one or more packets from the peripheral to the host processor using Escape Mode
- Transmit one or more packets from the host processor to a different peripheral using a different Virtual Channel ID

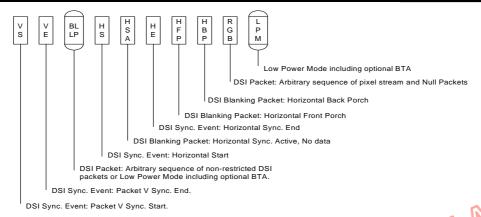
The sequence of packets within the BLLP or RGB portion of a HS transmission is arbitrary. The host processor may compose any sequence of packets, including iterations, within the limits of the packet format definitions. For all timing cases, the first line of a frame shall start with VS; all other lines shall start with HS. This is also true in the special case when VSA+VBP=0. Note that the position of synchronization packets, such as VS and HS, in time is of utmost importance since this has a direct impact on the visual performance of the display panel.

Normally, RGB pixel data is sent with one full scan line of pixels in a single packet. If necessary, a horizontal scan-line of active pixels may be divided into two or more packets. However, individual pixels shall not be split across packets.

Transmission packet components used in the figures in this section are defined in Figure below unless otherwise specified.

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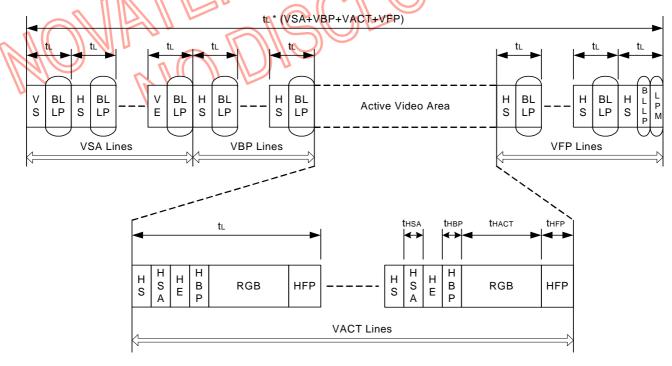


**DSI Video Mode Interface Timing Legend** 

If a peripheral timing specification for HBP or HFP minimum period is zero, the corresponding Blanking Packet may be omitted. If the HBP or HFP maximum period is zero, the corresponding blanking packet shall be omitted.

#### 5.5.2.4.2 Non-Burst Mode with Sync Pulses

With this format, the goal is to accurately convey DPI-type timing over the DSI serial Link. This includes matching DPI pixel-transmission rates, and widths of timing events like sync pulses. Accordingly, synchronization periods are defined using packets transmitting both start and end of sync pulses. An example of this mode is shown in Figure below.



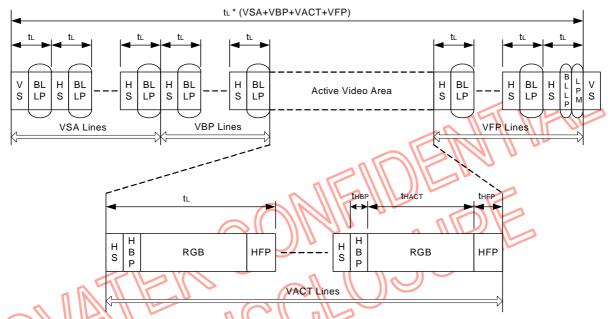
DSI Video Mode Interface Timing: Non-Burst Transmission with Sync Start and End

Normally, periods shown as HSA (Horizontal Sync Active), HBP (Horizontal Back Porch) and HFP (Horizontal Front Porch) are filled by Blanking Packets, with lengths (including packet overhead) calculated to match the period specified by the peripheral's data sheet. Alternatively, if there is sufficient time to transition from HS to LP mode and back again, a timed interval in LP mode may substitute for a Blanking Packet, thus saving power.



### 5.5.2.4.3 Non-Burst Mode with Sync Events

This mode is a simplification of the format described in section 5.8.2.4.2 "Non-Burst Mode with Sync Pulse" .Only the start of each synchronization pulse is transmitted. The peripheral may regenerate sync pulses as needed from each Sync Event packet received. Pixels are transmitted at the same rate as they would in a corresponding parallel display interface such as DPI-2. An example of this mode is shown in Figure below.



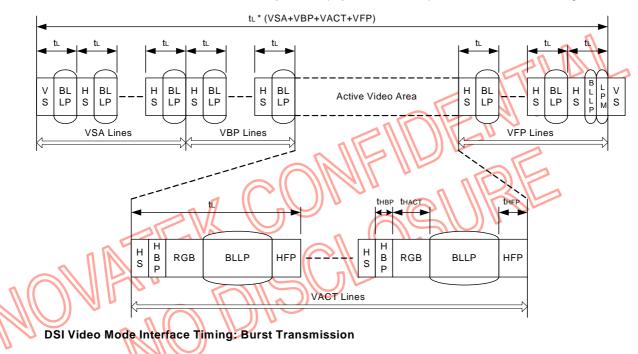
DSI Video Mode Interface Timing: Non-burst Transmission

As with the previous Non-Burst Mode, if there is sufficient time to transition from HS to LP mode and back again, a timed interval in LP mode may substitute for a Blanking Packet, thus saving power.



#### 5.5.2.4.4 Burst Mode

In this mode, blocks of pixel data can be transferred in a shorter time using a time-compressed burst format. This is a good strategy to reduce overall DSI power consumption, as well as enabling larger blocks of time for other data transmissions over the Link in either direction. There may be a line buffer or similar memory on the peripheral to accommodate incoming data at high speed. Following HS pixel data transmission, the bus goes to Low Power Mode, during which it may remain idle, i.e. the host processor remains in LP-11 state, or LP transmission may take place in either direction. If the peripheral takes control of the bus for sending data to the host processor, its transmission time shall be limited to ensure data underflow does not occur from its internal buffer memory to the display device. An example of this mode is shown in Figure below.



Similar to the Non-Burst Mode scenario, if there is sufficient time to transition from HS to LP mode and back again, a timed interval in LP mode may substitute for a Blanking Packet, thus saving power.



## 5.5.2.4.5 Parameters

Below table documents the parameters used in the preceding figures. Peripheral supplier companies are responsible for specifying suitable values for all blank fields in the table. The host processor shall meet these requirements to ensure interoperability.

### Required Peripheral Timing Parameters (Base on 1080RGBx1920)

Symbol	Parameter	Condition	Min	Тур	Max	Units
$BR_PHY$	Bit rate per Lane (Note3)	Full-HD(1080RGB x 1920)	80	,	1000	Mbps
t <sub>L</sub>	Line time	Full-HD(1080RGB x 1920)		12,9 (Note 1)		us
t <sub>HBP</sub>	Horizontal back porch	Full-HD (1080RGB x 1920)	TBD	11/21	-	us
t <sub>HACT</sub>	Time for image data	4 data lane	TBD		(Note 2)	us
HACT	Active pixels per line	Full-HD (1080RGB x 1920)		800	7	pixels
t <sub>HFP</sub>	Horizontal front porch		TBD		<b>-</b>	us
VSA	Vertical sync active		TBD	1111-2.	-	Н
VBP	Vertical back porch		TBD		-	Н
VACT	Active lines per frame	Full-HD (1080RGB x 1920)		1280		Н
VFP	Vertical front porch		TBD	-	-	Н

Note 1: Frame rate (Typ) = 60Hz, and VBP is set to 2 / VFP is set to 4.

Note 2:  $t_{HAC}T$  (max)=  $t_L - t_{HFP} - t_{HBP}$ 

Note 3: For MIPI speed limitation:

[1] Per lane bandwidth is 1Gbps,

[2] Total Bit Rate: 4Gbps for 8-8-8; 3Gbps for 6-6-6; and 2.67Gbps for5-6-5.



# 5.6 Display Reference Clock Function

The NT35596 provides a function to decide internal oscillator or external clock for display clock reference of driver IC. User can set this register of CMD1 address F8h. When user sets EN\_EXCK of F6h to "1", the display clock will refer to external clock, and user must set the frequency of external clock in register F6h/F7h, and then sets the RTN value for 1H line period (About RTN setting value, please always refers to 14MHz frequency basis). If user sets EN\_EXCK to "0", the display clock will refer to NT35596 internal oscillator, and user only need to set RTN value to decide 1H period.

External Clock Frequency must be filled in CMD1 register F6h/F7h if EN\_EXCK bit is "1":

 $EXCK \_FREQ[11:0] = 100 * f(MHz)$ 

"f" is external oscillator frequency in unit "MHz"

EXCK\_FREQ: External Clock Frequency include 2-digit decimal point accuracy

RTN setting for 1H period (for detailed, please refer to NT35596 application note):

RTN = 14M

(Line + BP + FP) \* FrameRate(Hz)

RTN: Number of clocks per line.

Line: Display Line Number

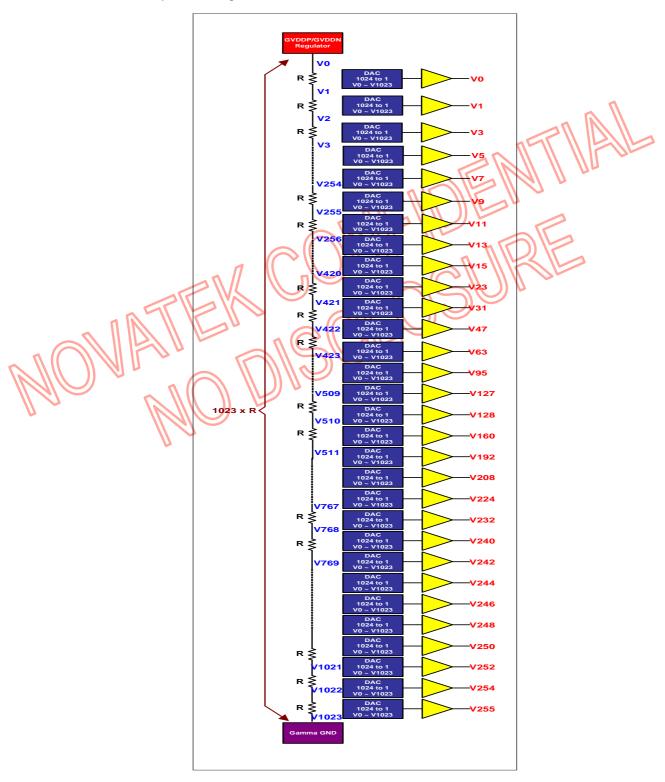
FP: Number of lines for front porch.

BP: Number of lines for back porch.



# 5.7 GAMMA Function

The structure of grayscale amplifier is shown as below. The 30 voltage levels between GVDDP/GVDDN and GND determined by the gradient adjustment register, the reference adjustment register, the amplitude adjustment resister and the micro-adjustment register.



Gamma Architecture for NT35596



# 5.8 Reset Function

The RESET function of NT35596 is triggered by a RESX input. After reset function triggered, the NT35596 enter a reset period, and the duration of this period must be at least 1ms. During this period, the NT35596 and its power circuit is initialized. In the meanwhile, because the NT35596 will be in a busy state, neither instruction from MPU nor GRAM data access request are not acceptable. In addition, for power-on reset case, there will be a 20ms period for oscillator to be stable. Therefore, any instructions or GRAM access request must be made after this 20ms period is over.

### **Initial States of Output Pins**

The following table represents the output pins and its initial state

Output Pins	Initial State				
Liquid crystal driver (Source driver output)	All output VSS				
VCOMDC3	Disabled (VSS level output)				
GVDD P/N	Disabled (VSS level output)				
CGOUTR1~R16, CGOUTL1~L16	Disabled (VSS level output)				
FTE / FTE1/LEDPWM	Disabled (VSS level output)				
VGH	TBD				
VGL	TBD				
VGHO	TBD				
VGLO	TBD				
VOL NO	TBD				
VCII	TBD				
AVDDR	TBD				
AVEER	TBD				



# Initial States of Input / Output Pins

The following table represents the input/output pins and its initial state

Input/Output Pins	Initial State
C21P/M	Hi-z
C31P/M	Hi-z
C41P/M	Hi-z

Notes: The initial states of input/output pins listed above are proper under the condition that LCD module is connected as shown in the connection example.

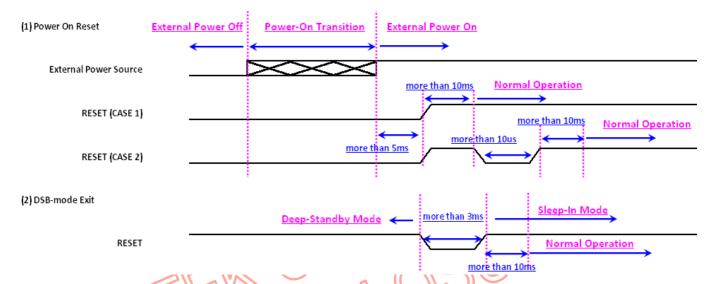
### **Initial State of Instruction Set**

The initial state of instruction set is listed in next chapter, and the default values are shown in the parenthesis of each instruction bit cell.



## 5.8.1 Timing of Reset Pin

NT35596 provides H/W pin to do driver IC initialization and exit of "Deep Standby Mode". For power-on reset, one-finger reset or two-finger reset method to do driver IC initialization. For "Deep Standby Mode" exit method, H/W reset pin must be keep low state more than 3ms. The detailed H/W reset pin timing is shown as below figure.



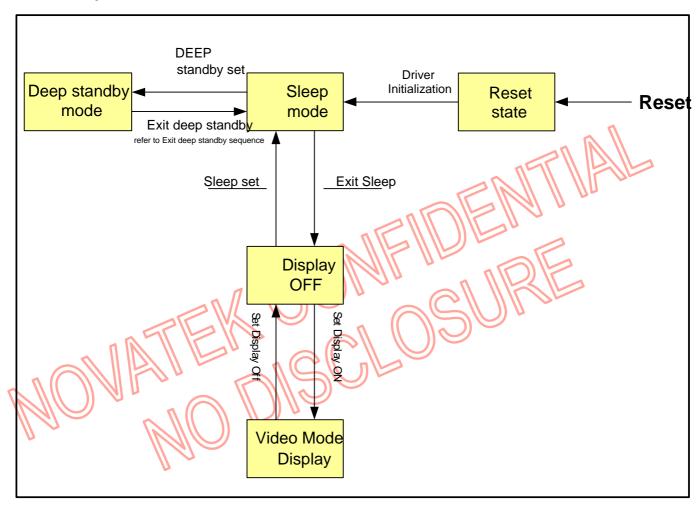
H/W reset pin timing for power-on reset and exit of "Deep Standby Mode"

Note: For detailed architecture of each power on/off sequence with reset pin, please refer to NT35596 application note.



# 5.9 Basic Operation Mode

The basic operation mode of NT35596 is illustrated below. When changing from one mode to another, make sure to follow the sequence indicated in the figure.

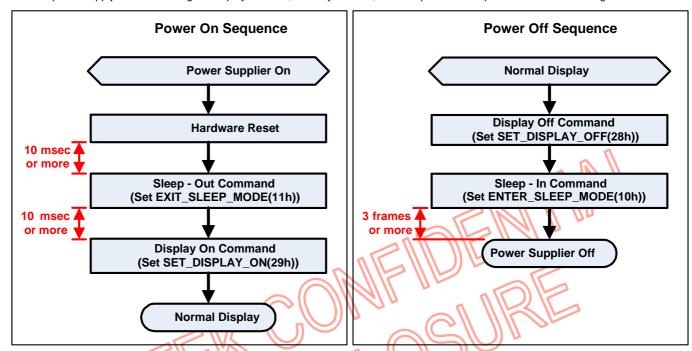


Operation Mode Change



# 5.10 Power On/Off Sequence

The power supply ON/OFF setting for Display ON/OFF, Standby Set/Exit, and Sleep Set/Exit sequences is illustrated in figure below.



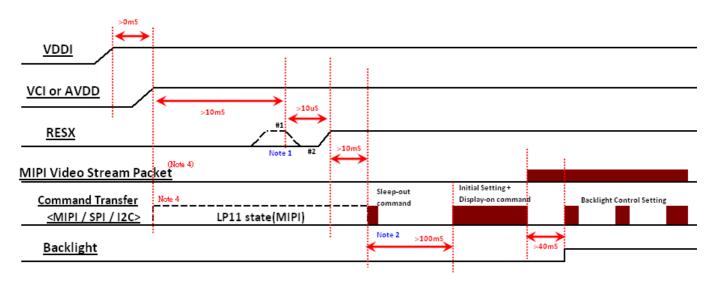
Power Supply Setting Sequence

Note: If user wants to change the LTPS timing, frame rate, porch settings, it would be necessary to delay 6 frames or more after sleep out command.



# 5.10.1 Power Supply On/Off setting sequence

# 5.10.1.1 {ENPWRP, ENPWRN} = 00b or 10b (two power (VDDI/VCI or VDDI/AVDD) input)



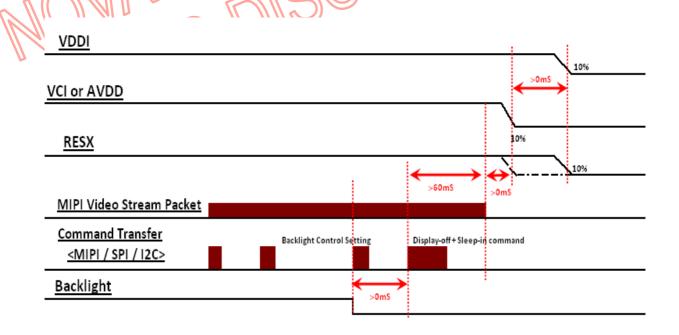
Note 1: The RESX waveform #1 is better than #2

Note 2: After Sleep-Out Command, Driver IC will reload MTP registers and do internal power on action.

Therefore, any initial settings (such as 3 A 00h, 3 B 00h, etc.) by MIPI, SPI or I2C should be set after Sleep-Out command with minimum delay time 100mS.

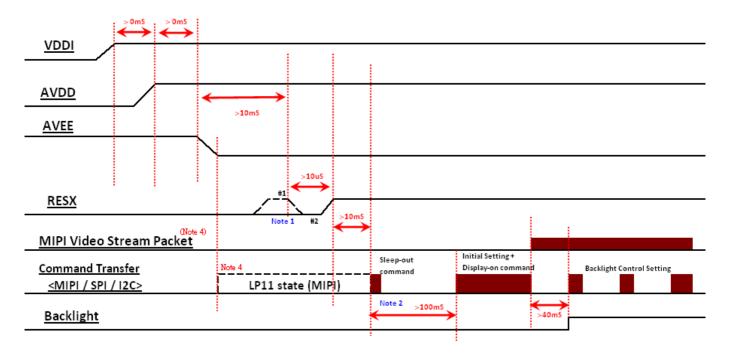
Note 3: For detailed panel-related power sequence, please refer to NT35596 Application Notes.

Note 4: When use MIPI I/F, MIPI Lanes must go to LP11 after Power VCI or AVDD is ready





# 5.10.1.2 {ENPWRP, ENPWRN} = 11b and EN4PWR=0 (three power (VDDI/AVDD/AVEE) input)



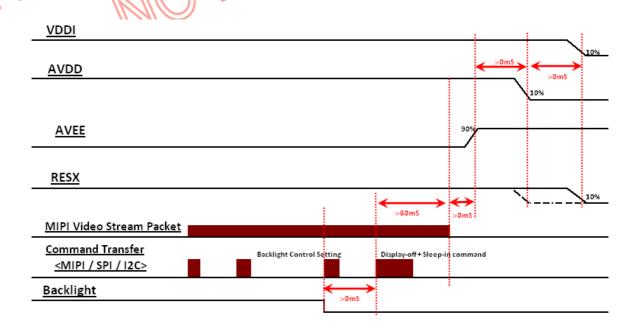
Note 1: The RESX waveform #1 is better than #2

Note 2: After Sleep-Out Command, Driver IC will reload MTP registers and do internal power on action.

Therefore, any initial settings (such as 3 A00h, 3 B00h, etc.) by MIPI, SPI or I2C should be set after Sleep-Out command with minimum delay time 100mS.

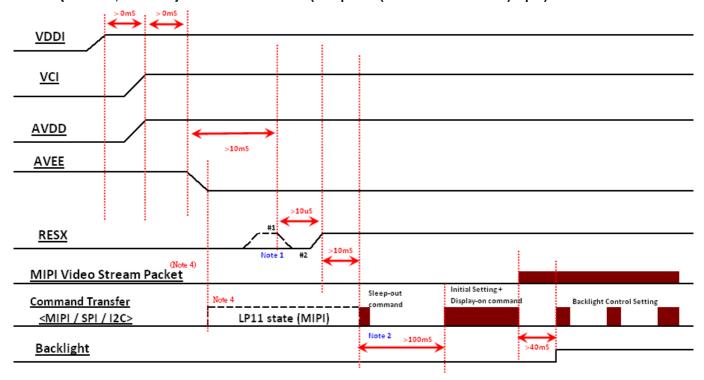
Note 3: For detailed panel-related power sequence, please refer to NT35596 Application Notes.

Note 4: When use MIPI I/F, MIPI Lanes must go to LP11 after Power A∀EE is ready



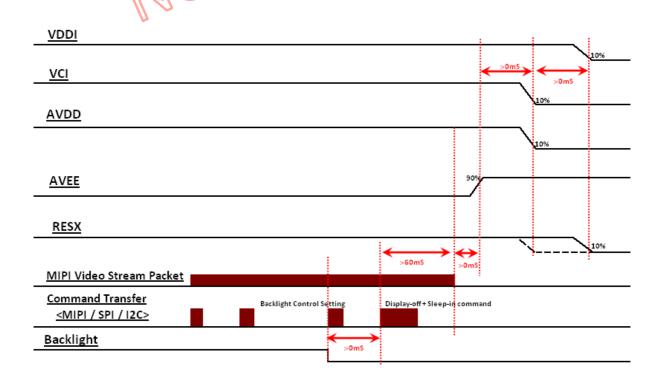


# 5.10.1.3 {ENPWRP, ENPWRN} = 11b and EN4PWR=1 (four power (VDDI/VCI/AVDD/AVEE) input)



- Note 1: The RESX waveform #1 is better than #2
- Note 2: After Sleep-Out Command, Driver IC will reload MTP registers and do internal power on action.

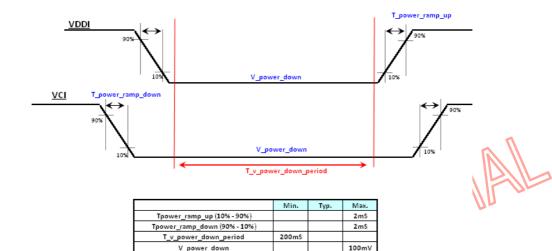
  Therefore, any initial settings (such as 3A00h, 3B00h, etc.) by MIPI, SPI or I2C should be set after Sleep-Out command with minimum delay time 100mS.
- Note 3: For detailed panel-related power sequence, please refer to NT35596 Application Notes.
- Note 4: When use MIPI I/F, MIPI Lanes must go to LP11 after Power AYEE is ready





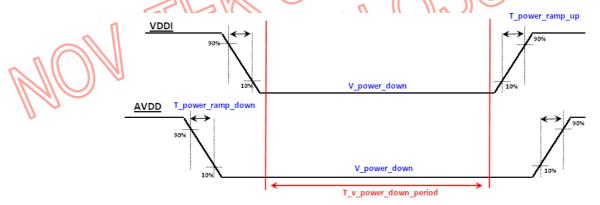
# 5.10.2 Power Ramp-up/down SPEC

# 5.10.2.1 Two Input Power (VCI / VDDI)



Note: For detailed application circuit, please refer to NT35596 Application Note.

# 5.10.2.2 Two Input Power (VCI/AVDD)

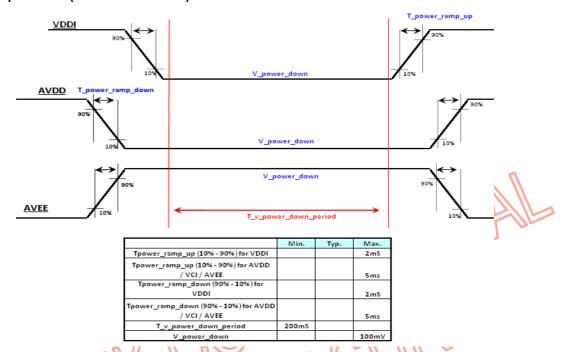


	Min.	Тур.	Max.
Tpower_ramp_up (10% - 90%) for VDDI			2mS
Tpower_ramp_up (10% - 90%) for AVDD			5ms
Tpower_ramp_down (90% - 10%) for VDDI			2mS
Tpower_ramp_down (90% - 10%) for AVDD			5ms
T_v_power_down_period	200mS		
V_power_down			100mV

Note: For detailed application circuit, please refer to NT35596 Application Note.

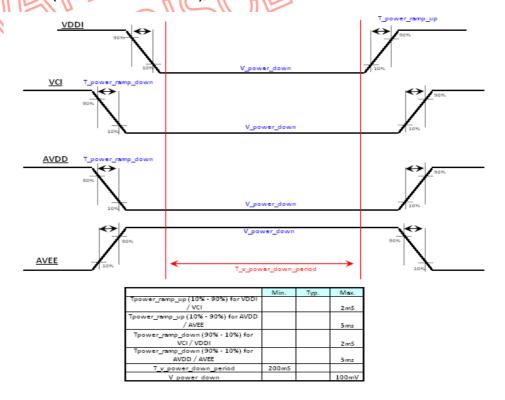


# 5.10.2.3 Three Input Power (VDDI / AVDD / AVEE)



Note: For detailed application circuit, please refer to NT35596 Application Note.

# 5.10.2.4 Four Input Power (VDDI / VCI / AVDD / AVEE)



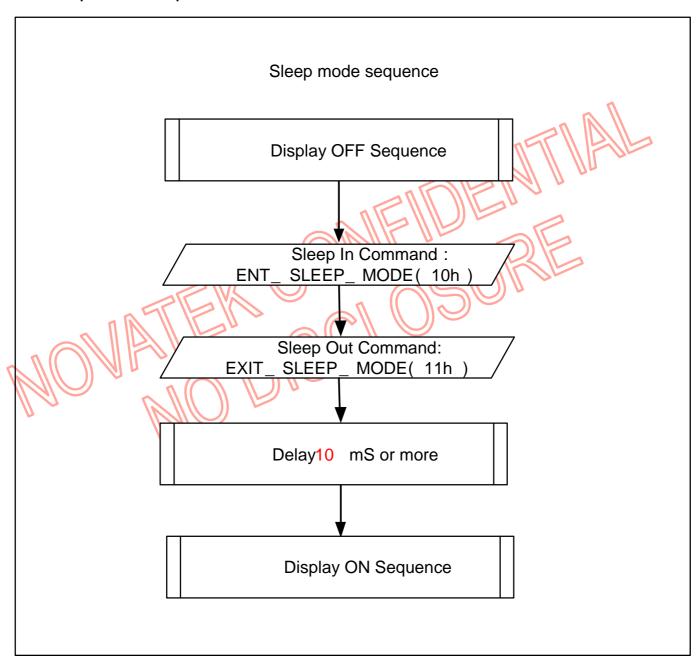
Note: For detailed application circuit, please refer to NT35596 Application Note.



### **5.11 Instruction Setting Sequence**

When setting instruction to the NT35596, the sequences shown in below figures must be followed to complete the instruction setting.

#### 5.11.1 Sleep SET/EXIT Sequences



Sleep SET/EXIT Sequences

Note: If user wants to change the LTPS timing, frame rate, porch settings, it would be necessary to delay 6 frames or more after sleep out command.



#### 5.11.2 Deep Standby Mode ENTER/EXIT Sequences

Set Display off (28h)

Enter Sleep-In mode
(Set ENTER\_SLEEP\_MODE (10h))

Waiting Time (4 frames or more)

# Enter Deep Standby Mode (Set ENTER\_DSTB\_MODE (4Fh))=01h)

Note:

For MIPI IF, if deep standby mode is used, please pull HSSI\_CLK\_P/N & HSSI\_D0~D3\_P/N to VSS after executing deep standby command.

# Exit Deep Standby Mode (Set RESX pin low pulse more than 3 mSec)

Note:

After exiting deep standby mode, please enables HSSI\_CLK\_P/N & HSSI\_D0~D3\_P/N to 1.2V.

**Initial instruction Setting** 

Display - On Sequence



Deep Standby Mode ENTER/EXIT Sequences



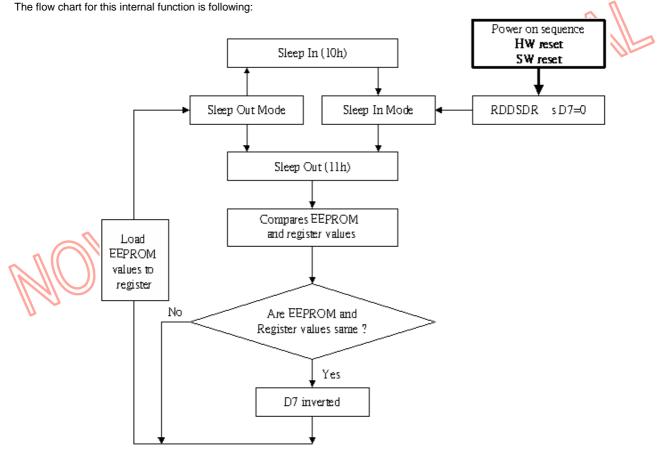


# 5.12 SLEEP OUT-COMMAND AND SELF-DIAGNOSTIC FUNCTIONS OF THE DISPLAY MODULE

#### 5.12.1 Register Loading Detection

Sleep Out-command (See "Sleep Out (11h)") is a trigger for an internal function of the display module, which indicates, if the display module loading function of factory default values from EEPROM (or similar device) to registers of the display controller is working properly.

There are compared factory values of the EEPROM and register values of the display controller by the display controller. If those both values (EEPROM and register values) are same, there is inverted (=increased by 1) a bit, which is defined in command "Read Display Self-Diagnostic Result (0Fh)" (=RDDSDR) (The used bit of this command is D7). If those both values are not same, this bit (D7) is not inverted (= increased by 1).



Note: There is not compared and loaded register values, which can be changed by user (00h to AFh and DAh to DDh), by the display module.

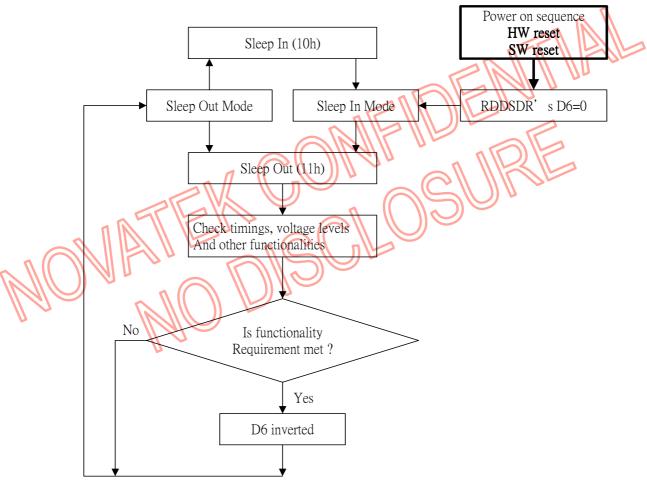


#### 5.12.2 Functionality Detection

Sleep Out-command (See "Sleep Out (11h)" is a trigger for an internal function of the display module, which indicates, if the display module is still running and meets functionality requirements.

The internal function (= the display controller) is comparing, if the display module is still meeting functionality requirements (e.g. booster voltage levels, timings, etc.). If functionality requirement is met, there is inverted (= increased by 1) a bit, which defined in command "Read Display Self-Diagnostic Result (0Fh)" (= RDDSDR) (The used bit of this command is D6). If functionality requirement is not same, this bit (D6) is not inverted (= increased by 1).

The flow chart for this internal function is following:

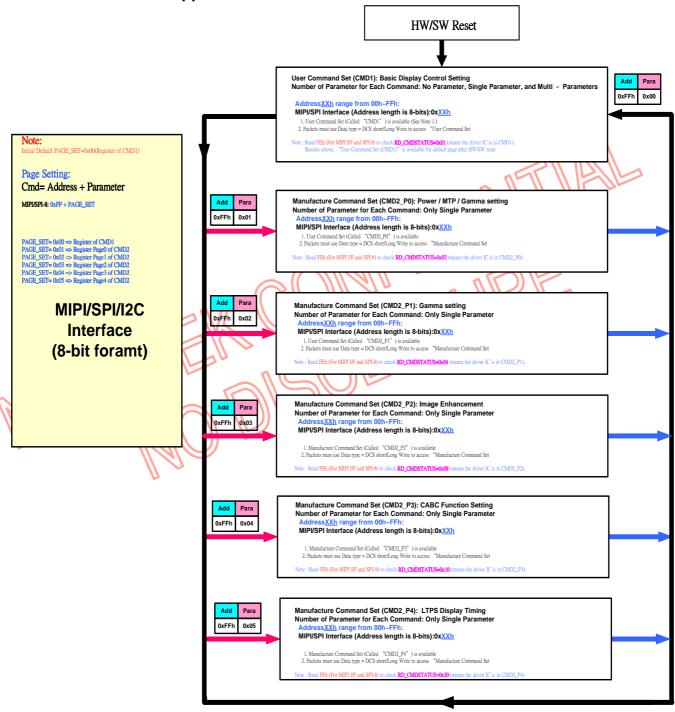


Note: There is needed 120msec after Sleep Out -command, when there is changing from Sleep In -mode to Sleep Out -mode, before there is possible to check if functionality requirements are met and a value of RDDSDR's D6 is valid. Otherwise, there is 5msec delay for D6's value, when Sleep Out -command is sent in Sleep Out -mode.



### 6. Command Descriptions

### MIPI/SPI/I2C Interface Application



Working Flow for Accessing Registers in CMD1 / CMD2 for MIPI/SPI/I2C interface.



The address mapping of registers for these 2 command sets is summarized as table below:

		User Comman	d Set (CMD1)		
	MIF	PI / SPI / I2C		СР	U (For Test Mode)
Command Table	Data Type	Address	8-bits	Address	16-bits
	Data Type	Parameter	8-bits	Parameter	16-bits
XXh	DCS Short Write,	Address	XXh	Address	XX00h
XXII	No Parameter	Address	AAII	Address	AAOOII
XXh + 1 Parameter	DCS Short Write,	Address	XXh	Address	XX00h
70 ti i i aramotor	1 Parameter	Parameter	PA1h	Parameter	PA1h
		Address	XXh	Address	XX00h
XXh + 2 Parameters	DCS LongWrite with	Parameter 1	PA1h	Parameter 1	PA1h
AATT 21 drameters	2 Parameters	Parameter 2	PA2h	Address	XX01h
				Parameter 2	PA2h
		Address	XXh	Address	XX00h
		Parameter 1	PA1h	Parameter 1	PA1h
		Parameter 2	PA2h	Address	XX01h
		Parameter 3	PA3h	Parameter2	PA2h
		:	:	Address	XX02h
XXh + n Parameters	DCS Long Write with	:	:	Parameter3	PA3h
(n > 2)	n Parameters	Parameter n-th	PAnh	Address	XX03h
				Parameter4	PA4h
				:	:
				:	:
				Address	XXXnh
				Parameter n	PAnh

Note: CMD1 is for Basic Display Control Setting use only

	Manufacture Cor	nmand Set (Reg	ister Page 0 of 0	CMD2)		
	MIF	PI / SPI / I2C		CPU (For Test Mode)		
Command Table	Data Type	Address 8-bits		Address	16-bits	
	Data Type	Parameter	8-bits	Parameter	16-bits	
XXh	DCS Short Write,	Address	XXh	Address	XX40h	
	No Parameter					
XXh + 1 Parameter	DCS Short Write,	Address	XXh	Address	XX40h	
XXn + 1 Parameter	1 Parameter	Parameter	PA1h	Parameter	PA1h	

Note: Page0 of CMD2 is for Power / MTP / Gamma setting use only



	Manufacture Command Set (Register Page 1 of CMD2)										
	MIF	PI / SPI / I2C		CPU (For Test Mode)							
Command Table	Data Type	Address	8-bits	Address	16-bits						
	Data Type	Parameter	8-bits	Parameter	16-bits						
XXh	DCS Short Write,	Address	XXh	Address	XX50h						
AAII	No Parameter	Address	<b>7</b> /11	Address	XX3011						
XXh + 1 Parameter	DCS Short Write,	Address	XXh	Address	XX50h						
XXn + 1 Parameter	1 Parameter	Parameter	PA1h	Parameter	PA1h						

Note: Page1 of CMD2 is for Gamma setting use only

	Manufacture Command Set (Register Page 3 of CMD2)											
	MIF	PI / SPI / I2C		CPU (For Test Mode)								
Command Table	Data Type	Address	8-bits	Address	16-bits							
	Data Type	Parameter	8-bits	Parameter	16-bits							
XXh	DCS Short Write,	Address	XXh	Address	XX60h							
	No Parameter	No Parameter										
XXh + 1 Parameter	DCS Short Write,	Address	XXh	Address	XX60h							
AAII + I Farameter	1 Parameter	Parameter	PA1h	Parameter	PA1h							

Note: Page2 of CMD2 is for Image Enhancement use only

	Manufacture Command Set (Register Page 3 of CMD2)											
	MIF	PI / SPI / I2C		CPU (For Test Mode)								
Command Table	Data Type	Address	8-bits	Address	16-bits							
	Data Type	Parameter	8-bits	Parameter	16-bits							
XXh	DCS Short Write,	Address	XXh	Address	XX70h							
AAII	No Parameter	Address	7001	Address	7007 011							
XXh + 1 Parameter	DCS Short Write,	Address	XXh	Address	XX70h							
AAIITIFalanietei	1 Parameter	Parameter	PA1h	Parameter	PA1h							

Note: Page3 of CMD2 is for CABC Function Setting use only

	Manufacture Cor	nmand Set (Reg	ister Page 4 of (	CMD2)	
	MIF	PI / SPI / I2C		CPU (Fo	or Test Mode)
Command Table	Data Type	Address 8-bits		Address	16-bits
	Data Type	Parameter	8-bits	Parameter	16-bits
XXh	DCS Short Write,	Address	XXh	Address	XX80h
AAII	No Parameter	Address	<b>7</b> /11	Address	AAOUII
XXh + 1 Parameter	DCS Short Write,	Address	XXh	Address	XX80h
XXII + 1 Parameter	1 Parameter	Parameter	PA1h	Parameter	PA1h

Note: Page4 of CMD2 is for Display LTPS timing setting use only



# 6.1 User Command Set (Command 1)

	2C Interface	Other I/F	Command 1)								
CMD	Parameter	Address	Instruction	D7	D6	D5	D4	D3	D2	D1	D0
00h	-	0000h	NOP	No Argument				gument		Į.	
01h	-	0100h	SOFT_RESET				No Ar	gument			
	1st Parameter	0400h	RDID1	ID17	ID16	ID15	ID14	ID13	ID12	ID11	ID10
04h	2nd Parameter	0401h	RDID2	1	ID26	ID25	ID24	ID23	ID22	ID21	ID20
	3rd Parameter	0402h	RDID3	ID37	ID36	ID35	ID34	ID33	ID32	ID31	ID30
05h	1st Parameter	0500h	RDNUMED	D[7:0]							
0Ah	1st Parameter	0A00h	GET_POWER_MODE	D7 0 0 D4 0 D2 0							0
0Bh	1st Parameter	0B00h	GET_ADDRESS_MODE	D7	D6	0	0	D3	0	0	0
0Dh	1st Parameter	0D00h	GET_DISPLAY_MODE	0	85	D5	0	0	D2	D1	D0
0Eh	1st Parameter	0E00h	GET_SIGNAL_MODE	D7	D6	0	°	0	0	0	D0
0Fh	1st Parameter	0F00h	RDDSDR	D7 D6 0 0 0 0 0							D0
10h	-	1000h	ENTER_SLEEP_MODE	J			No Ar	gument	71		
11h	-	1100h	EXIT_SLEEP_MODE		$R_{c}$	$((\ \ ))$	No Ar	gument			
20h	2	2000h	EXIT_INVERT_MODE	No Argument							
21h		2100h	ENTER_INVERT_MODE	No Argument							
26h	1st Parameter	2600h	GAMSET	GC[7:0]							
28h	-	2800h	SET_DISPLAY_OFF	No Argument							
29h	-	2900h	SET_DISPLAY_ON				No Ar	gument			
34h	-	3400h	SET_TEAR_OFF		1		No Ar	gument			
35h	1st Parameter	3500h	SET_TEAR_ON	TEW3	TEW2	TEW1	TEW0	0	0	TEP	М
36h	1st Parameter	3600h	SET_ADDRESS_MODE	SD_MY	SD_MX	0	0	RGB	0	0	0
44h	1st Parameter	4400h	SET_TEAR_SCANLINE	0	0	0	0	0	N10	N9	N8
45h	1st Parameter	4500h		N7	N6	N5	N4	N3	N2	N1	N0
46h	1st Parameter	4500h	RDSCL	SL15	SL14	SL13	SL12	SL11	SL10	SL9	SL8
	2nd Parameter	4501h		SL7	SL6	SL5	SL4	SL3	SL2	SL1	SL0
4Fh	1st Parameter	4F00h	ENTER_DSTB_MODE	0	0	0	0	0	0	0	DSTB
51h	1st Parameter	5100h	WRDISBV	DBV7	DBV6	DBV5	DBV4	DBV3	DBV2	DBV1	DBV0
52h	1st Parameter	5200h	RDDISBV	DBV7	DBV6	DBV5	DBV4	DBV3	DBV2	DBV1	DBV0
53h	1st Parameter	5300h	WRCTRLD	0	0	BCTRL	0	DD	BL	0	0
54h	1st Parameter	5400h	RDCTRLD	0 0 BCTRL 0 DD BL DB G						G	
55h	1st parameter	5500h	WR PWR SAVE	IN	//AGE_ENHAI	NCEMENT [3:	0]	0	0	CABC_C	COND[1:0]
56h	1st parameter	5600h	RDPWR SAVE	IN	//AGE_ENHAI	NCEMENT [3:	0]	0	0	CABC_C	COND[1:0]
5Eh	1st Parameter	5E00h	WRCABCMB				СМЕ	B[7 : 0]			



MIPI/SPI/I	2C Interface	Other I/F		1									
CMD	Parameter	Address	Instruction	D7	D6	D5	D4	D3	D2	D1	D0		
5Fh	1st Parameter	5F00h	RDCABCMB		CMB[7:0]								
	1st Parameter	A100h			SID[7 : 0]: LSB of Supplier ID								
	2nd Parameter	A101h			SID[15: 8]: MSB of Supplier ID								
	3rd Parameter	A102h			MID[7:0]: LSB of Model Number ID								
A1h	4th Parameter	A103h	RDDDBS			MID	[15 : 8]: MSB	of Model Num	ber ID				
	5th Parameter	A104h					RID[7 : 0]: LS	B of Revision	ID	n n			
	6th Parameter	A105h				R	RID[15 : 8]: MS	BB of Revision	ID				
	7th Parameter	A106h		1	1	1	1		1	1	1		
	1st Parameter	A800h				- 015	SID[7 : 0]: LS	B of Supplier					
	2nd Parameter	A801h			7		SID[15; 8]: MS	SB of Supplier	ID				
	3rd Parameter	A802h				MIC	[7 : 0]: LSB o	f Model Numb	oer ID				
A8h	4th Parameter	A803h	RDDDBC	MID[15 : 8]; MSB of Model Number ID									
	5th Parameter	A804h		RID[7: 0]: LSB of					ID				
	6th Parameter	A805h			Rc	R	RID[15 : 8]: MS	SB of Revision	ID				
	7th Parameter	A806h		(	ħ		1	1	1	1	1		
AAh	1st Parameter	AA00h	RDFCS	FCS7	FCS6	FCS5	FCS4	FCS3	FCS2	FCS1	FCS0		
	1st Parameter	AB00h		AWER15	AWER14	AWER13	AWER12	AWER11	AWER10	AWER9	AWER8		
ABh	2nd Parameter	AB01h	MIPI Error Report	AWER7	AWER6	AWER5	AWER4	AWER3	AWER2	AWER1	AWER0		
A Oli	1st Parameter	AC00h	DCS Long Write Payload	LPa15	LPa14	LPa13	LPa12	LPa11	LPa10	LPa9	LPa8		
ACh	2nd Parameter	AC01h	Counter	LPa7	LPa6	LPa5	LPa4	LPa3	LPa2	LPa1	LPa0		
AEh	1st Parameter	AE00h	STB EDGE POSITION				STB_EDG	SE_SEL[7:0]					
AFh	1st Parameter	AF00h	RDCCS	CCS7	CCS6	CCS5	CCS4	CCS3	CCS2	CCS1	CCS0		
BAh	1st Parameter	BA00h	SET_MIPI_LANE	0	0	0	0	0	0	DSI_L/	ANE[1:0]		
BCh	1st Parameter	BC00h	3D-Barrie Ctrl	0	0	EN_PORTR AIT	EN_3D	0	0	0	0		
D2h	1st Parameter	D200h	RGBCTRL	0	CRCM	0	0	DP	EP	HSP	VSP		
D3h	1st Parameter	D300h		0	0	VBP5	VBP4	VBP3	VBP2	VBP1	VBP0		
D4h	1st Parameter	D400h	DOS-11210	0	0	VFP5	VFP4	VFP3	VFP2	VFP1	VFP0		
D5h	1st Parameter	D500h	RGBMIPICTRL	0	0	HBP5	HBP4	HBP3	HBP2	HBP1	HBP0		
D6h	1st Parameter	D600h		0	0	HFP5	HFP4	HFP3	HFP2	HFP1	HFP0		
DAh	1st Parameter	DA00h	RDID1	ID17	ID16	ID15	ID14	ID13	ID12	ID11	ID10		
DBh	1st Parameter	DB00h	RDID2	ID27	ID26	ID25	ID24	ID23	ID22	ID21	ID20		
DCh	1st Parameter	DC00h	RDID3	ID37	ID36	ID35	ID34	ID33	ID32	ID31	ID30		
F3h	1st Parameter	F300h	MULTIIF	IM_IF_SEL	0	0	0	SECOND_I	F_SEL[1:0]	0	MULTIIF_EN		



MIPI/SPI/	I2C Interface	Other I/F									
CMD	Parameter	Address	Instruction	D7	D6	D5	D4	D3	D2	D1	D0
F4h	1st Parameter	F400h	Novatek ID	1	0	0	1	0	1	1	0
F5h	1st Parameter	F500h	IF_TEST	IF_TEST[7:0]							
F6h	1st Parameter	F600h	EVOK CTDI		EXCK_F	REQ[11:8]		0	0	0	EN_EXCK
F7h	1st Parameter	F700h	EXCK_CTRL	EXCK_FREQ[7:0]					1		
F8h	1st Paramete	F900h	I2C_SLAVE_ADDR	0			I2C_	_SLAVE_ADD	R[1:0]		
F9h	1st Paramete	FA00h	PIXEL_EXTEN	0	0	0	0	0	0	PIXEL_E	XTEN[1:0]
FBh	1st Parameter	FB00h	Reload CMD1	0	0	0	0	م الو			Reload_ CMD1
FEh	-	FE00h	RD_CMDSTATUS	0	0	CMD2_P4	CMD2_P3	CMD2_P2	CMD2_P1	CMD2_P0	CMD1
FFh	-	FF00h	CMD Page Select			71110	PAGE_	SEL[7:0]	J		



#### (00h) NOP: No Operation

Address		0	Dh		Access Attribute				w	
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value	
Parameter 1	-	No Argument								

Description	- This command performs no operation and is ignored by the device.
Restriction	-
	Status Availability
	Normal Mode On, Idle Mode Off, Sleep Out
Register Availability	Normal Mode On, Idle Mode On, Sleep Out
,	Partial Mode On, Idle Mode Off, Sleep Out N.A.
	Partial Mode On, Idle Mode On, Sleep Out N.A.
	Sleep In Yes
Default Value	N/A N/A
NOVA	NO DISCLOS



#### (01h) SOFT\_RESET: Software Reset

Address		01	lh			w				
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value	
Parameter 1	-	No Argument								

5	- When the Software Reset command is written, it causes a soft	ware reset. It resets the commands and							
Description	parameters to their S/W Reset register values and all source & gate	outputs are set to GND (display off).							
	(1) It will be necessary to wait 20msec before sending new comman	nd following software reset.							
	<ul><li>(2) The display module loads all display suppliers' factory default values to the registers during 8 msec.</li><li>(3) If Software Reset is applied during Sleep Out mode, it will be necessary to wait 120 msec before sending</li></ul>								
Restriction									
	Sleep- Out command.	W							
	(4) Software reset command cannot be sent during Sleep Out sequence.								
	Status	Availability							
	Normal Mode On, Idle Mode Off, Sleep Out	Yes							
Register Availability	Normal Mode On, Idle Mode On, Sleep Out	N.A.							
	Partial Mode On, Idle Mode Off, Sleep Out	N.A.							
	Partial Mode On, Idle Mode On, Sleep Out	N.A.							
	Sleep In	Yes							
Default Value	N/A								
- 11									

### (04h) RDID: Read Display ID

Address		04	4h		Access Attribute				R
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	ID17	ID16	ID15	ID14	ID13	ID12	ID11	ID10	N/A
Parameter 2	1	ID26	ID25	ID24	ID23	ID22	ID21	ID20	N/A
Parameter 3	ID37	ID36	ID35	ID34	ID33	ID32	ID31	ID30	N/A

- This read byte returns display identification information.

The 1st parameter (ID17 to ID10): LCD module's manufacturer ID.

The 2nd parameter (ID26 to ID20): LCD module/driver version ID.

It is defined by display supplier and changes each time a revision is made to the display, material or construction

specifications. See Table:

Description

ID Byte Value	Version	Change			
8'h80	Version1				
8'h81	Version2				
8'h82	Version3	:			

The 3rd parameter (ID37 to ID30): LCD module/driver ID.

#### Restriction

# Register Availability

Status	Availability
Normal Mode On, Idle Mode Off, Sleep Out	Yes
Normal Mode On, Idle Mode On, Sleep Out	N.A.
Partial Mode On, Idle Mode Off, Sleep Out	N.A.
Partial Mode On, Idle Mode On, Sleep Out	N.A.
Sleep In	Yes

#### Default Value

Status	Default Value						
Status	04h-1st	04h-2nd	04h-3rd				
Power On Sequence	N/A	N/A	N/A				
S/W Reset	N/A	N/A	N/A				
H/W Reset	N/A	N/A	N/A				

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#### (05h) RDNUMED: Read Number of the Error on DSI

Address		0	5h		Access Attribute				R
Parameter	D[7]	D[7] D[6] D[5] D[4]				D[3] D[2] D[1] D[0]			
Parameter 1	D7	D6	D5	D4	D3	D2	D1	D0	00h

	- 7	The first para	ameter is telling a number of the	errors on DSI. The more detailed description of the bi	ts is				
	е	explained in below.							
Description	D[ D[ is	7] is set to '1' 7 : 0] bits are sent the seco	its are telling a number of the errors.  et to '1' if there is overflow with P[6 : 0] bits.  its are set to '0's (as well as GET_SIGNAL_MODE (0Eh)'s D0 is set '0' at the same time) after there e second parameter information (= The read function is completed).  Iso refer to the sections: "Acknowledge with Error Report (AwER)" and "Read Display Signal Mode						
Restriction	$\mathbb{N}$								
	70								
			Status	Availability					
llale c	$\mathcal{I}$	Normal	Mode On, Idle Mode Off, Sleep O	ut Yes					
Register Availability		Normal	Mode On, Idle Mode On, Sleep O	ut N.A.					
	17	Partial	Mode On, Idle Mode Off, Sleep O	ut N.A.					
		Partial	Mode On, Idle Mode On, Sleep O	ut N.A.					
			Sleep In	Yes					
			Status	Default Value					
Default Value			Power On Sequence	00h					
1			S/W Reset	00h					
			<b>5</b> ,	0011					
			H/W Reset	00h					

# (0Ah) GET\_POWER\_MODE: Read Display Power Mode

Address		0/	Ah		Access Attribute				R
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	D7	0	0	D4	1	D2	0	0	08h

	- This command indic	cates the current status	of the display as desc	cribed in the table below:		
	Bit	Description		Value		
	D7	Booster Voltage State	us "1"=Booste	er on, "0"=Booster off		
	D6	Reserved	"0" (Not us	ed)		
	D5	Reserved	"0" (Not us	ed)		
Description	D4	Sleep In/Out	"1" = Sleep	Out, "0" = Sleep In		
	D3	Reserved	"1" (Not us	ed)		
	D2	Display On/Off	"1" = Displ	ay On, "0" = Display Off		
	D1	Reserved	"0" (Not us	ed)		
	D0	Reserved	"0" (Not us	"0" (Not used)		
Restriction						
	7/1	Status		Availability		
	Norma	I Mode On, Idle Mode O	Off, Sleep Out	-		
ll Ala	\\	I Mode On, Idle Mode O	•			
Register Availability		Mode On, Idle Mode C				
	U	Mode On, Idle Mode C	· .	1		
		Sleep In Ye				
		1				
	s	tatus	De	fault Value		
Default Value	Power O	n Sequence		00h		
	S/W	/ Reset		00h		
1		/ Reset	00h			

#### (0Bh) GET\_ADDRESS\_MODE: Get the Display Panel Read Order

Address	0Bh				Access Attribute				R
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	D7	D6	0	0	D3	0	0	0	00h

	- Thi	s comma	and indicates the current status	of the display	/ as described in the table below:		
		Bit	Description	or are alepiay	Value		
		D7	Vertical Scan Direction (SD_I	MY) "1"=D	Decrement (MY = 1), "0"=Increment (SD_MY = 0)		
		D6	Horizontal Scan Direction (SD_MX)	"1"=□	Decrement (MX = 1), "0"=Increment (SD_MX = 0)		
		D5	Reserved		"0" (Not used)		
Description		D4	Reserved		"0" (Not used)		
		D3	RGB/BGR Order	1116 11	=BGR (register bit RGB of register 0x36 is "1")  =RGB (register bit RGB of register 0x36 is "0")		
	<b>2</b> 5	D2	Reserved		"0" (Not used)		
		D1	Reserved		"0" (Not used)		
		D0	Reserved		"0" (Not used)		
Restriction	7-11						
			Status		Availability		
		$1 \sim$	nal Mode On, Idle Mode Off, S		Yes		
Register Availability			mal Mode On, Idle Mode On, S		ut N.A.		
		Par	tial Mode On, Idle Mode Off, SI	eep Out	N.A.		
		Par	tial Mode On, Idle Mode On, Sl	eep Out	N.A.		
			Sleep In		Yes		
			Status		Default Value		
Default Value		F	Power On Sequence		00h		
			S/W Reset		00h		
			H/W Reset	00h			

# (0Dh) GET\_DISPLAY\_MODE: Read the Current Display Mode

Address		01	Oh		Access Attribute				R
Parameter	D[7]	D[7] D[6] D[5] D[4]				D[3] D[2] D[1] D[0]			
Parameter 1	0	0	D5	0	0	D2	D1	D0	00h

	- Th		nd indicates the current sta	atus of the display					
	H	Bit	Description			alue			
	Н	D7	Reserved		"0" (N	lot used)			
	╽╽	D6	Reserved		"0" (N	lot used)			
	ΙЬ	D5	Inversion On/Off	"0" = Inv	ersion is Off,	"1" = Inversion is On			
		D4	Reserved		"0" (N	lot used)			
		D3	Reserved		"0" (N	lot used)			
Description		D[2:0]	Gamma Curve Selection	D2 D1  0 0  0 0  0 1  Others	D0	amma Curves Selection ed on Register 26h Setting) Gamma 2.2 Reserved Reserved Reserved Reserved			
Restriction									
	11	7	Status			Availability			
		Norm	al Mode On, Idle Mode O	ff, Sleep Out		Yes			
Register Availability		Norm	al Mode On, Idle Mode O	n, Sleep Out		N.A.			
j		Partia	al Mode On, Idle Mode Of	f, Sleep Out		N.A.			
		Partia	al Mode On, Idle Mode Or	n, Sleep Out		N.A.			
			Sleep In			Yes			
			Status		Defa	ult Value			
Default Value		Po	ower On Sequence	00h					
20.22.7 74.40			S/W Reset			00h			
			H/W Reset			00h			
	'			11-			=		



# (0Eh) GET\_SIGNAL\_MODE: Get Display Module Signaling Mode

Address	0Eh					R			
Parameter	D[7]	D[7] D[6] D[5] D[4]				D[3] D[2] D[1] D[0]			
Parameter 1	D7	D6	0	0	0	0	0	D0	00h

	- This	command ind	icates the current status of the	display as desc	ribed in the table bel	ow:		
		Bit	Description		Valu	ie		
		D7	Frame Tearing Effect Line	e On/Off	"1" = On,	"0" = Off		
		D6	Tearing Effect Line Outpu	ut Mode "	1" = Mode B,	"0" = Mode A		
		D5	Reserved		"0" (Not	used)		
Description		D4	Reserved		"0" (Not	used)		
		D3	Reserved		"0" (Not	used)		
		D2	Reserved		"0" (Not	used)		
		D1	Reserved		"0" (Not	used)		
		<b>D</b> 0	Error on DSI		1" = Error, "0	" = No Error		
Restriction								
	7//				A 11 - 1 - 11	11		
	2	Normal Mo	Status  de On, Idle Mode Off, Sleep O	ut	Availabili Yes	ity		
Register Availability		Normal Mo	de On, Idle Mode On, Sleep O	ut	N.A.			
, , , , , , , , , , , , , , , , , , ,		Partial Mo	de On, Idle Mode Off, Sleep Ou	ut	N.A.			
		Partial Mo	de On, Idle Mode On, Sleep Ou	ut	N.A.			
			Sleep In		Yes			
			Status		Default Value			
Default Value			Power On Sequence		00h			
			S/W Reset		00h			
			H/W Reset	00h				

#### (0Fh) RDDSDR: Read Display Self-Diagnostic Result

Address		OI	h			R				
Parameter	D[7]	D[7] D[6] D[5] D[4]				D[3] D[2] D[1] D[0]				
Parameter 1	D7	D6	0	0	0	0	0	D0	00h	

	- Tł	nis comma	and indicates the status of th	e display self-	diagnostic results	after Sleep Out. This command is					
	de	scribed in	the table below.								
		Bit	Description		Val	lue					
		D7	Register Loading Detection	Se	r Loading Detection"						
		D6	Functionality Detection		See section "Func	tionality Detection"					
		D5	Not Used		"0" (No	t used)					
Description		D4	Not Used		"0" (No	t used)					
		D3	Not Used		"0" (No	t used)					
		D2	Not Used		"0" (No	t used)					
		D1	Not Used		"0" (No	t used)					
	P	DO	D0 Checksums Compare "1"=Checksums are not same (Default)								
						, , ,					
Restriction			be necessary to wait 300ms after there is the last write access on DCS area registers before there if D0 value.								
11/9/0											
			Status		Availability						
	17	Norn	nal Mode On, Idle Mode Off,	Sleep Out		Yes					
Register Availability		Norn	nal Mode On, Idle Mode On,	Sleep Out		N.A.					
		Part	tial Mode On, Idle Mode Off, S	Sleep Out		N.A.					
		Part	tial Mode On, Idle Mode On, S	Sleep Out		N.A.					
		Sleep In Yes									
			Status		Default	Value					
Default Value		Р	Power On Sequence		001	1					
			S/W Reset		001	1					
			H/W Reset		001	1					



# (10h) ENTER\_SLEEP\_MODE: Enter the Sleep-In Mode

Address		10	)h			W			
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	Default Value			
Parameter 1		No Argument							Sleep-In Mode

Description	- This command initiates the power-down sequence. Th	e Sleep In profile will be executed when this command							
Restriction	- This command has no effect when the display module is already in Sleep Mode.								
	Status	Availability							
	Normal Mode On, Idle Mode Off, Sleep Out	Yes							
Register Availability	Normal Mode On, Idle Mode On, Sleep Out	N.A.							
	Partial Mode On, Idle Mode Off, Sleep Out	N-A.							
	Partial Mode On, Idle Mode On, Sleep Out Sleep In	N.A. Yes							
	Status	Default Status							
Default Value	Power On Sequence	Sleep-In							
	S/W Reset	Sleep-In							
	HW Reset	Sleep-In							



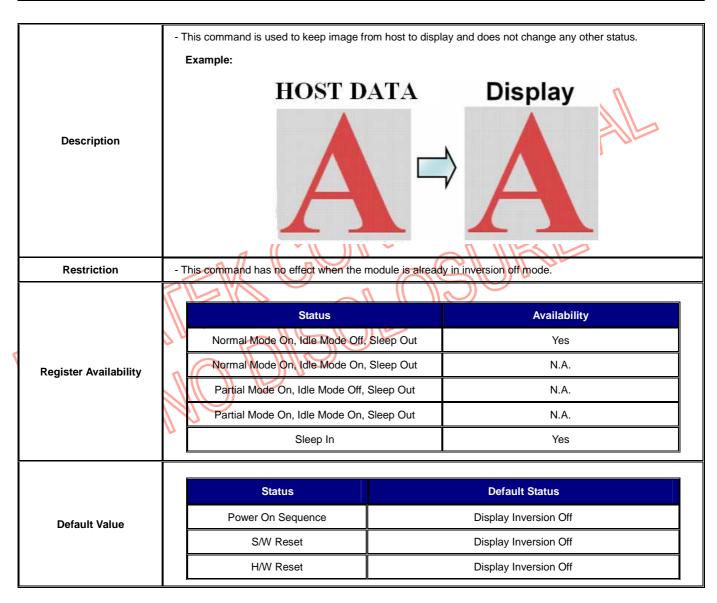
# (11h) EXIT\_SLEEP\_MODE: Exit the Sleep-In Mode

Address		11	lh			W			
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	Default Value			
Parameter 1				No Arg	jument				Sleep-In Mode

	- This command initiates the power-up se	equence.							
Description	· · ·	The Sleep Out profile will be executed when this command is received. The Sleep Out will re-load register value. It will be necessary to delay 20 ms or more before sending next command.							
Restriction	- This command will not cause any visible effect on the display when the display is not in Sleep Mode.								
	Status	Availability							
	Normal Mode On, Idle Mode Off, Sleep Out								
Register Availability	Normal Mode On, Idle Mode On, Sleep Out N.A.								
	Partial Mode On, Idle Mode Off,	Sleep Out N.A.							
	Partial Mode On, Idle Mode On,	Sleep Out N.A.							
	Sleep In	Yes							
	Status	Default Status							
Default Value	Power On Sequence	Sleep-In							
Delault Value	S/W Reset	Sleep-In							
	H/W Reset	Sleep-In							

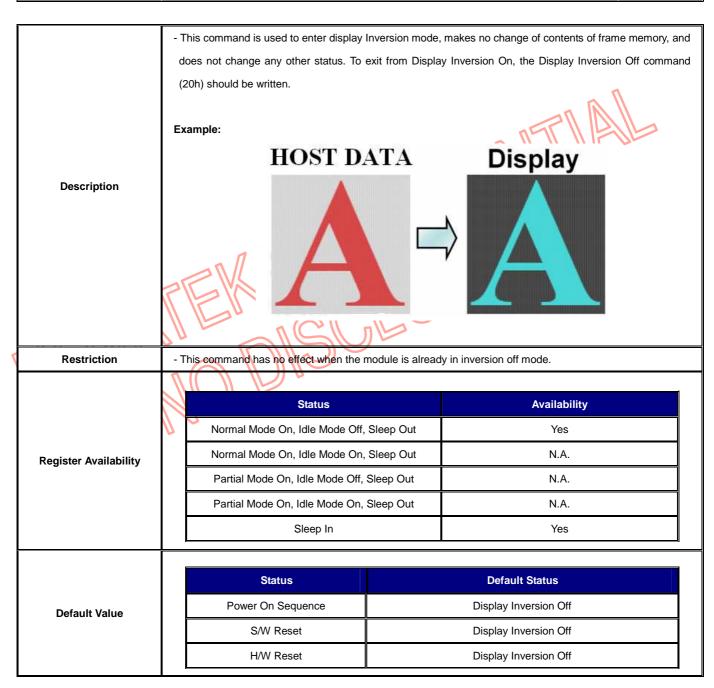
#### (20h) EXIT\_INVERT\_MODE: Display Inversion Off

Address		20	)h			Access Attribute				
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	Default Value				
Parameter 1		No Argument							Inversion Off	



#### (21h) ENTER\_INVERT\_MODE: Display Inversion On

Address		21	lh			W			
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	Default Value			
Parameter 1		No Argument							Inversion Off





#### (26h) GMASET: Gamma Curves Selection

Address		26	6h				R/W		
Parameter	D[7]	D[6]	D[5]	D[4]	D[3] D[2] D[1] D[0]				Default Value
Parameter 1	GC7	GC6	GC5	GC4	GC3	GC2	GC1	GC0	01h

	- This command is used to s	select the desired Gamm	a curve for the current display. The curve is selected b					
	setting the appropriate bit in	n the parameter as descri	bed in the Table.					
			0					
	GC[7:0]	Parameter	Curve Selected					
Description	01h	GC0	Gamma Curve 1 (Gamma 2.2)					
	02h	GC1	Reserved					
	04h	GC2	Reserved					
	08h	GC3	Reserved					
	- Values of GC[7:0] not sh	own in table above are i	nvalid and will not change the current selected Gamm					
Restriction	curve until valid value is rec	ceived.						
Restriction	- When register GMASET (2	6h) is changed, user sho	uld not access gamma registers within 20msec becaus					
	internal circuit needs some	time for gamma curve sv	itch.					
1								
	St	atus	Availability					
		le Mode Off, Sleep Out	Availability  Yes					
Register Availability	Normal Mode On, Id		·					
Register Availability	Normal Mode On, Id	le Mode Off, Sleep Out	Yes					
Register Availability	Normal Mode On, Id  Normal Mode On, Id  Partial Mode On, Idl	le Mode Off, Sleep Out	Yes N.A.					
Register Availability	Normal Mode On, Id  Normal Mode On, Id  Partial Mode On, Idl  Partial Mode On, Idl	le Mode Off, Sleep Out le Mode On, Sleep Out le Mode Off, Sleep Out	Yes N.A. N.A.					
Register Availability	Normal Mode On, Id  Normal Mode On, Id  Partial Mode On, Idl  Partial Mode On, Idl	le Mode Off, Sleep Out le Mode On, Sleep Out le Mode Off, Sleep Out le Mode On, Sleep Out	Yes N.A. N.A. N.A.					
Register Availability	Normal Mode On, Id  Normal Mode On, Id  Partial Mode On, Idl  Partial Mode On, Idl	le Mode Off, Sleep Out le Mode On, Sleep Out le Mode Off, Sleep Out le Mode On, Sleep Out	Yes N.A. N.A. N.A.					
Register Availability  Default Value	Normal Mode On, Id  Normal Mode On, Id  Partial Mode On, Idl  Partial Mode On, Idl  Sle	le Mode Off, Sleep Out le Mode On, Sleep Out le Mode Off, Sleep Out le Mode On, Sleep Out le Mode On, Sleep Out	Yes N.A. N.A. N.A. Yes					
	Normal Mode On, Id  Normal Mode On, Id  Partial Mode On, Idl  Partial Mode On, Idl  Sle  Status	le Mode Off, Sleep Out le Mode On, Sleep Out le Mode Off, Sleep Out le Mode On, Sleep Out le Mode On, Sleep Out	Yes N.A. N.A. N.A. Yes					



#### (28h) SET\_DISPLAY\_OFF: Display Off

Address	28h			Access Attribute				W	
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1		No Argument					Display Off		

- This command is used to enter to the DISPLAY OFF mode. In this mode, the output from Frame Memory is disabled and blank page is inserted. This command makes no change of contents of frame memory, and does not change any other status. There will be no abnormal visible effects on the display. Exit from this command by the Display On command (29h) Example: Display **RAM Data** Description Restriction This command has no effect when the module is already in Display Off mode. **Availability** Status Normal Mode On, Idle Mode Off, Sleep Out Yes Normal Mode On, Idle Mode On, Sleep Out N.A. **Register Availability** Partial Mode On, Idle Mode Off, Sleep Out N.A. Partial Mode On, Idle Mode On, Sleep Out N.A. Sleep In Yes Status **Default Status** Power On Sequence Display Off **Default Value** S/W Reset Display Off H/W Reset Display Off

#### (29h) SET\_DISPLAY\_ON: Display On

Address	29h			Access Attribute				w	
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1		No Argument					Display Off		

		the DISPLAY OFF mode. Output from the Frame Memory is enabled.							
	This command makes no change of contents of frame memory, and does not change any other status.								
Description	RAM Data Display								
Restriction	- This command has no effect when the module is already in Display On mode								
		<u>/</u>							
	Status	Availability							
11 2	Normal Mode On, Idle Mode Off,	Sleep Out Yes							
Register Availability	Normal Mode On, Idle Mode On,	Sleep Out N.A.							
Trogictor / trainability	Partial Mode On, Idle Mode Off, S	Sleep Out N.A.							
	Partial Mode On, Idle Mode On, S	Sleep Out N.A.							
	Sleep In	Yes							
	Status	Default Status							
Default Value	Power On Sequence	Display Off							
	S/W Reset	Display Off							



# (34h) SET\_TEAR\_OFF: Tearing Effect Line OFF

Address	34h			Access Attribute				W	
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1		No Argument					TE Line Off		

Description	- This command is used to turn OFF (Active Low) the output TE trigger message from the display module.								
Restriction	- This command has no effect when TE is already OFF.								
	Status	Availability							
Register Availability	Normal Mode On, Idle Mode Off, Sleep O	ut Yes							
	Normal Mode On, Idle Mode On, Sleep O	ut N.A.							
	Partial Mode On, Idle Mode Off, Sleep Ot	ıt N.A.							
	Partial Mode On, Idle Mode On, Sleep Ou	nt N.A.							
	Sleep In	Yes							
25	Status	Default Status							
Default Value	Power On Sequence	TE Line Off							
	S/W Reset	TE Line Off							
	H/W Reset	TE Line Off							



#### (35h) SET\_TEAR\_ON: Tearing Effect Line ON

Address	35h				Access	R/W			
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	TEW3	TEW2	TEW1	TEW0	0	0	TEP	M	00h

- This command is used to turn ON the Tearing Effect output from the TE signal. This output is not affected by changing MADCTR bit ML.

The Tearing Effect Line On has one parameter, which describes the mode of the Tearing Effect Output Line.

When M = 0: The Tearing Effect Output line consists of V-Blanking information only.

A Vertical Time Scale

When M = 1. The Tearing Effect Output line consists of both V-Blanking and H-Blanking information.

Vertical Time Scale

Description

Notes: During Sleep In Mode with Tearing Effect Line On, Tearing Effect Output pin will be active Low.

Register 35h & 44h both define TE Output:

R3500h	R4400h/R4500h	TE Output
M	N	TE Output
0	0	TE high in V-porch region (A)
1	0	TE high in all V-porch and H-porch region
		(B)
0	<b>≠</b> 0	TE high at N-th line (C)
1	<b>≠</b> 0	TE high in all V-porch and H-porch region
		(B)

This command is used to turn ON the output TE trigger message from display module.

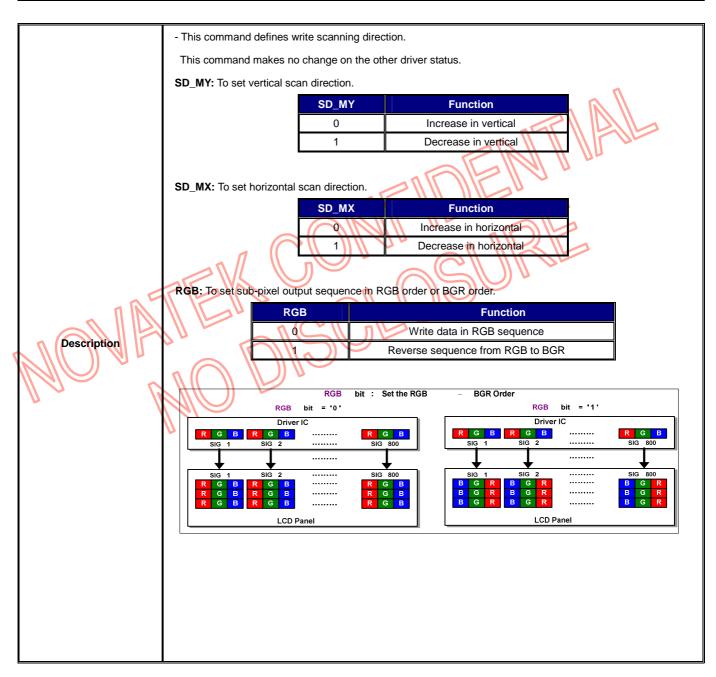
This output is not affected by changing SET\_ADDRESS\_MODE bit ML.

The Tearing Effect Line On has one parameter which describes the mode of the Tearing Effect Output Line.

TEP: Set the polarity of FTE signal. 0: Active High. 1: Active Low. TEW[3:0]: FTE active duration selection. TEW[3:0] **FTE Active Duration (Unit: Line)** Description 0 1 2 1 2 3 15 16 Restriction - This command has no effect when Tearing Effect output is already ON. **Status Availability** Normal Mode On, Idle Mode Off, Sleep Out Yes Normal Mode On, Idle Mode On, Sleep Out N.A. **Register Availability** Partial Mode On, Idle Mode Off, Sleep Out N.A. Partial Mode On, Idle Mode On, Sleep Out N.A. Sleep In Yes **Status Default Value Notes** Power On Sequence 00h TEW[3:0]=0 (1 Line) **Default Value** TEP = 0 (Active High) S/W Reset 00h M = 0(TE high in V-porch region (A)) H/W Reset 00h

#### (36h) SET\_DIRECTION\_MODE: Data Direction Access Control

Address	36h				Access	R/W			
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	SD_MY	SD_MX	0	0	RGB	0	0	0	00h





Restriction	- This	command has no effect when Tearing	Effect output is a	already C	DN.		
		Status			Availability		
Register Availability		Normal Mode On, Idle Mode Off	Sleep Out	·	Yes		
		Normal Mode On, Idle Mode On	Sleep Out		N.A.		
		Partial Mode On, Idle Mode Off,	Sleep Out	-	N.A.		
		Partial Mode On, Idle Mode On,	Sleep Out		N.A.		
		Sleep In		Yes			
		Status	Default Val	ue	Notes		
Default Value		Power On Sequence	00h		MY = 0 (Increase in vertical)		
Default value		S/W Reset	00h	11/2	MX = 0 (Increase in horizon)		
		H/W Reset	00h		RGB = 0 (RGB sequence)		



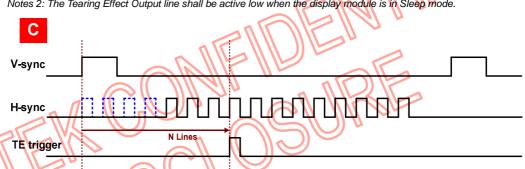
#### (44h~45h) SET\_TEAR\_SCANLINE: Set Tear Line

Address	44h				Access	R/W			
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
44h	0	0	0	0	N10	N9	N8	0	00h
45h	N6	N5	N4	N3	N2	N1	N0	N7	00h

- The Tearing Effect Line On has one parameter that describes the Tearing Effect Output Line mode. The Tearing Effect Output line consists of V-Blanking information only.

Notes 1: That TEARLINE with N = '0' is equivalent to TEON with M = '0'.

Notes 2: The Tearing Effect Output line shall be active low when the display module is in Sleep mode.



Description

Register 35h and 44h both define TE Output:

	R35h	R44h/45h	TE Output
1	М	N	12 Sulput
,	0	0	TE high in V-porch region (A)
	1	0	TE high in all V-porch and H-porch region (B)
	0	≠ 0	TE high at N-th line (C)
	1	≠ O	TE high in all V-porch and H-porch region (B)

This command is used to set the FTE output position.

Use "SET\_TEAR\_ON (35h)" to set the FTE polarity and pulse width.



		N[10:0] Function Description					
		000h		VBP Region			
		001h	1	2nd Line			
		002h		3rd Line			
Description		003h		4th Line			
		:		: .			
		77Dh					
		77Eh		1919th Line			
		77Fh		1920th Line			
	<b>-</b>				. (FTF)		
Restriction				ving the current frame. Therefore, if the Tear Eff	, ,		
Restriction	output is already ON, the FTE output shall continue to operate as programmed by the p SET_TEAR_ON, or SET_TEAR_SCANLINE, command until the end of the frame.						
	SET_TEAT_ON, STOLE_TEAT_DOMAINE, COMMING UNIQUE GROWTHE HAITE.						
		Sta	tus	Availability			
~ 1 M	Norm	nal Mode On, Idle	Mode Off, Sleep O	Yes			
Register Availability	Norm	nal Mode On, Idle	Mode On, Sleep O	ıt N.A	N.A.		
				14.74.			
	Parti	al Mode On, Idle	Mode Off, Sleep Ou				
	n + m	W // W	Mode Off, Sleep Ou Mode On, Sleep Ou	t N.A.			
Mo	n + m	W // W	Mode On, Sleep Ou	t N.A.			
	n + m	al Mode On, Idle	Mode On, Sleep Ou	t N.A.			
	Parti	al Mode On, Idle	Mode On, Sleep Ou	t N.A.			
	Parti	al Mode On, Idle Slee	Mode On, Sleep Ou p In	t N.A.  N.A.  Yes			
Default Value	Parti	al Mode On, Idle Slee	Mode On, Sleep Ou	t N.A.  t N.A.  Yes			
Default Value	Parti	al Mode On, Idle Slee Status On Sequence	Mode On, Sleep Ou p In  Default Value  00h	N.A.  N.A.  Yes  Note  (1) N[10:0] = 000h: FTE outputs at 1st line.			

#### (46h) RDSCL: Read Scan Line

Address	45h				Access Attribute				R
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	SL15	SL14	SL13	SL12	SL11	SL10	SL9	SL8	N/A
Parameter 2	SL7	SL6	SL5	SL4	SL3	SL2	SL1	SL0	N/A

- This command is used to read scan line data.							
-							
Status	Availability						
Normal Mode On, Idle Mode Off, Sleep Out	Yes						
Normal Mode On, Idle Mode On, Sleep Out	N.A.						
Partial Mode On, Idle Mode Off, Sleep Out	N.A.						
Partial Mode On, Idle Mode On, Sleep Out	WA						
Sleep In	Yes						
Status	Default Value						
	Status  Normal Mode On, Idle Mode Off, Sleep Out  Normal Mode On, Idle Mode On, Sleep Out  Partial Mode On, Idle Mode Off, Sleep Out  Partial Mode On, Idle Mode On, Sleep Out  Sleep In						

# (4Fh) ENTER\_DSTB\_MODE: Enter the Deep Standby Mode

Address	4Fh			Access Attribute				W	
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	0	0	0	0	0	0	0	DSTB	00h

	- This command is used to enter deep standby mode.								
	<b>DSTB</b> = '1': Enter the deep standby mode.								
Description	Note 1: It can't exit deep standby mode when set DSTB from '1' to '0'.  Note 2: User can not write this register in Sleep-Out and Display-On mode.  Note 3: To exit deep standby mode, please set RESX pin low pulse more than 3msec  - If user wants to enter to DSB mode from Normal Display directly, you must enter to sleep-in (reg. 10h) first and wait 4 frames or more time for complete power-down sequence, and then executes this command to enter to DSB mode								
Restriction									
Restriction									
	Status	Availability							
	Normal Mode On, Idle Mode Off, Sleep Out	Yes							
Register Availability	Normal Mode On, Idle Mode On, Sleep Out	N.A.							
Mala C	Partial Mode On, Idle Mode Off, Sleep Out	N.A.							
\	Partial Mode On, Idle Mode On, Sleep Out	N.A.							
	Sleep In	Yes							
	Status	Default Value							
Default Value	Power On Sequence	00h							
	S/W Reset	00h							
	H/W Reset	00h							

## (51h) WRDISBV: Write Display Brightness

Address	51h			Access Attribute				w	
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	DBV7	DBV6	DBV5	DBV4	DBV3	DBV2	DBV1	DBV0	00h

	1										
		ommand is used to adjust or return	-								
		In principle relationship is that 00h value means the lowest brightness and FFh value means the highest brightness.									
	brightne	DBV[7:0]	DIAMA Duty (0/)								
			PWM Duty (F	Ratio)	PWM Duty (%)						
		00h			<del>- 11 11 11 11 -</del>						
		01h	2 / 256		0.78125 %						
Description		02h	3 / 256	11 11 -	1.171875 %						
		03h	4\/256		1.5625 %						
			251/25	1/2 //							
		FDh	254 / 25 255 / 25	<del>~      </del>	99.21875 %						
	75	FEh	t)	99.609375 %							
	11 1/	100 %									
Restriction	70										
Restriction	26										
		Status		Availability							
	1/2	Normal Mode On, Idle Mode Off,	Sleep Out	Yes							
Register Availability		Normal Mode On, Idle Mode On,	Sleep Out	N.A.							
Register Availability		Partial Mode On, Idle Mode Off, S	Sleep Out	N.A.							
		Partial Mode On, Idle Mode On, S	Sleep Out	ep Out N.A.							
		Sleep In		Yes							
		Status			Default Value						
Default Value		Power On Sequence		00h							
		S/W Reset		00h							
		H/W Reset			00h						

## (52h) RDDISBV: Read Display Brightness

Address	52h			Access Attribute				R	
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	DBV7	DBV6	DBV5	DBV4	DBV3	DBV2	DBV1	DBV0	00h

	- This command is used to returns the brightness value of the display.								
	In principle relationship is that 00h value means the lowest brightness and FFh value means the highest								
Description	brightness. Please refer the register "WRDISBV (5100h)" for detailed.  DBV[7:0] is "0" (RDDISBV, 52h) when display is in sleep-in mode.								
	DBV[7:0] is "0" (RDDISBV, 52h) when bit BCTRL of "W	rite CTRL Display (5300h)" command is "0".							
	DBV[7:0] is manual set brightness specified with "Write	CTRL Display (5300h)" command when bit BCTRL is							
	"1".								
Restriction									
		500							
	Status	Availability							
	Normal Mode On, Idle Mode Off, Sleep Out	Yes							
Register Availability	Normal Mode On, Idle Mode On, Sleep Out	N.A.							
	Partial Mode On, Idle Mode Off, Sleep Out	N.A.							
	Partial Mode On, Idle Mode On, Sleep Out	N.A.							
	Sleep In	Yes							
	Status	Default Value							
Default Value	Power On Sequence	00h							
	S/W Reset	00h							
	H/W Reset	00h							



## (53h) WRCTRLD: Write CTRL Display

Address	53h			Access Attribute				W	
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	0	0	BCTRL	0	DD	BL	0	0	00h

- This command is used to control the "LEDPWM" pin, dimming function for CABC.

BCTRL: Turn On / Off the brightness control block with the dimming effect.

About the register "LEDPWPOL", please refer to the register "ABC\_CTRL2"

BCTRL	LEDPWPOL	LEDPWM Pin Final State	Backlight Final State
0	0	Keep "LOW" (0% PWM Duty) (Default)	OFF
1	0	PWM Output (High level is duty)	ON
0	1	Keep "HIGH" (0% PWM Duty)	OFF
1	1	Inversed PWM Output (Low level is duty)	ON

Description

DD: Enable / Disable dimming function only for CABC.

DD	CABC Dimming Function				
0	Disabled				
	Enabled (Default)				

BL: Turn On/Off the backlight control without dimming effect.

BL	Backlight Control
0	OFF (Default)
1	ON

When BL bit change from '1' to '0', backlight is turned off without gradual dimming, even if dimming-on (DD = '1') are selected.

Dimming function is adapted to the brightness registers for display when bit BCTRL is changed at DD=1, e.g. BCTRL:  $0 \rightarrow 1$  or  $1 \rightarrow 0$ 

Restriction

Register Availability

Status	Availability
Normal Mode On, Idle Mode Off, Sleep Out	Yes
Normal Mode On, Idle Mode On, Sleep Out	N.A.
Partial Mode On, Idle Mode Off, Sleep Out	N.A.
Partial Mode On, Idle Mode On, Sleep Out	N.A.
Sleen In	Yes

Default Value

Status	Default Value		
Power On Sequence	00h		
S/W Reset	00h		
H/W Reset	00h		

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#### (54h) RDCTRLD: Read CTRL Display

Address	54h			Access Attribute				R	
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	0	0	BCTRL	0	DD	BL	0	0	00h

- This command is used to "read" the setting status of "LEDPWM" pin, dimming function for CABC.

**BCTRL**: Turn On / Off the brightness control block with the dimming effect.

About the register "LEDPWPOL", please refer to the register "ABC\_CTRL02"

BCTRL	LEDPWPOL	LEDPWM Pin Final State	Backlight Final State
0	0	Keep "LOW" (0% PWM Duty) (Default)	OFF
1	0	PWM Output (High level is duty)	ON
0	1	Keep "HIGH" (0% PWM Duty)	OFF
1	1	Inversed PWM Output (Low level is duty)	ON

DD: Enable / Disable dimming function only for CABC.

Description

DD	CABC Dimming Function
0	Disabled
1	Enabled (Default)

BL: Turn On/Off the backlight control without dimming effect.

BL	Backlight Control				
0	OFF (Default)				
1	ON				

When BL bit change from '1' to '0', backlight is turned off without gradual dimming, even if dimming-on (DD = '1') are selected.

Dimming function is adapted to the brightness registers for display when bit BCTRL is changed at DD=1, e.g. BCTRL:  $0 \rightarrow 1$  or  $1 \rightarrow 0$ 

Restriction

Register Availability

Status	Availability
Normal Mode On, Idle Mode Off, Sleep Out	Yes
Normal Mode On, Idle Mode On, Sleep Out	N.A.
Partial Mode On, Idle Mode Off, Sleep Out	N.A.
Partial Mode On, Idle Mode On, Sleep Out	N.A.
Sleep In	Yes

**Default Value** 

Status	Default Value
Power On Sequence	00h
S/W Reset	00h
H/W Reset	00h

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#### (55h) WRPWRSAVE: Write Power Save

Address		5	5h			Access	w		
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	IMA	AGE_ENHA	NCEMENT[:	3:0]	0	0	CABC_C	OND[1:0]	00h

- This command is used to set parameters for image content based adaptive brightness control and image enhancement level control functionality.
- There is possible to use 4 different modes for content adaptive image functionality, which are defined on a table below.

CABC_CC	OND[1 : 0]	Function				
0	0	Off (Default)				
0	1	User Interface Image (UI-Mode)				
1	011	Still Picture Image (Still-Mode)				
1		Moving Image (Moving-Mode)				

- The NT35596 provides 4 different Image Enhancement (IE) technologies that include Smart Contrast, Vivid Color, Smart Color and Edge Enhancement. The three sets for IE Low/Medium/High level can be selected by IMAGE\_ENHANCE[3:0] as below table. User can define each IE level value of these four IE technologies

independently in "CMD2 Page2" and

these registers in below table can also be programmed in MTP.

Description

The NT35596 also provides three Sunlight Readability Enhancement (SRE) levels to enhance IE function in outdoor

Each SRE level also can be set independently in "CMD2 Page 2" Registers and these registers in below table can also be programmed in MTP.

IMA	IMAGE_ENHANCEM ENT[3:0]		IE Level	Smart Contrast	Vivid Color	Smart Color	Edge Enhancement	
0	0	0	0					
1	0	0	0	IE_Low	LEVEL_01	LEVEL01	RATIO_SEL01	COEFF_01
1	0	0	1	IE_Medium	LEVEL_02	LEVEL02	RATIO_SEL02	COEFF_02
1	0	1	1	IE_High	LEVEL_03	LEVEL03	RATIO_SEL03	COEFF_03
0	1	0	0	SRE_Low	LEVEL_01	LEVEL01	RATIO_SEL01	COEFF_01
0	1	0	1	SRE_Medium	LEVEL_02	LEVEL02	RATIO_SEL02	COEFF_02
0	0 1 1 0		SRE_High	LEVEL_03	LEVEL03	RATIO_SEL03	COEFF_03	
	Oth	ers				N.A. (Reserv	/ed)	

- This register is synchronized with V-sync by internal circuit.

Restriction

- Smart Contrast Function is not available in 3D mode.



	Status Avai	ability		
	Normal Mode On, Idle Mode Off, Sleep Out	′es		
Register Availability	Normal Mode On, Idle Mode On, Sleep Out	.A.		
	Partial Mode On, Idle Mode Off, Sleep Out	.A.		
	Partial Mode On, Idle Mode On, Sleep Out	.A.		
	Sleep In	Yes		
		1		
	Status Default Value	\\		
Default Value	Power On Sequence 00h			
	S/W Reset 00h	/ // // //		
	H/W Reset 00h			

#### (56h) RDPWRSAVE: Read Power Save

Address		56	Sh		Access Attribute				R
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	IMA	AGE_ENHA	NCEMENT[	3:0]	0	0	CABC_C	OND[1:0]	00h

- This command is used to "read" the CABC operation mode and image enhanced level.
- There is possible to use 4 different modes for content adaptive image functionality, which are defined on a table below.

CABC_C	OND[1:0]	Function
0	0	Off (Default)
0	1	User Interface Image (UI-Mode)
1	0	Still Picture Image (Still-Mode)
1	~ N	Moving Image (Moving-Mode)

- Image Enhancement (IE) and Sunlight Readability Enhancement (SRE) levels are read by IMAGE\_ENHANCEMENT [3:0] as below table.

Description

11										
				IE Level	Smart	Vivid	Smart Color	Edge		
	IMAGE	IMAGE_ENHANCEMENT[3:0]			IL Level	Contrast	Color	Siliali Coloi	Enhancement	
/	0	0 0 0			IE OFF					
	1	0	0	0	IE_Low	LEVEL_01	LEVEL01	RATIO_SEL01	COEFF_01	
	M	0	0		IE_Medium	LEVEL_02	LEVEL02	RATIO_SEL02	COEFF_02	
\		9	1	1	IE_High	LEVEL_03	LEVEL03	RATIO_SEL03	COEFF_03	
	0	1	0	0	SRE_Low	LEVEL_01	LEVEL01	RATIO_SEL01	COEFF_01	
	0	1	0	1	SRE_Medium	LEVEL_02	LEVEL02	RATIO_SEL02	COEFF_02	
	0	1	1	0	SRE_High	LEVEL_03	LEVEL03	RATIO_SEL03	COEFF_03	
		Oth	ners		N.A. (Reserved)					

Restriction

Register Availability

Status	Availability
Normal Mode On, Idle Mode Off, Sleep Out	Yes
Normal Mode On, Idle Mode On, Sleep Out	N.A.
Partial Mode On, Idle Mode Off, Sleep Out	N.A.
Partial Mode On, Idle Mode On, Sleep Out	N.A.
Sleep In	Yes

Default Value

Status	Default Value				
Power On Sequence	00h				
S/W Reset	00h				
H/W Reset	00h				

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# (5Eh) WRCABCMB: Write CABC Minimum Brightness

Address	5Eh				Access Attribute				W
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1		CMB[7:0]							

	- This command is used to set the minimu	um brightness value of the display for CABC function.							
Description	00h value means the lowest brightness fo	or CABC and FFh value means the highest brightness for CABC.							
Restriction									
	Status	Availability							
	Normal Mode On, Idle Mode Off,	Sleep Out Yes							
Register Availability	Normal Mode On, Idle Mode On,	Sleep Out N.A.							
	Partial Mode On, Idle Mode Off,	Sleep Out N.A.							
	Partial Mode On, Idle Mode On,	Sleep Out N.A.							
n M	Sleep In	Yes							
	Status	Default Value							
Default Value	Power On Sequence	00h							
A Service Manage	S/W Reset	00h							
	H/W Reset	00h							



# (5Fh) RDCABCMB: Read CABC Minimum Brightness

Address	5Fh				Access Attribute				R
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1		CMB[7:0]							

	- Thi	- This command is used to "read" the minimum brightness value of the display for CABC function.								
Description										
	00h	value means the lowest brightness for	CABC and FFh value means the highest brightness for CABC.							
Restriction	-									
		Status	Availability							
		Normal Mode On, Idle Mode Off, Sl	leep Out Yes							
Register Availability		Normal Mode On, Idle Mode On, S	leep Out N.A.							
		Partial Mode On, Idle Mode Off, SI	eep Out N.A.							
		Partial Mode On, Idle Mode On, Sl	eep Out N.A.							
	25	Sleep In	Yes							
n M										
		Status	Default Value							
		Power On Sequence	00h							
Default Value	$\mathbb{Z}_{n}$	S/W Reset	00h							
11 -	$\mathbb{N}$	H/W Reset	00h							
· ·	//									

#### (A1h) RDDDBS: Read DDB Start

Address		A	lh			R				
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value	
Parameter 1		SID[7 : 0]								
Parameter 2		SID[15 : 8]								
Parameter 3		MID[7:0]								
Parameter 4				MID[1	5 : 8]				N/A	
Parameter 5		RID[7 : 0]								
Parameter 6		RID[15 : 8]								
Parameter 7			-	FI	-h	75			FFh	

- This command returns supplier identification and display module model / revision information. Note: This information is "not" the same what "Read ID1 (DA00h)", "Read ID2 (DB00h)" and "Read ID3 (DC00h)" commands are returning. Note: Parameter 7 is an "Exit Code", this means that there is no more data in the DDB block. This read sequence can be interrupted by any command and it can be continued by "Read DDB Continue (A800h)" command when the first parameter, what has been transferred, is the parameter, which has not been Description sent e.g. RDDDBS => 1st parameter has been sent => 2nd Parameter has been sent => interrupt => RDDDBC > 3rd parameter of the RDDDBS has been sent. Note: SID[15:0]: MIPI member ID number MID[15:0]: Module ID RID[15:0]: Revision ID Restriction Status **Availability** Normal Mode On, Idle Mode Off, Sleep Out Yes N.A. Normal Mode On, Idle Mode On, Sleep Out **Register Availability** Partial Mode On, Idle Mode Off, Sleep Out N.A. Partial Mode On, Idle Mode On, Sleep Out N.A. Yes Sleep In



F	Parameter 1~6:						
	Status	Default Value					
	Power On Sequence	N/A					
	S/W Reset	N/A					
	H/W Reset	N/A					
Default Value	arameter 7:						
	Status	Default Value					
	Power On Sequence	FFh					
	S/W Reset	FFh					
	H/W Reset	FFR					
	,						



# (A8h) RDDDBC: Read DDB Continue

Address		A	3h			R					
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value		
Parameter 1		SID[7:0]									
Parameter 2		SID[15 : 8]									
Parameter 3		MID[7 : 0]									
Parameter 4				MID[	15 : 8]				N/A		
Parameter 5				RID[	7 : 0]			۲	N/A		
Parameter 6		RID[15 : 8]									
Parameter 7		FFh									
					255			11 -			

			415								
Description	(R Ot	- A read_DDB_start (RDDDBS) command should be executed at least once before a read_DDB_continue  (RDDDBC) command to define the read location.  Otherwise, data read with a read_DDB_continue command is undefined.  Note: (1) Parameter 7 is an "Exit Code", this means that there is no more data in the DDB block.  (2) for use example:     Step 1. HW Reset.     Step 2: write 0x11, set sleep out mode.     Step 3: set max. return packet size =5.     Step 4. Read 0x41, Return 5 bytes. Return SIDI7:01. SIDI15:81, MIDI7:01. MIDI15:81, RIDI7:01.									
	Step 4. Read 0xA1, Return 5 bytes. Return SID[7:0], SID[15:8], MID[7:0], MID[15:8], RID[7:0] Step 5. Read 0xA8, DDI return 2 bytes (RID[15:8], 0xFF)										
Restriction	1/5	- SPI don't support continue read, only supports completely read.									
1											
	17	Status		Availability							
		Normal Mode On, Idle Mode Off,	Sleep Out	Yes							
Register Availability		Normal Mode On, Idle Mode On,	Sleep Out	N.A.							
		Partial Mode On, Idle Mode Off,	Sleep Out	N.A.							
		Partial Mode On, Idle Mode On,	Sleep Out	N.A.							
		Sleep In		Yes							
	Pa	rameter 1~6:									
		Status		Default Value							
		Power On Sequence		N/A							
		S/W Reset		N/A							
		H/W Reset		N/A							
Default Value	Pa	rameter 7:									
		Status		Default Value							
		Power On Sequence		FFh							
		S/W Reset		FFh							
		H/W Reset		FFh							

## (AAh) RDFCS: Read First Checksum

Address	AAh				Access Attribute				R
Parameter	D[7]	D[7] D[6] D[5] D[4]				D[2]	D[1]	D[0]	Default Value
Parameter 1	FCS7	FCS6	FCS5	FCS4	FCS3	FCS2	FCS1	FCS0	00h

Description	- This comma	nd returns the first checksum what has	been calculated from System function registers and	d the						
Boothpaon	frame memo	ry after the write access to those regist	ers and/or frame memory has been done.							
	(1) It will be no	ecessary to wait 150 ms after there is	he last write access on System function registers be	efore						
Restriction	there can r	there can read this checksum value.								
		0.1								
		Status	Availability							
	Norma	al Mode On, Idle Mode Off, Sleep Out	Yes							
Register Availability	Norma	al Mode On, Idle Mode On, Sleep Out	N.A.							
	Partia	Partial Mode On, Idle Mode Off, Sleep Out N.A.								
	Partia	Mode On, Idle Mode On, Sleep Out	N.A.							
	PISW	Sleep In Yes								
	7 -	Status	Default Value							
Default Value	$n \cap n$	Power On Sequence	00h							
11 0		S/W Reset	00h							
\		H/W Reset	00h							

# (ABh) MIPI Error Report

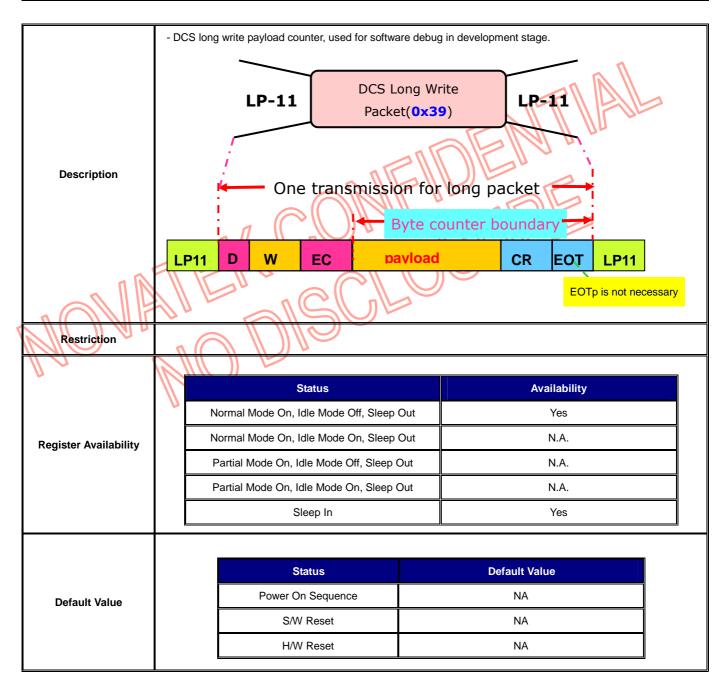
Address	ABh				Access Attribute				R
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	AWER15	AWER14	AWER13	AWER12	AWER11	AWER10	AWER9	AWER8	NA
Parameter 2	AWER7	AWER6	AWER5	AWER4	AWER3	AWER2	AWER1	AWER0	NA

	- Peripheral sou	rced MIPI error report for software debu	ug in development stage.				
Description	- It is an alternat	is an alternative way to use DCS short read packet (with 2 parameters) for error report readout besides of					
	DSI packet type	e 02h					
Restriction							
		Status	Availability				
	Normal	Mode On, Idle Mode Off, Sleep Out	Yes				
Register Availability	Normal	Normal Mode On, Idle Mode On, Sleep Out N.A.					
g.c.c. /a,	Partial	Mode On, Idle Mode Off, Sleep Out	N.A.				
	Partial	Partial Mode On, Idle Mode On, Sleep Out N.A.					
n M		Sleep In	Yes				
	711	also be					
		Status	Default Value				
Default Value	((-))/(2)	Power On Sequence	NA				
		S/W Reset	NA				
	V	H/W Reset	NA				



# (ACh) DCS long write payload counter

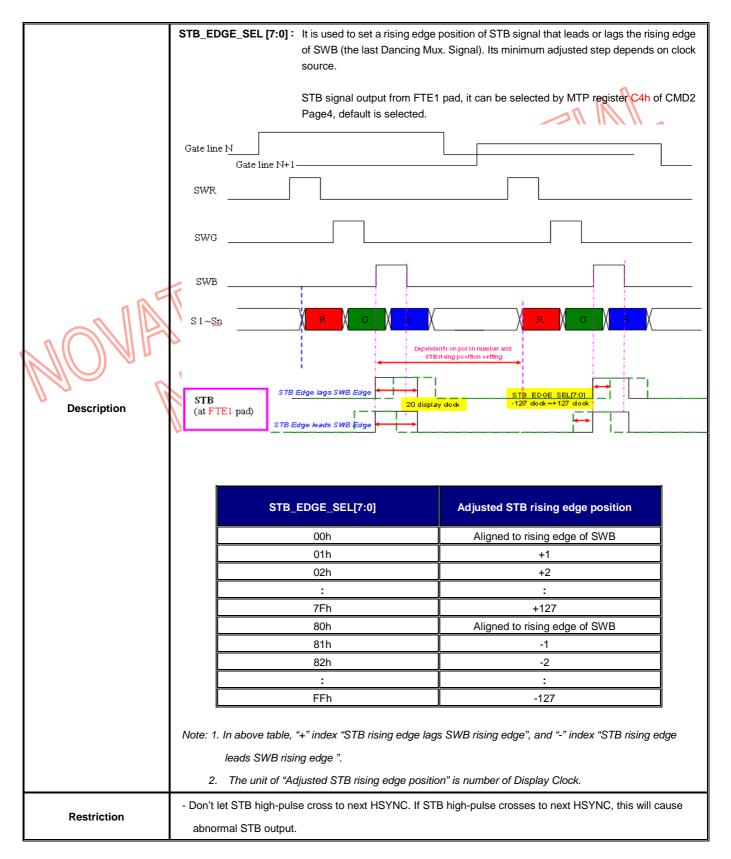
Address	ACh				Access Attribute				R
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	LPa15	LPa14	LPa13	LPa12	LPa11	LPa10	LPa9	LPa8	NA
Parameter 2	LPa7	LPa6	LPa5	LPa4	LPa3	LPa2	LPa1	LPa0	NA





#### (AEh) STB EDGE POSITION

Address	AEh				Access Attribute				R
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1		STB_EDGE_SEL[7:0]						00h	





Register Availability	Status	Availability
Default Value	Power On Sequence S/W Reset H/W Reset	Default Value  00h  00h  00h
NOVA	IEA CON	



## (AFh) RDCCS: Read Continue Checksum

Address	AFh				Access Attribute				R
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	CCS7	CCS6	CCS5	CCS4	CCS3	CCS2	CCS1	CCS0	00h

	- This command returns the continue	e checksum what has been calculated continuously after the first						
Description	checksum has calculated from Syster	em function registers and the frame memory after the write access to						
	those registers and/or frame memory l	has been done.						
	(1) It will be necessary to wait 300 ms after there is the last write access on System function registers before							
Restriction	there can read this checksum value in	there can read this checksum value in the first time.						
	Status	Availability						
	Normal Mode On, Idle Mode Off,	f, Sleep Out Yes						
Register Availability	Normal Mode On, Idle Mode On,	n, Sleep Out N.A.						
	Partial Mode On, Idle Mode Off,	Sleep Out N.A.						
	Partial Mode On, Idle Mode On, Sleep Out N.A.							
	Sleep In	Yes						
	Status	Default Value						
Default Value	Power On Sequence	nce 00h						
	S/W Reset	00h						
	H/W Reset	00h						
		-						



## (BAh) SET\_MIPI\_LANE

Address		В	Ah		Access Attribute				R
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	0	0	0	0	0	0	DSI_LA	NE[1:0]	03h

	- MIPI data lane number selection.	
	DSI_LANE[1:0]	Function Description
	00	Reserved
Description	01	MIPI DSI with 2 lanes
	10	MIPI DSI with 3 lanes
	11	MIPI DSI with 4 lanes
Restriction		
Register Availability	Normal Mode On, Idle Mod Normal Mode On, Idle Mod Partial Mode On, Idle Mod Partial Mode On, Idle Mod Sleep In	le On, Sleep Out N.A. e Off, Sleep Out N.A.
	Status	Default Value
Default Value	Power On Sequence	03h
	S/W Reset	N.A.
	H/W Reset	03h
	H/W Reset	03h

# (BCh) 3D-Barrier Ctrl:

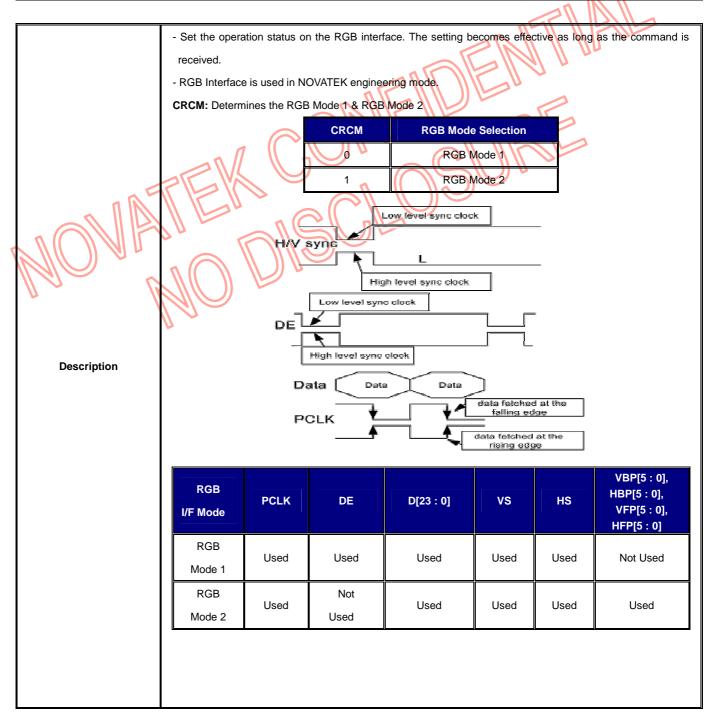
Address	BCh					Access Attribute			
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	0	0	EN_PORT RAIT	EN_3D	0	0	0	0	00h

	- EN_3D / EN_I	PORTRAIT : 3D ba	arrier function selection					
		EN_3D	EN_PORTRAIT	Function				
Description		0	0	3D Disable (Default)	\			
Description		1	0	3D Landscape View				
		1	1	3D Portrait View				
Restriction	- Bit "EN_3D"	must be enabled a	after sleep-out sequence	e and be disabled before sleep-in sequ	ence.			
		Status		Availability				
	Normal	Mode On, Idle Mo	de Off, Sleep Out	Yes				
Register Availability	Normal	Mode On, Idle Mo	de On, Sleep Out	N.A.				
	Partial	Mode On, Idle Mod	de Off, Sleep Out	N.A.				
	Partial	Mode On, Idle Mod	de On, Sleep Out	N.A.				
		Sleep In		Yes				
	1410							
	11 0	Sta	atus	Default Value				
Default Value		Power On	Sequence	00h				
		S/W	Reset	00h				
		H/W	Reset	00h				



# (D2h~D6h) RGBMIPICTRL: RGB-MIPI-Video-Mode Signal Control

Address		38	3h		Access Attribute				R/W
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
D2h	0	CRCM	0	0	DP	EP	HSP	VSP	03h
D3h	0	0	VBP5	VBP4	VBP3	VBP2	VBP1	VBP0	02h
D4h	0	0	VFP5	VFP4	VFP3	VFP2	VFP1	VFP0	04h
D5h	0	0	HBP5	HBP4	HBP3	HBP2	HBP1	HBP0	04h
D6h	0	0	HFP5	HFP4	HFP3	HFP2	HFP1	HFP0	04h







DP / EP / HSP / VSP: Clock polarity set for RGB Interface

Symbol	Name	Clock Polarity Set For RGB Interface				
DP	PCLK Polarity Set	'0' = Data fetched at the rising edge				
DF	FOLK Folanty Set	'1' = Data fetched at the falling edge				
EP	DE Polarity Set	'0' = High enable for RGB interface				
EF.	DE Polanty Set	'1' = Low enable for RGB interface				
HSP	Hayna Dalarity Cat	'0' = High level sync clock				
ПЭР	Hsync Polarity Set	'1' = Low level sync clock				
) (OD	Voyage Delevity Cet	'0' = High level sync clock				
VSP	Vsync Polarity Set	'1' = Low level sync clock				

VBP[5:0], VFP[5:0], HBP[5:0] and HFP[5:0]:

Description

Vertical back and front porch setting are used for MIPI video mode and RGB I/F mode 2.

Horizontal back and front porch setting are used for RGB I/F mode 2.

VBP[5:0]: Number of lines for the back porch of VSYNC.

VFP[5:0]: Number of lines for the front porch of VSYNC.

HBP[5:0]: Number of clock for the back porch of HSYNC.

HFP[5:0]: Number of clock for the front porch of HSYNC.



	VBP[5:0]	Back Porch Line Number	VFP[5:0]	Front Porch Line Number	HBP[5:0]	Back Porch Pixel clocks	HFP[5:0]	Front Porch
	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved
	:	:	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved
	:	:	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved
	02d	2	04d	4	04d	4	04d	4
Description	03d	3	05d	5	05d	5	05d	5
Description	:	:	:	:	:	:	:	:
	:	(STEP 1)	:	(STEP 1)	:	(STEP 1)	:	(STEP 1)
	:	:	:	:	:	:	:	:
	61d	61	61d	61	61d	61	61d	61
	62d	62	62d	62	62d	62	62d	62
	63d	63	63d	63	63d	63	63d	63
	Note: VBP >=	2 and VFP>=4.						
Restriction								
		n (	Status		Availability			
	Norm	nal Mode On J	dle Mode Off.	Sleep Out		Ye	s	

Register Availability

Status	Availability
Normal Mode On, Idle Mode Off, Sleep Out	Yes
Normal Mode On, Idle Mode On, Sleep Out	N.A.
Partial Mode On, Idle Mode Off, Sleep Out	N.A.
Partial Mode On, Idle Mode On, Sleep Out	N.A.
Sleep In	Yes



D2h:

Status	Default Value	Note
Power On Sequence	03h	CRCM = '0' (RGB Mode 1)
H/W Reset	03h	DP = '0', EP = '0', HSP = '1' (Low Level),
S/W Reset	03h	VSP = '1' (Low Level)

**Default Value** 

D3h ~ D6h:

Status	Default Value							
Jiatus	VBP	VFP	НВР	HFP				
Power On Sequence	02h	04h	04h	04h				
H/W Reset	02h	04h	04h	04h				
S/W Reset	02h	04h	04h	04h				



(DAh) RDID1: Read ID1

Address	DAh				Access Attribute				R
Parameter	D[7] D[6] D[5] D[4]				D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	ID17	ID16	ID15	ID14	ID13	ID12	ID11	ID10	N/A

Description	- This read byte identifies the display module's manufacturer.			
Restriction	-			
	Status	Availability		
Register Availability	Normal Mode On, Idle Mode Off, Sleep Out	Yes		
	Normal Mode On, Idle Mode On, Sleep Out	N.A.		
	Partial Mode On, Idle Mode Off, Sleep Out	N.A.		
	Partial Mode On, Idle Mode On, Sleep Out	N.A.		
	Sleep In	Yes		
	Status	Default Value		
Default Value	Power On Sequence	N/A		
Delauit Value	S/W Reset	N/A		
	HW Reset	N/A		
		-		



(DBh) RDID2: Read ID2

Address	DBh				Access Attribute				R
Parameter	D[7] D[6] D[5] D[4]				D[3] D[2] D[1] D[0]			Default Value	
Parameter 1	1	ID26	ID25	ID24	ID23	ID22	ID21	ID20	N/A

	- This read byte is used to track the display m	nodule/driver version.
	It is defined by display supplier and chan-	ges each time a revision is made to the display, material or
Description	ID Byte Value	Version Changes
	80h	
	81h	
	82h	
Restriction		
	Status	Availability
	Normal Mode On, Idle Mode Off, Slee	ep Out Yes
Register Availability	Normal Mode On, Idle Mode On, Slee	ep Out N.A.
	Partial Mode On, Idle Mode Off, Slee	ep Out N.A.
	Partial Mode On, Idle Mode On, Slee	ep Out N.A.
	Sleep In	Yes
	Status	Default Value
Default Value	Power On Sequence	N/A
	S/W Reset	N/A
	H/W Reset	N/A



(DCh) RDID3: Read ID3

Address	DCh				Access Attribute				R
Parameter	D[7]	D[7] D[6] D[5] D[4]			D[3] D[2] D[1] D[0]			D[0]	Default Value
Parameter 1	ID37	ID36	ID35	ID34	ID33	ID32	ID31	ID30	N/A

Description	- This	s read byte identifies the display module / drive	r.
Restriction	-		
		Status	Availability
Register Availability		Normal Mode On, Idle Mode Off, Sleep Out	Yes
		Normal Mode On, Idle Mode On, Sleep Out	NA U
		Partial Mode On, Idle Mode Off, Sleep Out	N.A.
		Partial Mode On, Idle Mode On, Sleep Out	N:A
		Sleep In	Yes
			C// /// //
	179	Status	Default Value
Default Value		Power On Sequence	N/A
<u> </u>	70	S/W Reset	N/A
	36	H/W Reset	N/A
, ,	$\perp \parallel \parallel$		



## (F3h) MULTIIF: Multi-Interface Function

Address	F3h				Access Attribute				R/W
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	IM_IF_SE L	0	0	0	SECOND_I	F_SEL[1:0]	0	MULTIIF_ EN	80h

	IM_IF_SEL:	To decide the main	IF to access regi	ster. This bit i	s available wh	en IM[2:0] = 000	0b / 010b /		
	(	011b.		•	^				
		IM_IF_SEL			Func	tion			
		0		MIPI VIDI	EO MODE + MI	PI ACCESS REC	SISTER		
		1		MIPI VID	EO MODE + S	ECONDARY IF (	(I2C or		
					SPI) ACCESS	REGISTER			
	MULTIIF_EN :	: Enable or Disable m IM[2:0]=110b.	nulti-interface func	tion by register	r. It's only availa	ble when HW pi	n		
Description		MULTIIF_E	EN		Function				
,,,,,		0		C	only MIPI I/F				
	1 1 20			<b>y</b> M	ulti-IF Enable		1		
	7/11 5						1		
	SECOND_IF_	\\\`\\\		ce to access register when MULTIIF_EN=1. It is only 2:0]=110b. MIPI VIDEO mode is always available.					
			when HW pin IM[2	_		s always availab	ole. ■		
		Primary I/F		Second	ary I/F				
		IM[2:0] = 110b		SECOND_IF_SEL[1:0]					
		MIPI	00b	01b	10b	11b			
			I2C	9-bit SPI	8-bit SPI	N.A.			
Restriction	- Do Not supp	ort two I/F access req	gister simultaneou	sly when Multi	-IF function ena	ble.			
		Status			Availa	bility			
	Norma	al Mode On, Idle Mod	de Off, Sleep Out		Ye	s			
Register Availability	Norma	al Mode On, Idle Mod	de On, Sleep Out		N.A.				
Register Availability	Partia	al Mode On, Idle Mod	e Off, Sleep Out		N.A.				
	Partia	al Mode On, Idle Mod	e On, Sleep Out		N.A	٩.			
		Sleep In			Ye	S			
	<del>                                     </del>								
		Statu	us		Default Value				
Default Value		Power On S	Sequence		80h				
		S/W Re	eset	N.A.					
		H/W Re	eset		80h				
i									

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## (F4h) Novatek ID: Read Novatek ID

Address	F4h			Access Attribute				R	
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	1	0	0	1	0	1	1	0	96h

Description	- This r	read byte identifies the Novatek ID code.	
Restriction	-		
		Status	Availability
		Normal Mode On, Idle Mode Off, Sleep Out	Yes
Register Availability		Normal Mode On, Idle Mode On, Sleep Out	NA UU
		Partial Mode On, Idle Mode Off, Sleep Out	N.A.
		Partial Mode On, Idle Mode On, Sleep Out	N.A.
		Sleep In	Yes
			6/1/1/1/20
	PIL	Status	Default Value
Default Value	1 1	Power On Sequence	90h
Default Value	711.	S/W Reset	90h
	n	H/W Reset	90h
0	VIII A		



## (F5h) IF\_TEST: INTERFACE TEST

Address	F5h			Access Attribute				R/W	
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1		IF_TEST[7:0]					00h		

Description	- This byte is used for interface test.							
Restriction	-							
	Status		Availability					
	Normal Mode On, Idle Mode	e Off, Sleep Out	Yes					
Register Availability	Normal Mode On, Idle Mode	e On, Sleep Out	MA. UU					
	Partial Mode On, Idle Mode	Partial Mode On, Idle Mode Off, Sleep Out N.A.						
	Partial Mode On, Idle Mode	Partial Mode On, Idle Mode On, Sleep Out N.A.						
	Sleep In		Yes					
	Status		Default Value					
	Otatus	IF_TEST[7]	IF_TEST[6:0]					
Default Value	Power On Sequence	00h	00h					
	S/W Reset	00h	No effect					
	H/W Reset	00h	NO effect					

#### (F6h~F7h) EXCK\_CTRL: Display Clock Source Control

Address	F8h				Access Attribute				R/W
Parameter	D[7] D[6] D[5] D[4]				D[3]	D[2]	D[1]	D[0]	Default Value
F6h		EXCK_FREQ[11:8]				0	0	EN_EXCK	50h
F7h				EXCK_F	REQ[7:0]				78h

- EN\_EXCK: Display Clock Source selection.

EN_EXCK	Display Clock Source
0	Display refer to Internal Oscillator
1	Display refer to External Clock

Description

- EXCK\_FREQ[11:0]: When using external clock source for display reference, user must set external oscillator frequency in "EXCK\_FREQ[11:0]". NT35596 can accept the external oscillator frequency range from 9MHz to 40MHz and frequency accuracy can be accepted to 2-digit decimal point. The formula is as below:

 $EXCK\_FREQ[11:0] = 100* f(MHz)$ , "f" is external oscillator frequency in unit "MHz"

Example 1: If external oscillator frequency is 20MHz:

EXCK\_FREQ[11:0] = 100 \* 20 = 2000(Decimal) = 7D0(Hex)

Example 2: If external oscillator frequency is 14.14MHz:

EXCK\_FREQ[11:0] = 100 \* 14.14 = 1414(Decimal) = 586(Hex)

Note: If external oscillator frequency is 14.145, user must use 14.14MHz or 14.15MHz to fill this register.

Restriction

Register Availability

Status	Availability
Normal Mode On, Idle Mode Off, Sleep Out	N.A.
Normal Mode On, Idle Mode On, Sleep Out	N.A.
Partial Mode On, Idle Mode Off, Sleep Out	N.A.
Partial Mode On, Idle Mode On, Sleep Out	N.A.
Sleep In	Yes

Default Value

Status	Defaul	t Value
Status	EXCK_EXCK	EXCK_FREQ[11:0]
Power On Sequence	00h	578h
S/W Reset	00h	578h
H/W Reset	00h	578h



# (F8h) I2C\_SLAVE\_ADDR: I2C Slave Address

Address		F9h			Access Attribute				R/W
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	0		I2C_SLAVE_ADDR[6:0]					00h	

	-Set the slave address of I2C interface.							
	- Default slave address is 00h, and this slave addre	ess always can access register whether this register have						
Description	been filled another slave address or not. It means	that user can use the slave address that you fill into this						
	register to access registers or uses global slave ad	dress 00h to access registers.						
	NT35596 does not support "general call address" function.							
Restriction	- In end-customer terminal (system platform), it can	n Not send "hardware general call" function of standard I2C						
	SPEC. This function will lead NT35596 work abnor	PEC. This function will lead NT35596 work abnormally.						
	Status	Availability						
	Normal Mode On, Idle Mode Off, Sleep Out	Yes						
Register Availability	Normal Mode On, Idle Mode On, Sleep Out	N.A.						
	Partial Mode On, Idle Mode Off, Sleep Out	N.A.						
	Partial Mode On, Idle Mode On, Sleep Out	N.A.						
	Default slave address is 00h, and this slave address always can access register whether this register been filled another slave address or not. It means that user can use the slave address that you fill it register to access registers or uses global slave address 00h to access registers.  - NT35596 does not support "general call address" function.  - In end-customer terminal (system platform), it can Not send "hardware general call" function of stand SPEC. This function will lead NT35596 work abnormally.  Status  Availability  Normal Mode On, Idle Mode Off, Sleep Out  Normal Mode On, Idle Mode On, Sleep Out  N.A.  Partial Mode On, Idle Mode Off, Sleep Out  N.A.	Yes						
	Status	Default Value						
	Ciatus	I2C_SLAVE_ADDR[1:0]						
Default Value	Power On Sequence	00h						
	S/W Reset	00h						
	H/W Reset	00h						

# (F9h) PIXEL\_EXTEN: PIXEL EXTENSION FORMAT

Address		FAh				Access	R/W		
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	0	0	0	0	0	0	PIXEL_EXTEN[1:0]		00h

- This byte is	used for pixel	extension format.				
PIXEL_E	XTEN[1:0]	5-6-5 format	6-6-6 format	8-8-8 format		
		R[7:0] = {R[4:0], R[4:2]}	R[7:0] = {R[5:0], R[5:4]}	R[7:0] = R[7:0]		
00	0b	G[7:0] = {G[5:0], G[5:4]}	G[7:0] = {G[5:0], G[5:4]}	G[7:0] = G[7:0]		
		B[7:0] = {B[4:0], B[4:2]}	B[7:0] = {B[5:0], B[5:4]}	B[7:0] = B[7:0]		
		R[7:0] = {R[4:0], 3'b0}	R[7:0] = {R[5:0], 2'b0}	R[7:0] = R[7:0]		
0	1b	G[7:0] = {G[5:0], 2'b0]}	$G[7:0] = {G[5:0], 2'b0]}$	G[7:0] = G[7:0]		
		$B[7:0] = \{B[4:0], 3'b0\}$	$B[7:0] = {B[5:0], 2'b0}$	B[7:0] = B[7:0]		
		$R[7:0] = \{R[4:0], 3'b111\}$	R[7:0] = {R[5:0], 2'b11}	R[7:0] = R[7:0]		
10	0b /	$G[7:0] = \{G[5:0], 2'b11\}$	$G[7:0] = \{G[5:0], 2'b11\}$	G[7:0] = G[7:0]		
		$B[7:0] = \{B[4:0], 3'b111\}$	B[7:0] = {B[5:0], 2b11}	B[7:0] = B[7:0]		
	1b		N.A.			
	n					
~ 7		Status				
Nor	mal Mode On	, Idle Mode Off, Sleep Out	t Yes			
Nor	mal Mode On	, Idle Mode On, Sleep Out	t N.A.			
Pa	rtial Mode On,	Idle Mode Off, Sleep Out	N.A.			
Pa	rtial Mode On,	Idle Mode On, Sleep Out	N.A.			
		Sleep In	Yes			
		Status	Default Value			
		Status	PIXEL_EXTEN[1:0]			
	Powe	er On Sequence	00h			
		S/W Reset	00h			
		H/W Reset	00h			
	PIXEL_E	PIXEL_EXTEN[1:0]  00b  10b  10b  11b  Normal Mode On. Normal Mode On. Partial Mode On, Partial Mode On,	R[7:0] = {R[4:0], R[4:2]} G[7:0] = {G[5:0], G[5:4]} B[7:0] = {B[4:0], B[4:2]} R[7:0] = {R[4:0], 3'b0} G[7:0] = {G[5:0], 2'b0]} B[7:0] = {B[4:0], 3'b11} B[7:0] = {R[4:0], 3'b111} B[7:0] = {B[4:0], 3'b11} B[7:0] = {B[	PIXEL_EXTEN[1:0]   5-6-5 format   6-6-6 format   R[7:0] = {R[4:0], R[4:2]}   R[7:0] = {R[5:0], R[5:4]}   R[7:0] = {R[5:0], G[5:4]}   R[7:0] = {R[4:0], G[5:0], G[5:4]}   R[7:0] = {R[4:0], B[4:2]}   R[7:0] = {R[5:0], B[5:4]}   R[7:0] = {R[4:0], 3'b0}   R[7:0] = {R[5:0], 2'b0}   R[7:0] = {R[4:0], 3'b0}   R[7:0] = {R[5:0], 2'b0}   R[7:0] = {R[4:0], 3'b11}   R[7:0] = {R[4:0], 3'b11}   R[7:0] = {R[5:0], 2'b11}   R[7:0] = {R[5:	R[7:0] = {R[4:0], R[4:2]}	

## (FBh) RELOAD CMD1

Address	FBh				Access Attribute				R/W
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	0	0	0	0	0	0	0	RELOAD_ CMD1	00h

	RELOAD_CMD1: The RELOAD_C	CMD1 is used to select	t the control value of CMD1.					
	RELOAD_REG	MIPI LANE, STB Function, 3D-related Function						
	0 Rel	eload setting value from MTP or register default value to register						
	1	Don't reload MTP or register default value to register						
Description	<ol> <li>Notes:</li> <li>If the user doesn't program any MTP, these above descript MTP registers default value equal to NT35596 default value as Specification definition.</li> <li>If the user programmed MTP, these above descript registers default value equal to MTP Value after hardwors software reset again.</li> <li>When the NT35596 exit sleep mode, the driver IC will reload MTP or register default value to the above MTP register to change these registers contents.</li> <li>The user can set the RELOAD_CMD1 bit to one to keep current register value by user's software setting the driver IC Exit sleep mode.</li> </ol>							
Restriction								
	Status		Availability					
	Normal Mode On, Idle Mod	de Off, Sleep Out	Yes					
Register Availability	Normal Mode On, Idle Mod	de On, Sleep Out	N.A.					
	Partial Mode On, Idle Mod	le Off, Sleep Out	N.A.					
	Partial Mode On, Idle Mod	le On, Sleep Out	N.A.					
	Sleep In		Yes					
	Status		Default Value					
Default Value	Power On Sequence		00h					
	S/W Reset		00h					
	H/W Reset		00h					

#### (FEh) RD\_CMDSTATUS: Read the Current Register Set

Address		F	Eh			Access	R		
Parameter	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]	Default Value
Parameter 1	0	0	CMD2_P4	CMD2_P3	CMD2_P2	CMD2_P1	CMD2_P0	CMD1	01h

- This command is used for checking the current CMD accessing status, especially when MIPI interface is selected.

**CMD1** = 1, host is accessing registers of CMD1 Set.

CMD2\_P0 = 1, host is accessing registers of CMD2 Page 0.

CMD2\_P1 = 1, host is accessing registers of CMD2 Page1.

CMD2\_P2 = 1, host is accessing registers of CMD2 Page2.

CMD2\_P3 = 1, host is accessing registers of CMD2 Page3.

CMD2\_P4 = 1, host is accessing registers of CMD2 Page4

Description

	0	0	CMD2_P4	CMD2_P3	CMD2_P2	CMD2_P1	CMD2_P0	CMD1	Current Register Set Status
	0	0	0	0	0		0	1	In Command 1
		70	70(	2 (0 )		0	1	0	In the Page 0 of
	10					O .	'	U	Command 2
				0	0	1	0	0	In the Page 1 of
				Ů	O	'	ŭ	U	Command 2
	Alle	0	0	0	1	0	0	0	In the Page 2of
/	U	O	O						Command 2
	0 0		0	1	0	0	0	0	In the Page 3 of
			O						Command 2
	0 0	0	0 1	0	0	0	0	0	In the Page 4 of
		J							Command 2
	Others								Reserved

Restriction

Register Availability

Status	Availability
Normal Mode On, Idle Mode Off, Sleep Out	Yes
Normal Mode On, Idle Mode On, Sleep Out	N.A.
Partial Mode On, Idle Mode Off, Sleep Out	N.A.
Partial Mode On, Idle Mode On, Sleep Out	N.A.
Sleep In	Yes



Default	Value

Status	Default Value				
Power On Sequence	01h				
S/W Reset	01h				
H/W Reset	01h				



NT35596

# (FFh) CMD Page Select

Address	FFh			Access Attribute				w
Parameter	D[7]	D[6]	D[5]	D[4]	D[3] D[2] D[1] D[0]			Default Value
Parameter 1		PAGE_SEL[7:0]						00h

	- This command is used to select page.					
	- PAGE_SEL[7:0] : it defines how to select	a register page	that you want to access.			
	00h → CMD1 is selected	d	5			
	01h → CMD2 Page0 is s	selected	// M 20			
Description	02h → CMD2 Page1 is s	selected				
	03h → CMD2 Page2 is s	selected				
	04h → CMD2 Page3 is s	selected				
	05h → CMD2 Page4 is §	selected				
	Note: When the driver IC received this comm	mand, then the dr	iver IC will enter the register page.			
Restriction		411				
	Status		Availability			
n M	Normal Mode On, Idle Mode Off,	Sleep Out	Yes			
	Normal Mode On, Idle Mode On,	1112	N.A.			
Register Availability	Partial Mode On, Idle Mode Off, S	· · · · · · · · · · · · · · · · · · ·	N.A.			
11 2	Partial Mode On, Idle Mode On, S	Sieep Out				
	Sleep In	<u> </u>				
	Status		Default Value			
Default Value	Power On Sequence		00h			
	S/W Reset		00h			
	H/W Reset		00h			
Restriction	-					
	Status		Availability			
	Normal Mode On, Idle Mode Off,	Sleep Out	Yes			
Register Availability	Normal Mode On, Idle Mode On,	Sleep Out	N.A.			
,	Partial Mode On, Idle Mode Off, S		N.A.			
	Partial Mode On, Idle Mode On, S	Sleep Out	N.A.			
	Sleep In		Yes			



# 7. Electrical Characteristics

## 7.1 ABSOLUTE MAXIMUM RATINGS

ltem	Symbol	Rating	Unit
Supply voltage	VDDI,VDDAM	-0.3 ~ +5.5	V
Supply voltage	VCI-AVSS	- 0.3 ~ <b>+</b> 6.5	V
Driver supply Voltage	AVDD-AVSS	-0.3 ~ +6.5	V
Operating temperature range	TOPR	-30 ~ +75	°C
Storage Temperature range	TSTG	-40 ~ +85	<b>~ 1</b> ℃
Logic Input voltage range	VIN	-0.3 ~ +4	
Logic Output voltage range	VO	-0.3 ~ +4	V
Humidity		5% to 95%	%

NOTE: If the absolute maximum rating of even is one of the above parameters is exceeded even momentarily, the quality of the product may be degraded. Absolute maximum ratings, therefore, specify the values exceeding which the product may be physically damaged. Be sure to use the product within the range of the absolute maximum ratings.



# 7.2 DC CHARACTERISTICS

## 7.2.1 Basic Characteristics

Parameter	Symbol	Conditions		Specification	n	Unit	Notes
Faranieter	Syllibol	Conditions	MIN	TYP	MAX	Unit	Notes
<u> </u>		Power & Operation	Voltage				
Analog Operating voltage	VCI	Operating Voltage	2.5	2.8	4.8	V	Note 1
I/O operating voltage	VDDI	I/O supply voltage	1.65	1.8	3.6	V	Note 1
MIPI Operating voltage	VDDAM	MIPI	1.7	1.8	3.6	V	Note1
Iviii i Operating voltage	VDDAW	Supply voltage	1.7	1.0	3.0	v	Note1
	-	Input / Outpu	ut				
Logic High level input voltage	VIH		0.7VDDI		VDDI	V	Note 1, 2
Logic Low level input voltage	VIL	-	VSS	-	0.3VDDI	V	Note 1, 2
Logic High level output voltage	VOH	IOH = -0.1mA	0.8VDDI	-	VDDI	V	Note 1, 2
Logic Low level output voltage	VOL	IOL = +0.1mA	VSS	-	0.2VDDI	V	Note 1, 2
Logic High level leakage (Except MIPI)	ILIH1	Vin = 0 to VDDI		15	\\1\\1	uA	Note 1, 2
Logic Low level leakage				- 1	H	An	
(Except MIPI)	ILIIL1	Vin = 0 to VDDI	-1		11/21 "	uA	Note 1, 2
Logic High level leakage	ILIH2	Vin = 0 to 1. 3 V			10	μA	
MIPI	ILITIZ	VIII = 0 to 1. 3 V			10	μΑ	
Logic Low level leakage	ILIL2	Vin = 0 to 1, 3 V	-10			<b>1</b> μΑ	
MIPI			777	n n			
Vocabo II	V0014D00	VCOM Operat	li i				
VCOMDC voltage	VCOMDC3	Operating Voltage	-2		+2	V	
		Source Drive	<del>-                                     </del>				
Gamma reference voltage	GVDDP GVDDN	GVDDP <avdd-0.3 GVDDN&gt;AVEE+0.3</avdd-0.3 	-5.25		5.25	V	
11 1/11 11 2	V,dev1	Sout>=+4.2V, Sout<=+0.8V	-5.25	20	- 3 30	mV	
Output deviation voltage	V,dev1	+0.8V <sout<+4.2v< td=""><td></td><td>10</td><td>15</td><td>mV</td><td></td></sout<+4.2v<>		10	15	mV	
V (	V,dev3	Sout>=-0.8V, Sout<=-4.2V		20	30	mV	Note3
	V,dev4	-0.8V <sout<-4.2v< td=""><td></td><td>10</td><td>15</td><td>mV</td><td></td></sout<-4.2v<>		10	15	mV	
Output offset voltage	VOFSET				35	mv	
16/11/		Power generat	ion				
Internal reference voltage	VREF	Operating Voltage		1.2		V	
Power supply for Digital circuit	VDD			1.5		V	
Power supply for MIPI I/F	VP_HSSI			1.5		V	
Analog power	AVDD		4.5		6	V	
Analog power	AVEE		-6		-4.5	V	
LDO output for GVDDP	AVDDR		3		5.5	V	
LDO output for GVDDN	AVEER		-5.5		-3	V	
LDO output for VGH	VGHO	VGH > VGHO + 0.3V	6		14	V	Note 4
LDO output for VGL	VGLO	VGL < VGLO-0.3V	-8.2		-5	V	Note 4
1st Booster voltage	VGH	Operating Voltage	AVDD - VCL		2xAVDD - AVEE	V	
2nd Booster voltage	VGL	Operating Voltage	2*AVEE –V CI		AVEE – VCI	V	
3rd Booster voltage or LDO output	VCL	Operating Voltage from pump Circuit or LDO	-3.3		-2.5	V	
Oscillator tolerance	OSC	25℃	-5	-	5	%	
Oscillator tolerance	OSC	75℃~-30℃	-8	-	8	%	

Note 1: VDDI=1.65 to 3.6V, VCI= 2.5 to 4.8V, VDDAM=1.7 to 3.6 V, AVSS=VSS=0V, Ta=-30 to 75  $^{\circ}$ C (to +85  $^{\circ}$ C no damage)

Note 2: When the measurements are performed with LCD module, Measurement Points are like below.

CSX, RDX, WRX, D[23:0], DCX, RESX, SCL, IM[2:0] and Test pins

Note 3: Source channel loading= 40pF/channel

Note 4: VCI=3.3V, Ta=25 °C, No load;



# 7.2.2 Current Consumption

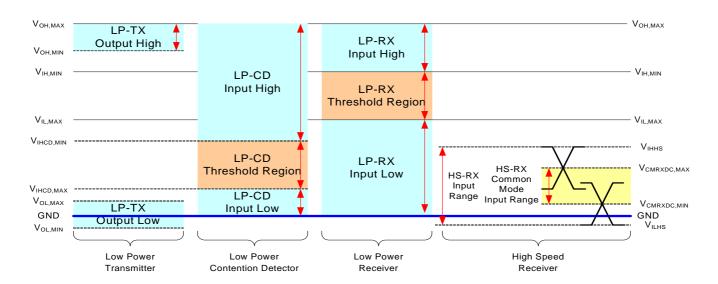
					Specif	ication			
Parameter	Symbol	Conditions	N	IIN	T	/P	M	AX	Unit
			VCI	VDDI	VCI	VDDI	VCI	VDDI	
Sleep in mode (Note 1)	I <sub>SPA</sub>	VDDI = VDDAM = 1.8V,							
Two power mode		VCI = 3V , 1920 lines,		-	TBD	TBD	TBD	TBD	uA
(VCI + VDDI)		Ta = 25°							
Sleep in mode (Note 1)	I <sub>SPA</sub>	VDDI = VDDAM = 1.8V,							
Two power mode		AVDD = 5.6V , 1920 lines,		-	TBD	TBD	TBD	TBD	uA
(VDDI + AVDD)		Ta = 25°					n [	M	
Sleep in mode (Note 1)	I <sub>SPA</sub>	VDDI = VDDAM = 1.8V,				15-15	'\\\		
Three power mode		AVDD = 5.6V, AVEE =		-	M.	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	TDD	TDD	
(VDDI + AVDD + AVEE)		-5.6V, 1920 lines,		ジルド	TBD	TBD	TBD	TBD	uA
		Ta = 25°	$\mathbb{N}$	)) \\	<b></b> u				
Sleep in mode (Note 1)	I <sub>SPA</sub>	VDDI = VDDAM = 1.8V,	11/			376	3		
Four power mode		VCI = 3V , AVDD = 5.6V,		- n		以い	T00	TDD	
(VCI + VDDI + AVDD + AVEE)	$\mathbb{R}^{n}$	AVEE = -5.6V, 1920 lines,		$\overline{\mathscr{I}}$	TBD	TBD	TBD	TBD	uA
		Ta = 25°		$\mathcal{O}(C)$					
Deep standby mode (Note 1)	lost	VDDI = VDDAM = 1.8V,							
Two power mode		VCI = 3V , Ta = 25°		=	0.	1	5	;	uA
(VCI + VDDI)									
Deep standby mode (Note 1)	I <sub>DST</sub>	VDDI = VDDAM = 1.8V,							
Two power mode		AVDD = 5.6V ,		-	0	.1		5	uA
(VDDI + AVDD)		Ta = 25°							
Deep standby mode (Note 1)	I <sub>DST</sub>	VDDI = VDDAM = 1.8V,							
Three power mode		AVDD = 5.6V, AVEE =		-	0	.1		5	uA
(VDDI + AVDD + AVEE)		-5.6V, Ta = 25°							
Deep standby mode (Note 1)	I <sub>DST</sub>	VDDI = VDDAM = 1.8V,							
Four power mode		VCI = 3V , AVDD = 5.6V,		-	0	.1		5	uA
(VCI + VDDI + AVDD + AVEE)		AVEE = -5.6V, Ta = 25°							

Note. For MIPI interface, the sleep in and deep standby current is only in ULPS mode.



## 7.2.3 MIPI DC Characteristics

Symbol	Parameter	Min	Тур	Max	Unit
	Power and Operation Voltage t	or MIPI Receiver			•
VDDAM	Power supply voltage for MIPI RX	1.7	1.8	3.6	V
VP_HSSI	High speed / Low power mode operating voltage		1.2		V
	MIPI Characteristics for High S	peed Receiver			
VILHS	Single-ended input low voltage	-40			mV
VIHHS	Single-ended input high voltage			460	mV
VCMRXDC	Common-mode voltage	70		330	m∨
ZID	Differential input impedance	80	100	125	ohm
VOD	HS transmit differential voltage ( VOD=VDP-VDN)	140	200	250	m∨
V <sub>IDTH</sub>	Different input high threshold			70	mV
$V_{IDTL}$	Different input low threshold	-70			mV
$V_{TERM-EN}$	Single-ended threshold for HS termination enable	1/1/1	Π	450	mV
	MIPI Characteristics for Lov	v Power Mode	2     C		
VI	Pad signal voltage range	-50		1350	mV
VGNDSH 1	Ground shift	-50		50	mV
VIE	Logic 0 input threshold	0.0		550	mV
VIH VI	Logic 1 input threshold	880		VDDAM	mV
VHYST	Input hysteresis	25			mV
VOL	Output low level	-50		50	mV
VOH	Output high level	1.1	1.2	1.3	V
ZOLP	Output impedance of Low Power Transmitter	80	100	125	ohm
VIHCD,MAX	Logic 0 contention threshold	0.0		200	mV
VILCD,MIN	Logic 1 contention threshold	450		VDDAM	mV

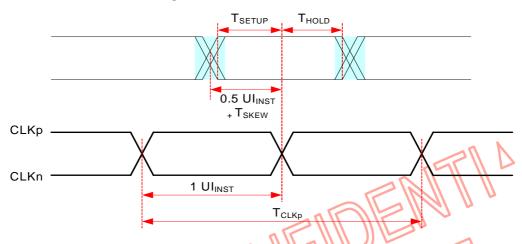




## 7.3 AC CHARACTERISTICS

#### 7.3.1 MIPI Interface Characteristics

High Speed Data Transmission: Data-Clock Timing



Parameter	Symbol	Min	Тур	Max	Units	Notes
UI instantaneous	Ul <sub>INST</sub>	1		12.5	ns	1,2,10
Data to Clock Skew [measured at tansmitter]	T <sub>SKEW</sub> [TX]	-0.15		0.15	UI <sub>INST</sub>	3
	I SKEW[1]	-0.2		0.2	UI <sub>INST</sub>	4
Data to Clock Setup Time [measured at receiver]	T <sub>SETUP</sub> [RX]	-0.15		0.15	UI <sub>INST</sub>	5
Para o occino prime (measures et cestro)	SETUPLICAL	-0.2		0.2	UI <sub>INST</sub>	6
Data to Clock Hold Time [measured at reciever]	T <sub>HOLD</sub> [RX]	-0.15		0.15	UI <sub>INST</sub>	5
Butte to check field fill the filestated at Editorell	HOLD[TOX]	-0.2		0.2	UI <sub>INST</sub>	6
		100			ps	9
20% - 80% rise time and fall time	t <sub>R</sub> / t <sub>F</sub>			0.3	UI <sub>INST</sub>	7
				0.35	UI <sub>INST</sub>	8

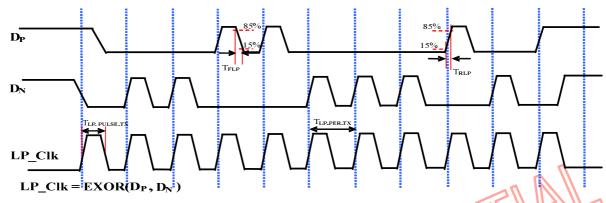
#### Note:

- 1. This value corresponds to a minimum 80 MHz data rate.
- 2. The minimum UI shall not be violated for any single bit period, i.e., any DDR half cycle within a data burst.
- 3. Total silicon and package delay budget of 0.3\* UIINST when D-PHY is supporting maximum data rate = 1Gbps.
- 4. Total silicon and package delay budget of 0.4\* UIINST when D-PHY is supporting maximum data rate > 1Gbps.
- 5. Total setup and hole window for receiver of 0.3\* UIINST when D-PHY is supporting maximum data rate = 1Gbps.
- 6. Total setup and hole window for receiver of 0.4\* UIINST when D-PHY is supporting maximum data rate > 1Gbps.
- 7. Applicable when operating at HS bit rates ≤ 1 Gbps (UI ≥ 1 ns).
- 8. Applicable when operating at HS bit rates > 1 Gbps (UI < 1 ns).
- 9. Applicable for all HS bit rates. However, to avoid excessive radiation, bit rates ≤ 1 Gbps (UI ≥ 1 ns), should not use values below 150 ps.
- 10. For MIPI speed limitation:
  - [1] Per lane bandwidth is 1Gbps,
  - [2] Total Bit Rate: 4Gbps for 8-8-8; 3Gbps for 6-6-6; and 2.67Gbps for 5-6-5.

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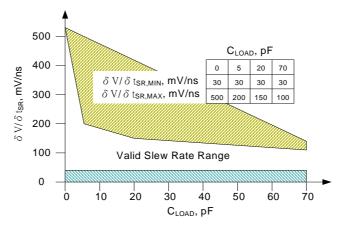
#### LP Transmission AC Specification



						11 11 2 1	
Para	nmeter	Symbol	Min	Тур	Max	Units	Notes
15%-85% rise	time and fall time	$T_{RLP}/T_{FLP}$			25	ns	1
30%-85% rise	time and fall time	T <sub>REOT</sub>	المادر		35	ns	1,5,6
Pulse width of the LP exclusive-OR clock	First LP exclusive-OR clock pulse after STOP state or last pulse before stop state	T <sub>LP</sub> :pulse.tx	40			ns	4
	All other pulses		20	7	ランド	ns	4
Period of the LP	exclusive-OR clock	T <sub>LP-PER-TX</sub>	90		$    /  _L$	ns	
Slew Rate@	$\mathbb{Q} C_{LOAD} = 0 pF$	2	30		500	mV/ns	1,2,3,7
Slew Rate@	C <sub>LOAD</sub> = 5pF	ōV/ōt <sub>SR</sub>	30		200	mV/ns	1,2,3,7
Slew Rate@	2 C <sub>LOAD</sub> = 20pF	OV/Otsr	30		150	mV/ns	1,2,3,7
Slew Rate@	2 C <sub>LOAD</sub> = 70pF	と	30		100	mV/ns	1,2,3,7
Load Ca	apacitance	C <sub>LOAD</sub>			70	pF	1

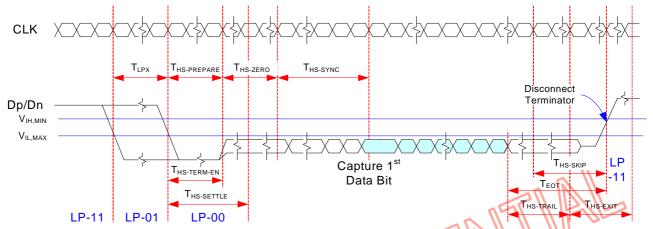
Note:

- 1. CLOAD includes the low-frequency equivalent transmission line capacitance. The capacitance of TX and RX are assumed to always be <10pF. The distributed line capacitance can be up to 50pF for a transmission line with 2ns delay.
- 2. When the output voltage is between 15% and below 85% of the fully settled LP signal levels.
- 3. Measured as average across any 50 mV segment of the output signal transition.
- 4. This parameter value can be lower then TLPX due to differences in rise vs. fall signal slopes and trip levels and mismatches between Dp and Dn LP transmitters. Any LP exclusive-OR pulse observed during HS EoT (transition from HS level to LP-11) is glitch behavior.
- 5. The rise-time of TREOT starts from the HS common-level at the moment the differential amplitude drops below 70mV, due to stopping the differential drive.
- 6. With an additional load capacitance CCM between 0-60pF on the termination center tap at RX side of the Lane.
- 7. This value represents a corner point in a piecewise linear curve as bellowed.





#### **High-Speed Data Transmission in Bursts**

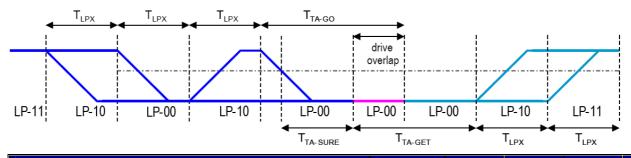


Parameter	Symbol	Min	Тур	Max	Units
Time to drive LP-00 to prepare for HS transmission	T <sub>HS-PREPARE</sub>	40+4UI	7	85+6UI	ns
Time from start of tHS-TRAIL or tCLK-TRAIL period to start of LP-11 state	T <sub>EOT</sub>			105+12UI	ns
Time to enable Data Lane receiver line termination measured from when Dn cross VIL,MAX	T <sub>HS-TERM-EN</sub>			35+4UI	ns
Time to drive flipped differential state after last payload data bit of a HS transmission burst	T <sub>HS-TRAIL</sub>	60+4UI			ns
Time-out at RX to ignore transition period of EoT	T <sub>HS-SKIP</sub>	40		55+4UI	ns
Time to drive LP-11 after HS burst	T <sub>HS-EXIT</sub>	100			ns
Length of any Low-Power state period	$T_{LPX}$	50			ns
Sync sequence period	T <sub>HS-SYNC</sub>		8UI		ns
Minimum lead HS-0 drive period before the Sync sequence	T <sub>HS-ZERO</sub>	105+6UI			ns

## Note:

- 1: The minimum value depends on the bit rate. Implementations should ensure proper operation for all the supported bit rates.
- 2: UI means Unit Interval, equal to one half HS the clock period on the Clock Lane.
- 3: TLPX is an internal state machine timing reference. Externally measured values may differ slightly from the specified values due to asymmetrical rise and fall times.

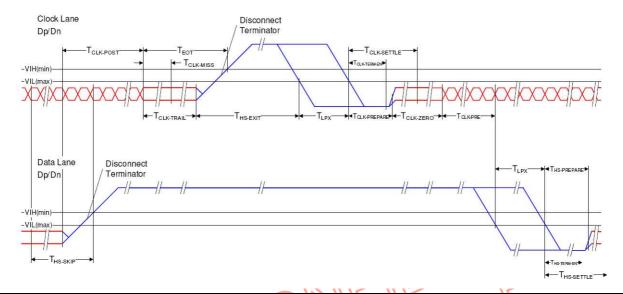
#### **Turnaround Procedure**



Parameter	Symbol	Min	Тур	Max	Units
Length of any Low-Power state period : Master side	$T_{LPX}$	50		75	ns
Length of any Low-Power state period : Slave side	$T_{LPX}$	50		75	ns
Ratio of TLPX(MASTER)/TLPX(SLAVE) between Master and Slave side	Ratio T <sub>LPX</sub>	2/3		3/2	
Time-out before new TX side start driving	T <sub>TA-SURE</sub>	$T_{LPX}$		2T <sub>LPX</sub>	ns
Time to drive LP-00 by new TX	T <sub>TA-GET</sub>		5T <sub>LPX</sub>		ns
Time to drive LP-00 after Turnaround Request	T <sub>TA-GO</sub>		$4T_{LPX}$		ns



## Switching the Clock Lane between Clock Transmission and Low-Power Mode

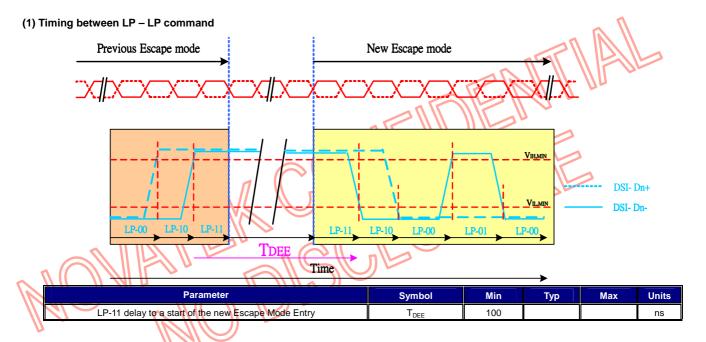


Parameter	Symbol	Min	Тур	Max	Units
Time that the transmitter shall continue sending HS clock after the last associated Data Lane has transitioned to LP mode	T <sub>CLK-POST</sub>	60+ <b>112</b> UI	A P	7	ns
Detection time that the clock has stopped toggling	T <sub>CLK-MISS</sub>		U	60	ns
Time to drive LP-00 to prepare for HS clock transmission	T <sub>CLK-PREPARE</sub>	38		95	ns
Minimum lead HS-0 drive period before starting Clock	T <sub>CLK-PREPARE</sub> +T <sub>CLK-ZERO</sub>	300			ns
Time to enable Clock Lane receiver line termination measured from when Dn cross VIL,MAX	T <sub>HS-TERM-EN</sub>			38	ns
Minimum time that the HS clock must be set prior to any associated date lane beginning the transmission from LP to HS mode	T <sub>CLK-PRE</sub>	8			UI
Time to drive HS differential state after last payload clock bit of a HS transmission burst	T <sub>CLK-TRAIL</sub>	60			ns

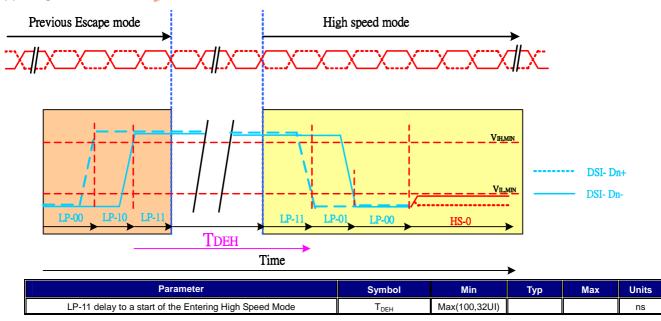


# LP11 timing request between data transformation

When Clock lane of DSI TX chip always keeps High speed mode, then Clock lane never go back to Low power mode. If Date lane of TX chip needs to transmit the next new data transmission or sequence, after the end of Low power mode or High speed mode or BTA. Then TX chip needs to keep LP-11 stop state before the next new data transmission, no matter in Low power mode or High speed mode or BTA. The LP-11 minimum timing is required for RX chip in the following 9 conditions, include of LP – LP, LP – HS, HS – LP, HS – BTA, BTA – BTA, LP – BTA, BTA – LP, HS – BTA, and BTA – HS. This rule is suitable for short or long packet between TX and RX data transmission.

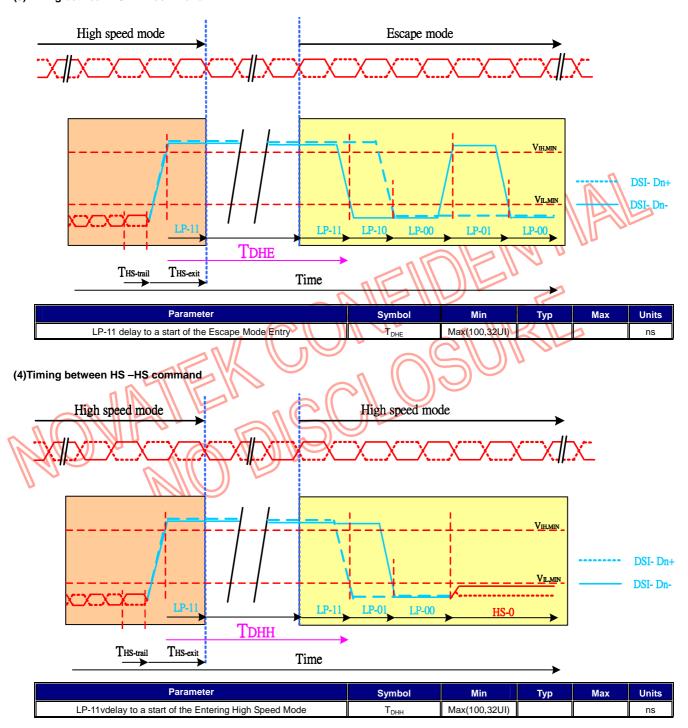


#### (2)Timing between LP - HS command



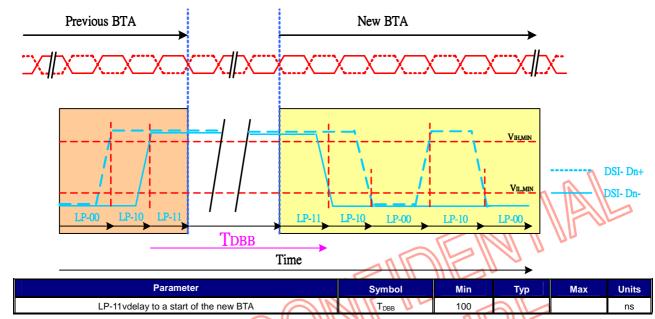


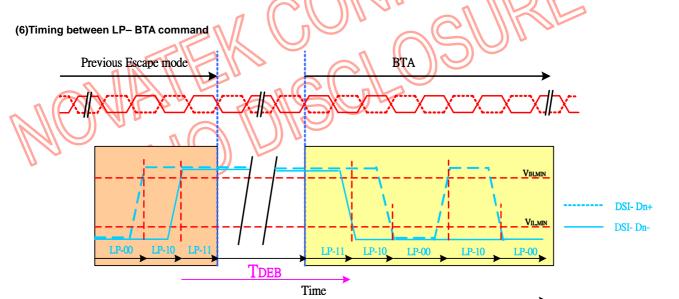
## (3)Timing between HS - LP command





# (5)Timing between BTA - BTA command

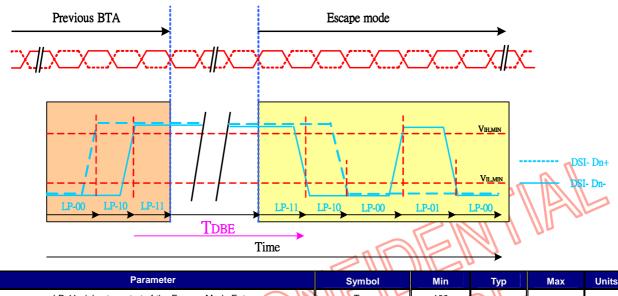




Parameter	Symbol	Min	Тур	Max	Units
LP-11vdelay to a start of the BTA	T <sub>DEB</sub>	100			ns



## (7)Timing between BTA - LP command



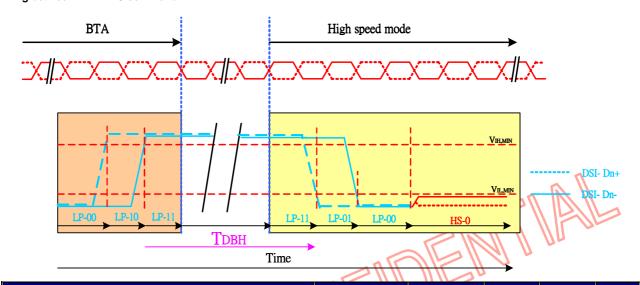
Units LP-11vdelay to a start of the Escape Mode Entry T<sub>DBE</sub> 100 ns

# (8)Timing between HS - BTA command BTA High speed mode DSI- Dn+ VIL,MIN DSI- Dn-**TDHB** THS-trail THS-exit Time

**Parameter** Symbol Min Тур Max Units LP-11vdelay to a start of the BTA  $\mathsf{T}_\mathsf{DHB}$ Max(100,32UI)



# (9)Timing between BTA – HS command



Parameter	Symbol	Min	Тур	Max	Units
LP-11vdelay to a start of the Entering High Speed Mode	T <sub>DBH</sub>	Max(100,32UI)			ns



# 7.3.2 Serial Interface Timing Characteristics

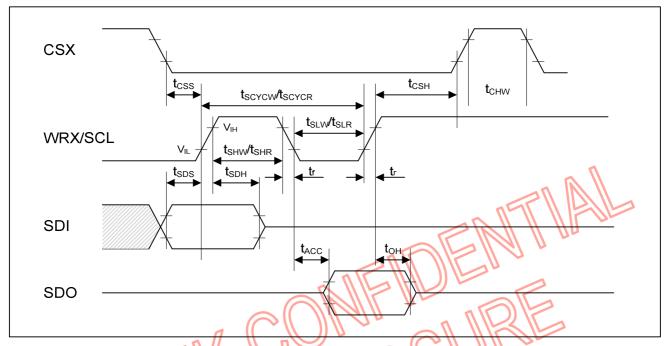


Figure 7.3.2 Serial Interface (9-bits) Operation

VCI= 2.5 V to 4.8 V, VDDI = 1.65V to 3.6V, VDDAM = 1.7V ~ 3.6V

			1			
Item	Symbol	Timing Diagram	Min.	Тур.	Max.	Unit
SCL clock cycle time Write (received)	tscycw	Figure 7.3.2	100	-	20,000	ns
SCL clock cycle time Read (transmitted)	t <sub>SCYCR</sub>	Figure 7.3.2	300	-	20,000	ns
SCL "High" pulse width Write (received)	t <sub>SHW</sub>	Figure 7.3.2	40		-	ns
SCL "High" pulse width Read (transmitted)	t <sub>SHR</sub>	Figure 7.3.2	140	-	-	ns
SCL "Low" pulse width Write (received)	t <sub>SLW</sub>	Figure 7.3.2	40		-	ns
SCL "Low" pulse width Read (transmitted)	t <sub>SLR</sub>	Figure 7.3.2	140		=	ns
SCL clock rise/fall time	t <sub>r</sub> , t <sub>f</sub>	Figure 7.3.2	-	-	10	ns
Chip select setup time	t <sub>CSS</sub>	Figure 7.3.2	20	-	=	ns
Chip select hold time	t <sub>сsн</sub>	Figure 7.3.2	50	-	-	ns
Input data setup time	t <sub>SDS</sub>	Figure 7.3.2	20	-	=	ns
Input data hold time	t <sub>sDH</sub>	Figure 7.3.2	20	-	=	ns
Output data access time	t <sub>ACC</sub>	Figure 7.3.2			120	ns
Output data hold time	tон	Figure 7.3.2	5		-	ns
Chip deselect "High" pulse width	t <sub>CHW</sub>	Figure 7.3.2	45	-	-	ns



## 7.3.3 I2C Bus Characteristics

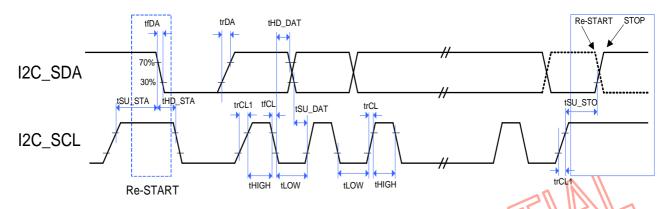


Figure 7.3.3 I2C-Bus Operation

Table 7.3.3 I2C-Bus Timing, VCI = 2.5 V to 4.8 V, VDDI = 1.65V to 3.6V, VDDAM = 1.7V ~ 3.6V

Item (High Speed Mode)	Timing Diagram	Symbol	Min.	Тур.	Max.	Unit
I2C_SCL clock frequency	Figure 7.3.3	Fscl		71	3.4	MHz
Hold time for START condition	Figure <b>7</b> .3.3	$t_{HD\_STA}$	160	-	-	ns
Set-up time for a repeated START condition	Figure 7.3.3	$t_{SU\_STA}$	160	-	-	ns
LOW period of the I2C_SCL clock	Figure 7.3.3	$t_{LOW}$	160	-	-	ns
HIGH period of the I2C_SCL clock	Figure 7.3.3	$t_{HIGH}$	60	-	-	ns
Data hold time	Figure 7.3.3	$t_{HD\_DAT}$	-	-	70	ns
Data set-up time	Figure 7.3.3	$t_{SU\_DAT}$	10	-	-	ns
Rise time for I2C_SCL signal	Figure 7.3.3	$t_{rCL}$	10	-	40	ns
Rise time for I2C_SCL signal I after a repeated START condition and after an acknowledge bit	Figure 7.3.3	$t_{rCL1}$	10	-	80	ns
Rise time for I2C_SDA signal	Figure 7.3.3	$t_{rDA}$	10	-	80	ns
Fall time for I2C_SCL signal	Figure 7.3.3	$t_{fCL}$	10	-	40	ns
Fall time for I2C_SDA signal	Figure 7.3.3	$t_{f\!D\!A}$	10	-	80	ns
Set-up time for STOP condition	Figure 7.3.3	$t_{SU\_STO}$	160	-	-	ns
Pulse width of spikes (must be suppressed by the input filter)	Figure 7.3.3	$t_{SP}$	-	-	10	ns
Noise margin at the LOW level	Figure 7.3.3	$V_{nL}$	0.1	-	-	VDDI
Noise margin at the HIGH level	Figure 7.3.3	$V_{nH}$	0.2	-	-	VDDI



## Table 7.3.4 I2C-Bus Timing, VCI = 2.5 V to 4.8 V, VDDI = 1.65V to 3.6V, VDDAM = 1.7V $\sim$ 3.6V

Item (Fast Mode)	Timing Diagram	Symbol	Min.	Тур.	Max.	Unit
I2C_SCL clock frequency	Figure 7.3.3	Fscl	-	-	400	KHz
Hold time for START condition	Figure 7.3.3	$t_{HD\_STA}$	600	-	-	ns
Set-up time for a repeated START condition	Figure 7.3.3	$t_{SU\_STA}$	600	-	-	ns
LOW period of the I2C_SCL clock	Figure 7.3.3	$t_{LOW}$	1.3	-	- (	us
HIGH period of the I2C_SCL clock	Figure 7.3.3	$t_{HIGH}$	0.6	- 45		us
Data hold time	Figure 7.3.3	$t_{HD\_DAT}$	5	1	70	us
Data set-up time	Figure 7.3.3	$t_{SU\_DAT}$	100	//-//	170	ns
Rise time for I2C_SCL signal	Figure 7.3.3	t <sub>rcL</sub>	B	2.	300	ns
Rise time for I2C_SCL signal I after a repeated START condition and after an acknowledge bit	Figure 7.3.3	$t_{rCL1}$			300	ns
Rise time for I2C_SDA signal	Figure 7.3.3	$t_{rDA}$			300	ns
Fall time for I2C_SCL signal	Figure 7.3.3	$t_{fCL}$	)) <u>.u</u>	-	300	ns
Fall time for I2C_SDA signal	Figure 7.3.3	$t_{JDA}$	-	-	300	ns
Set-up time for STOP condition	Figure 7.3.3	$t_{SU\_STO}$	600	-	-	ns
Pulse width of spikes (must be suppressed by the input filter)	Figure 7.3.3	$t_{SP}$	-	-	50	ns
Noise margin at the LOW level	Figure 7.3.3	$V_{nL}$	0.1	-	-	VDDI
Noise margin at the HIGH level	Figure 7.3.3	$V_{_{nH}}$	0.2	-	-	VDDI



#### 7.3.4 Reset Timing Characteristics

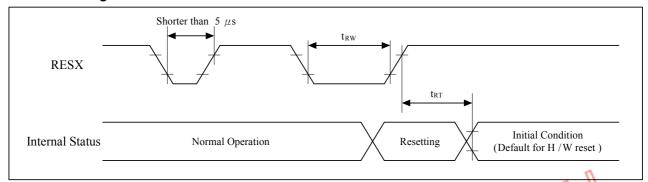


Figure 7.3.4 Reset Operation

Table 7.3.4 Reset Timing Characteristics VCI=2.5~4.8V, VDDI=1.65~3.6V, VDDAM=1.7~3.6V

Signal	Symbol	Parameter	Min.	Max.	Unit
	t <sub>RW</sub>	Reset pulse duration	10(Note)	-	us
RESX	t <sub>RT</sub>	Reset cancel		10(Note)	ms
		Neset Calicel		120(Note)	ms

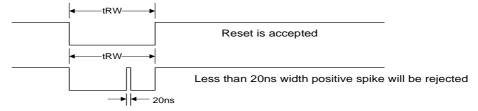
#### Note:

- -The reset cancel also includes required time for loading ID bytes, VCOM setting and other settings from EEPROM (or similar device) to registers.

  This loading is done every time when there is HW reset cancel time (tRT) within 10 ms after a rising edge of RESX.
- -Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below  $\,:\,$

RESX	Pulse Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9us	Reset Starts

- -During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts at Sleep-Out status. The display remains the blank state in Sleep-In mode). Then return to Default condition for Hardware Reset.
- -Spike Rejection also applies during a valid reset pulse as shown below :



- -When Reset applied during Sleep-In Mode.
- -When Reset applied during Sleep-Out Mode.
- -It is necessary to wait 10ms after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120 ms.